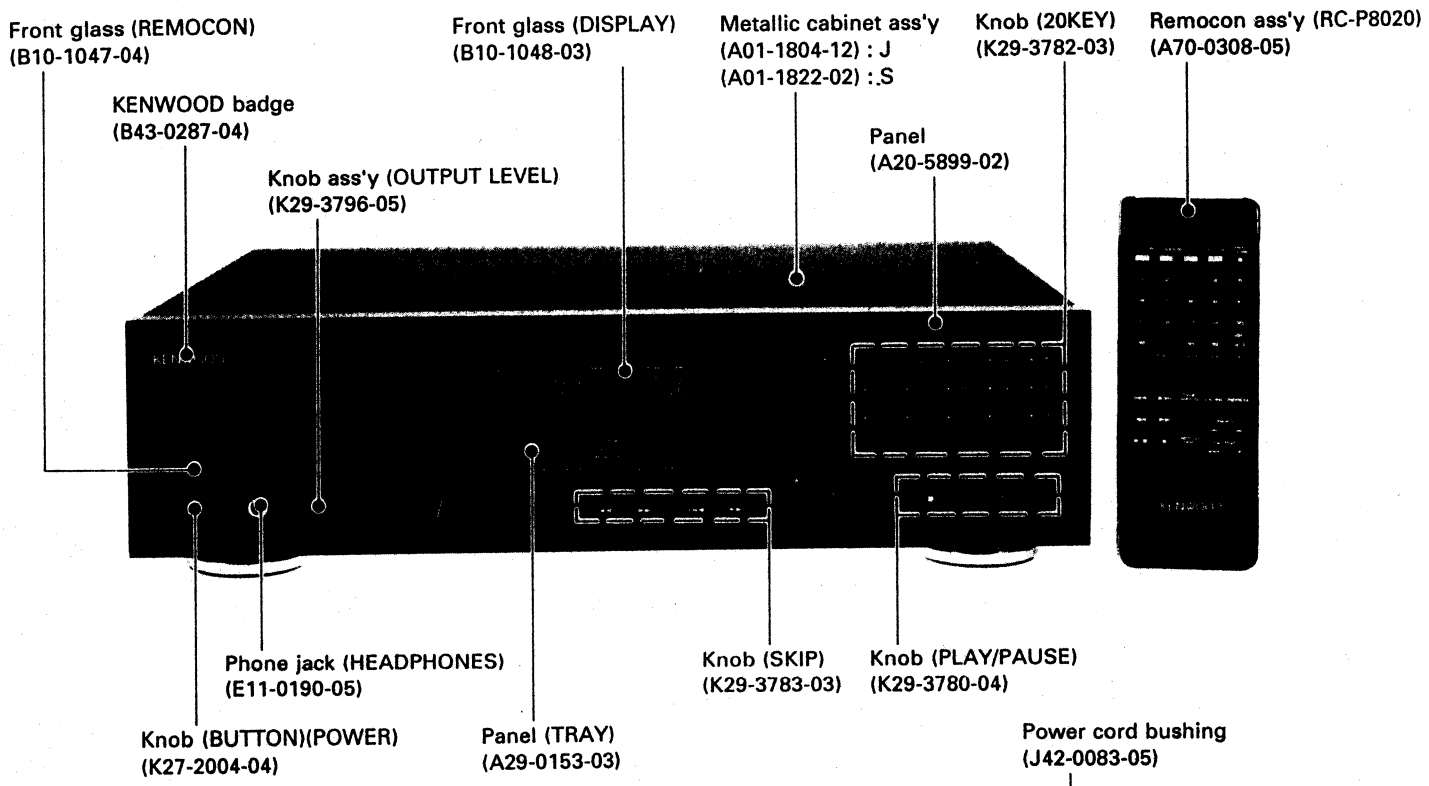
COMPACT DISC PLAYER

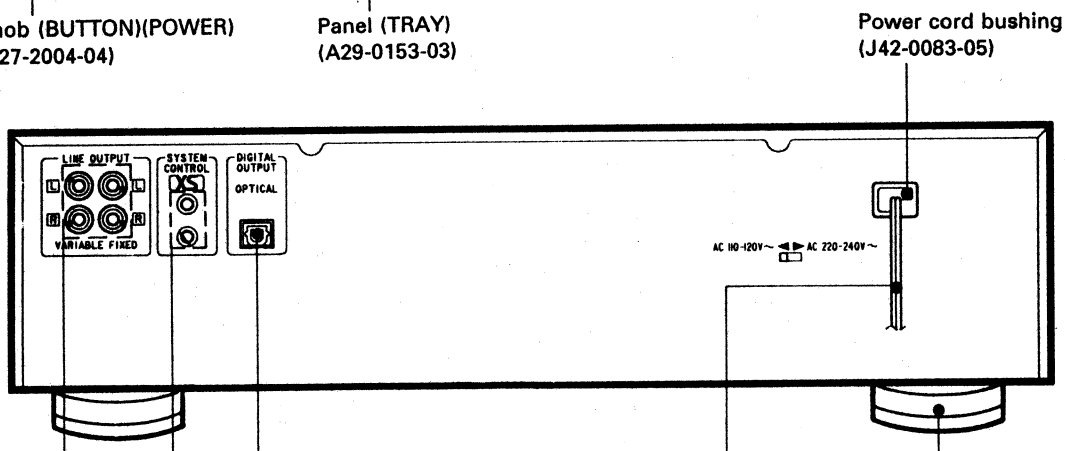
DP-7020

SERVICE MANUAL

KENWOOD

B51-3992-00 (O) 3354





In complicance with Federal Regulations, following are reproductions of labels on, or inside the product relating to laser product safety.

KENWOOD-Corp. certifies this equipment conforms to DHHS Regulations No. 21 CFR 1040. 10, Chapter 1, Subchapter J.

DANGER : Laser radiation when open and interlock defeated. AVOID DIRECT EXPOSURE TO BEAM.

J : Japan made
S : Singapore made

***Refer to parts list on page 73.**

CONTENTS

DP-7020	JAPAN MADE	SINGAPORE MADE
CONTROL UNIT*	X32-1510-11 (K, P) X32-1510-21 (U, UE, M) X32-1512-71 (X)	X32-1562-71 (T, E) X32-1560-10 (K)
MECHANISM ASS'Y	X92-1370-02 (CDM-14)	X92-1400-02 (CDM-14SA)

Caution :
The mechanism ass'y used with the DP-7020 varies in two types depending on the manufacturing location. (Japan, Singapore)

Before Operation

- **Transportation screw**

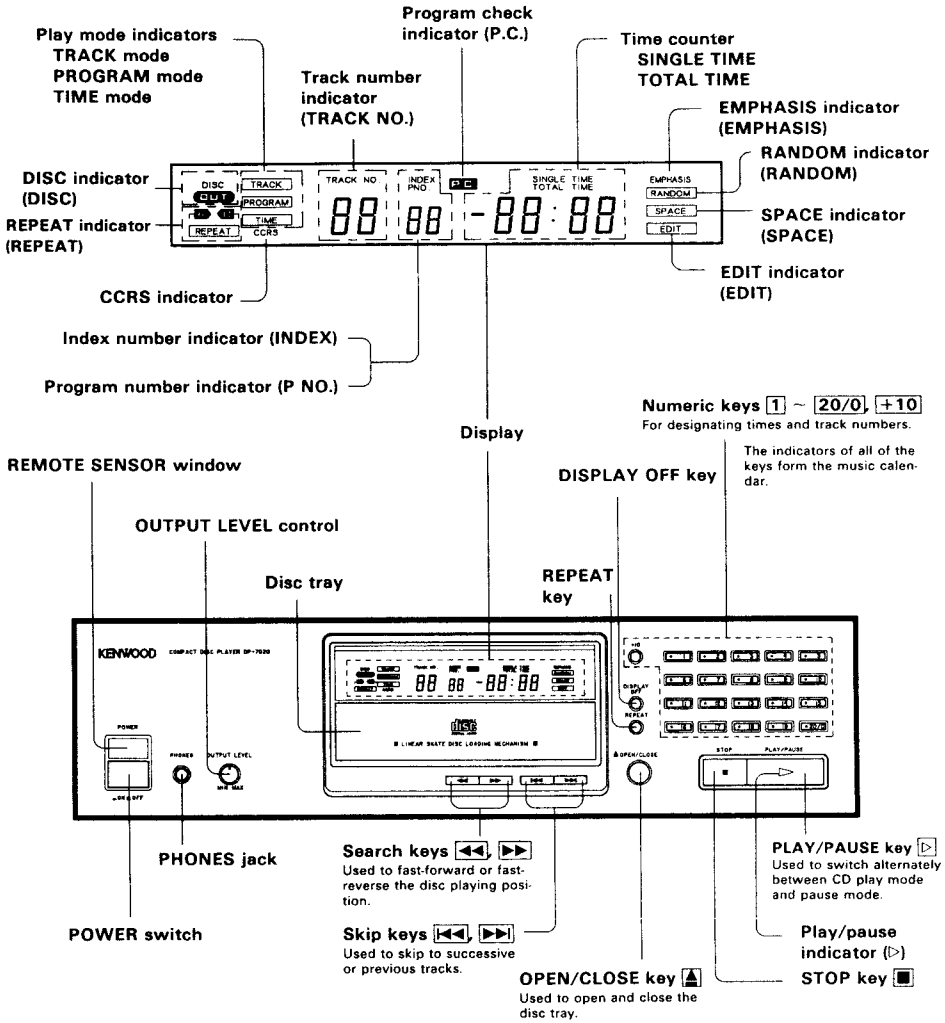
Before operation, remove the red-headed screw attached to the bottom of the unit used during transportation from the factory. Remove the screw using a coin or screwdriver, etc.

- After removing, retain the screw together with the Warranty card and other documents.
- When the unit is to be transported again, be sure to replace the screw to its original position.

1. Turn ON the power switch when no disc is loaded.
2. Wait a few seconds until the disc OUT indicator comes "ON". Then turn "OFF" the power.

3. Firmly tighten the transportation screw.

CONTROLS AND INDICATORS



DISPLAY OFF key
If the DISPLAY OFF key is pressed during disc play, the display is extinguished.

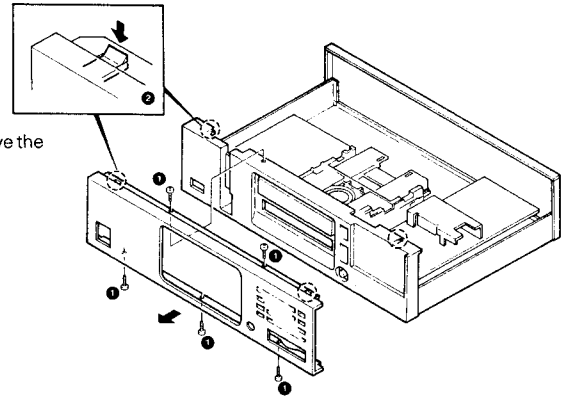
- If the DISPLAY OFF key is pressed at any time other than during disc play, the display will not be extinguished.
- When an operation key is pressed (excluding adjustment of the OUTPUT LEVEL control) while the display is in the DISPLAY OFF state, the display appears for a few seconds.
- When the display is in the DISPLAY OFF state during program play, the display appears for approximately 2 seconds at the beginning of each tune.

The DISPLAY OFF state is canceled when the DISPLAY OFF key is pressed again or when the OPEN/CLOSE key ⏏ or STOP key ■ is pressed.

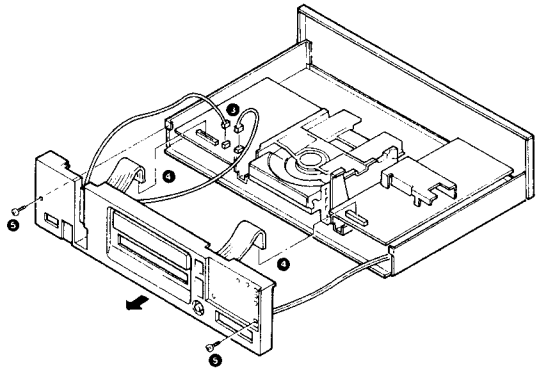
DISASSEMBLY FOR REPAIR

1. How to remove the operation unit and mechanismass'y

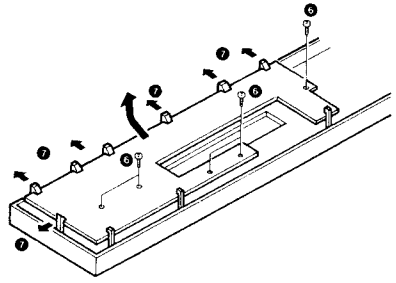
1. Remove the 5 screws (❶).
2. Push the projection of the front panel and remove the panel (❷).



3. Remove 2 connectors (❸).
4. Pull out the 2 flexible Cables (❹).
5. Remove the screw (❺) and sub panel.



6. Remove the 5 screws (❻).
7. Slide the projections and remove pc board ass'y (❼).



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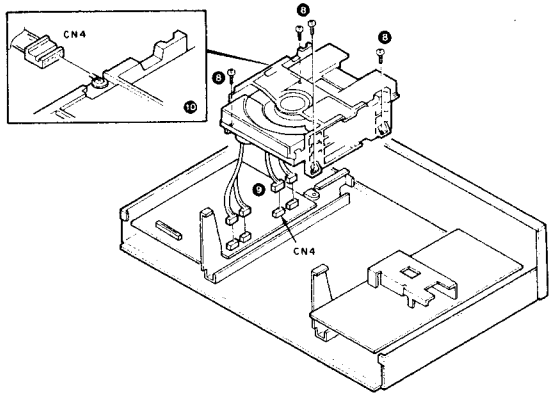
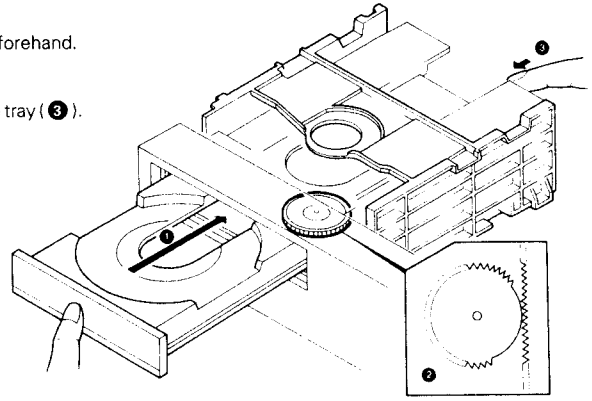
DISASSEMBLY FOR REPAIR

8. Remove the 4 screws (❽).
9. Remove the 4 connectors (❾).
10. When removing the mechanism ass'y, (❿) first set the short pin.

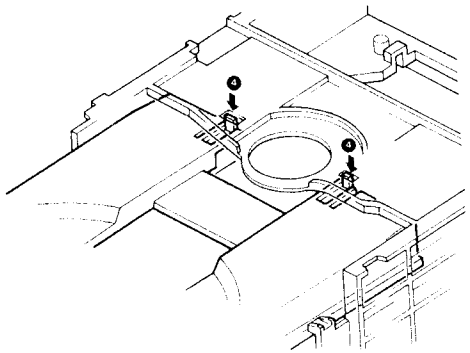


2. Removing the tray

1. With the tray open, turn off the power beforehand.
2. Push in the tray slowly by a hand (❶).
   In this situation, the gear is free (❷).
3. Push the tray towards you and draw out the tray (❸).

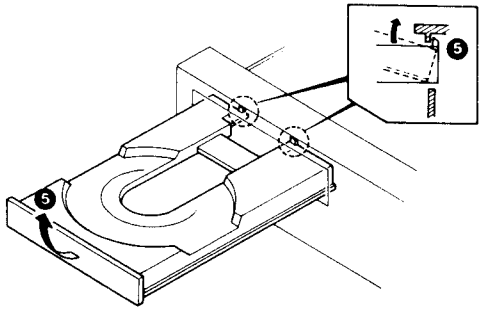


4. Push down off the two catches (❹) of the tray stopper, and draw out the tray in the direction of an arrow.



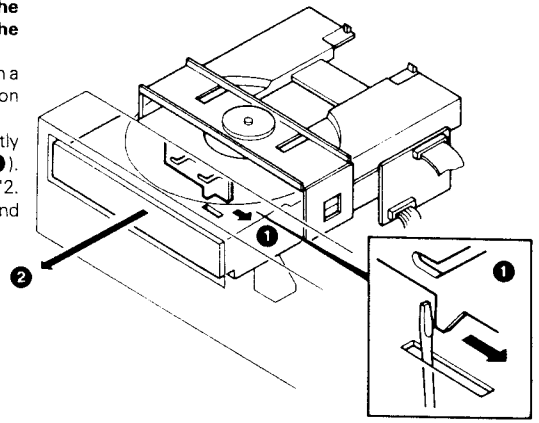
DISASSEMBLY FOR REPAIR

5. When removing the tray, detach it in the direction of arrow (❺) in which it can be detached without the sub panel caught by the tray stopper.



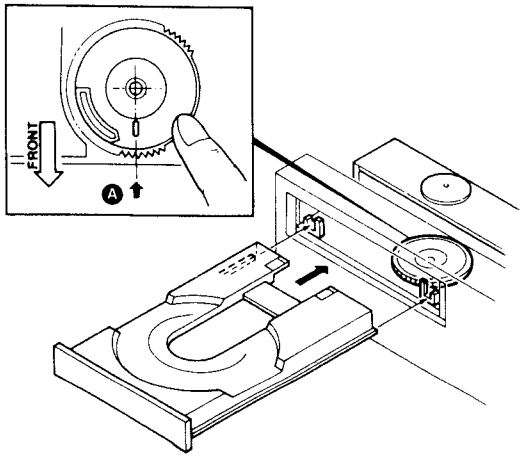
2–1. When the power is not turned on or when the tray does not come out even by pressing the OPEN key

1. Push the lever by a screwdriver, etc. put in through a slit on the bottom plate of the product as shown on the right (❶).
2. Thereby, the gear will be free with the tray slightly advanced. Thus, draw out the tray towards you (❷). Otherwise, as previously stated in step 3. of "2. Removing the tray", push the tray towards you and draw out the tray.



3. Installing the tray

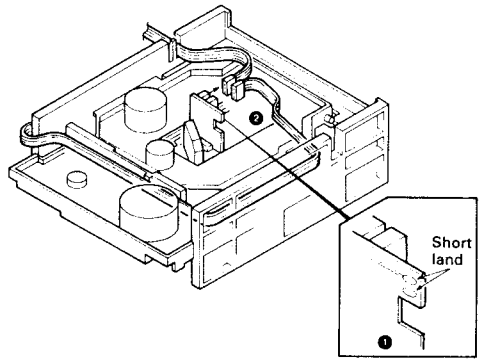
1. Set to location (Ⓐ) the protrusion on the upper side of the gear as shown on the right.
2. Push in the tray along the left and right guides.



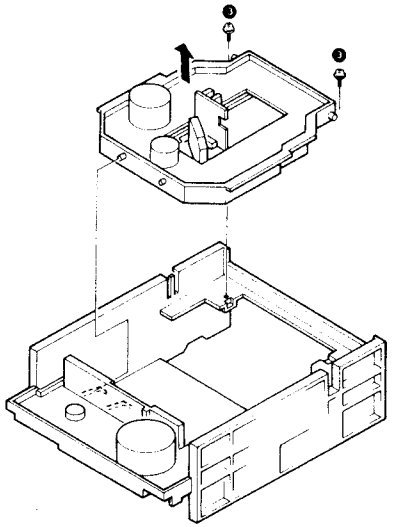
DISASSEMBLY FOR REPAIR

3. Removing the Pickup (Japan made)

1. Turn over the mechanism and short the short land of the pickup (❶).
2. Disconnect the two connectors (❷).

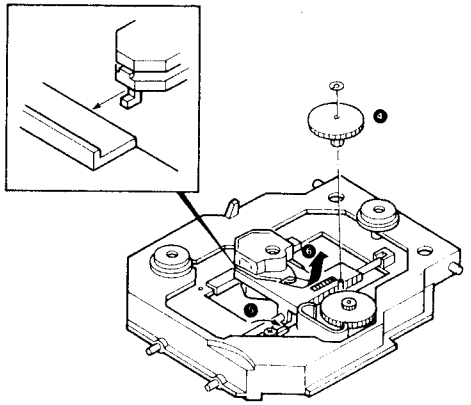


3. Remove the two screws (❸), then remove the MD assembly.



4. Remove the snap ring, then remove the gear (❹).
5. Remove the stopper (❺).
6. Remove the pickup in the direction of the arrow (❻).

Note : When installing the pickup, in the reverse order of disassembly.
Unsolder the short land after connecting the connector.



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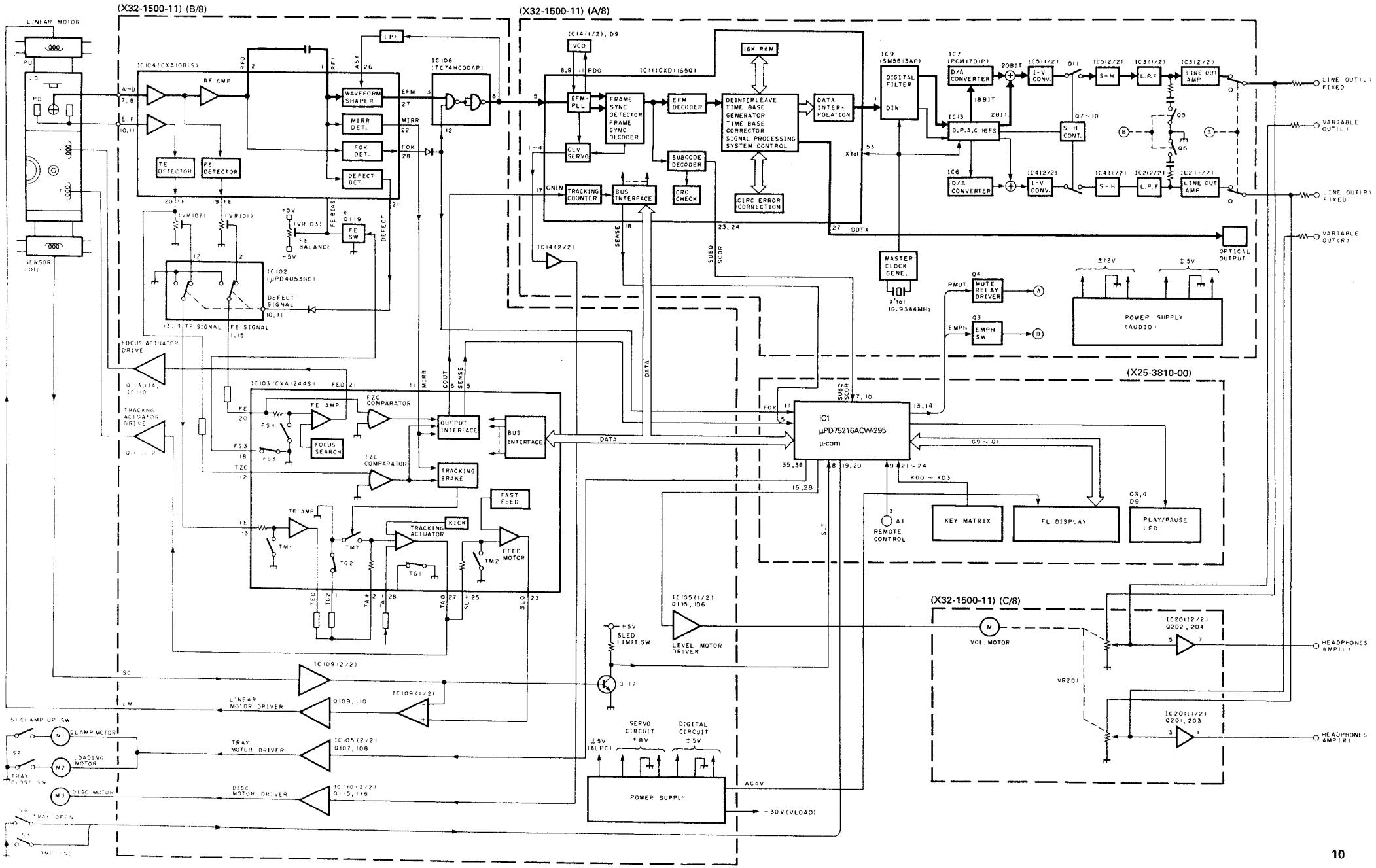
BLOCK DIAGRAM

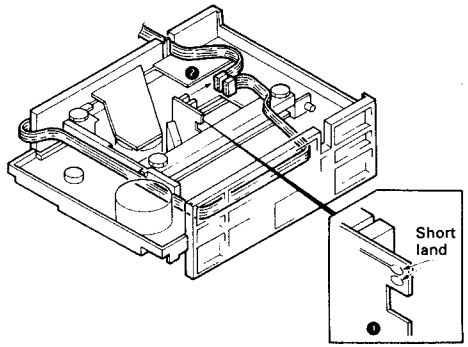


DISASSEMBLY FOR REPAIR

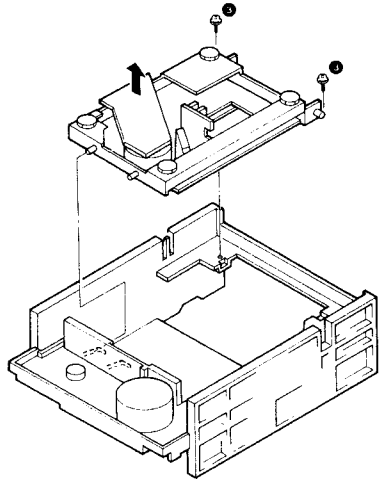
SINGAPORE MADE

3. Removing the pickup (Singapore)

1. Turn over the mechanism and short the short land of the pickup (❶).
2. Disconnect the two connectors (❷).

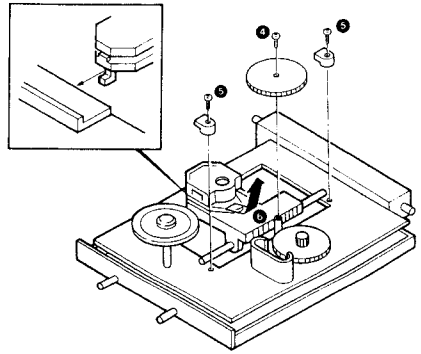


3. Remove the two screws (❸), then remove the MD assembly.



4. Remove the screw, then remove the gear (❹).
5. Remove the stopper (❺).
6. Remove the pickup in the direction of the arrow (❻).

Note : When installing the pickup, in the reverse order of disassembly.
Unsolder the short land after connecting the connector.



CIRCUIT DESCRIPTION

1. Description of components

1-1. CD PLAYER UNIT (X32-1500-11)

Ref. No.	Part. No.	Use/Function	Operation/Condition/Compatibility
IC1	NJM4565D	Power Supply	For analog circuit of DAC.
IC2, 3	NJM4565D	L.P.F	2nd low pass filter and amplifier for output.
IC4, 5	NJM4580D	I/V Converter	Conversion of D/A converter current output into voltage from. (Refer to D.P.A.C at page 15)
IC6, 7	PCM1701P	DAC	Conversion of 18bit digital data into analog one.
IC8	NJM4565D	Power supply (+5V)	For oscillation (IC10), Digital filter (IC9) and HIC.
IC9	SM5813AP	Digital filter	Convert 16bit FS to 20bit 8FS.
IC10	TC74HCU04AP	Oscillation	Oscillation master clock 16.9344MHz and applied clock signal to IC9,11, and 13.
IC11	CXD1165Q	Digital signal processor	All digital signal processing operation, Including the EFM data demodulator, error correction, interpolation circuit, PLL, CLV, Digital output jitter free.
IC12	NJM4565D	Power supply (+5v)	For IC11,15 and IC14 of PLL and CLV.
IC13	KAG01	Bit converter	Add 2bit to 18bit DAC and 18bit to 20bit jitter free. (refer to circuit descrip tion at page 40)
IC14	NJM4565D	PLL, CLV servo	Servo amplifier for disk motor and control VCO freq. by phase comparation signal.
IC15	TC74HC00AP	Data select	No use for repair.
IC101	NJM4558D	Power supply (+5V)	For servo circuit.
IC102	µPD4053BC	Defect circuit	If RF signal defect (IC104 Defection), servo circuit is open and playback goes on.
IC103	CXA1244S	Servo signal processor	Control of focusing error tracking servo and feed servo pulses for servo control.
IC104	CXA1081S	RF amplifier	Focusing error signal generator, tracking error signal generator, RF signal generator and phase componsation.
IC105	NJM4558D	Motor control	For motor of OPEN/CLOSE and one of UP/DOWN.
IC106	TC74HC00AP	Buffer amplifier	For EFM signal to signal processor.
IC109	NJM4558D	Amplifier	For sled drive of pickup travel.
IC110	NJM4558D	Amplifier	For focus actuator drive and disk motor.
IC201	NJM4565D	Amplifier	For headphone.
Q1	2SB941	Power supply (+)	For analog circuit.
Q2	2SD1266	Power supply (–)	For analog circuit.
Q3	DTC124EN	Inter face	For emphasis and micro processor.
Q4	2SC1740S	Inter face	For relay, micro processor and relay drive.
Q5, 6	2SC2878	Switch	For emphasis.
Q7, 8	2SA1206	Inter face	For sample-hold circuit and inter face of clock signal.
Q9, 10	2SK246	Power supply	When Q7, 8 are off condition, Q11, 12 are off.
Q11, 12	2SK152	Switch	Control the gate Q7~10. If on, sample mode. If off, hold mode.
Q13, 14	2SC3940A	Power supply (+5)	For DAC.
Q15	2SC3940A	Power supply (+5)	For digital filter (IC9).
Q16	2SC3940A	Power supply (+5V)	For oscillation (IC10).
Q17	2SA1534A	Power supply (–5V)	For PLL and CLV.
Q18	2SC3940A	Power supply (+5V)	For PLL, CLV and signal processor.
Q19	2SK246	Power supply (+5V)	—
Q20 Q21	2SA933S 2SC733 (A)	Muting amplifier	Control output of optical when power on. Buffer amplifier for optical output.
Q101	2SA1534A	Power supply (+5)	For servo circuit.
Q102	2SC3940A	Power supply (–5V)	For servo circuit.
Q103	2SD1944	Power supply (+5V)	For FL-indicator.
Q104	2SA1534A	Power supply (–30V)	For FL-indicator.
Q105 Q106	2SA1534A 2SC3940A	Buffer	Drive motor of VOLUME.
Q107 Q108	2SA1534A 2SC3940A	Buffer	Drive motor of tray.

CIRCUIT DESCRIPTION

Ref. No.	Part. No.	Use/Function	Operation/Condition/Compatibility
Q109	2SA1534A	Buffer	Drive feed motor.
Q110	2SC3940A		
Q111	2SA1534A	Buffer	Drive actuator of tracking.
Q112	2SC3940A		
Q113	2SA1534A	Buffer	Drive actuator of focusing.
Q114	2SC3940A		
Q115	2SA1534A	Buffer	Drive disk motor.
Q116	2SC3940A		
Q118	2SA11534A	Buffer	For laser diode and ALPC.
Q119	2SC1740S (Q, R) 2SC945 (A) (Q, R)	Switch	When focus servo is on FE BIAS circuit works.
Q201 Q202 Q203 Q204	2SC3666 2SA1426	Buffer	For head phone.

1-2. DISPLAY AND μ-COM UNIT (X25-3810-00)

Ref. No.	Part. No.	Use/Function	Operation/Condition/Compatibility
IC1~3	TD62801P	Inverter	Convert data (Serial parallel). For 20KEY LED.
IC4	μPD75216ACW-295	Microprocessor	–
IC5	M51951ASL	Reset IC	For reset of microprocessor.
Q1, 5	2SC1740S (Q, R) 2SC945 (A) (Q, R)	Buffer	For FL-indicator of pin1 and pin9.
Q2	DTA124EN	Buffer	For VOLUME LED.
Q3, 4	DTA124EN	Power supply	For reset IC.

2. Display unit μ-com unit

•Turning on the self-illuminating 20KEY LED's

The self-illuminating 20KEY LED's are turned on with the 8-bit shift register (TD62801P). The microprocessor sends the serial data, latch data, and clock to turn on the 20KEY, PLAY, and PAUSE LED's.

Three units of TD62801P are used and connected respectively by S-OUT and S-IN. The data are output by setting the enable terminal to "H" level.

Fig.1 shows the rough block diagram for turning on the LED's and Fig.2 shows the timing chart.

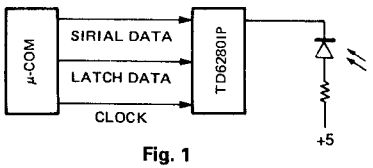


Fig. 1

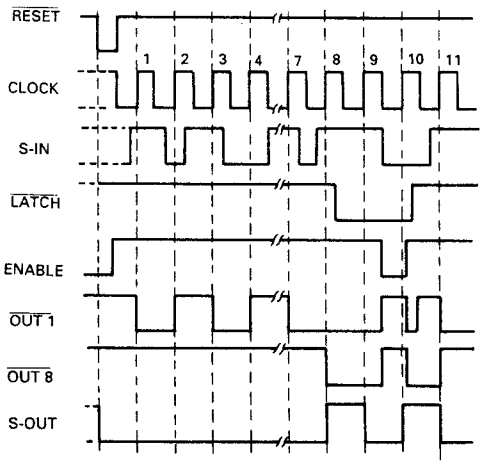


Fig. 2

CIRCUIT DESCRIPTION

• D.P.A.C (Digital Pulse Axis Control) circuit

Two different distortions are attendant on the conversion of the digital signal into an analog signal. One is a distortion on the level axis (voltage axis), which is determined mainly by the resolution of the D/A converter, and in case of using a ladder resistor type, by its error.

The other is a distortion on the time axis, which is not so prevailing as to appear on the distortion meter but has great influence on the sound quality. It is the D.P.A.C that is to operate as a circuit to improve this point.

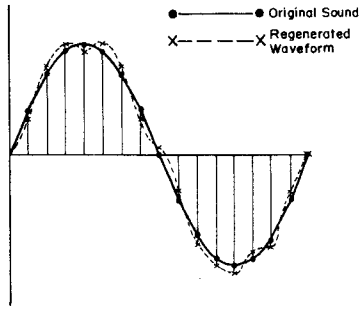


Fig. 3 Error (distortion) on voltage axis

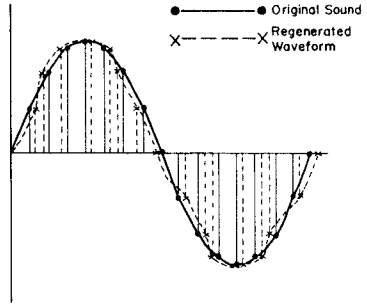


Fig. 4 Error (distortion) on time axis

Figure 2-3 shows the error (distortion) on the voltage axis of the D/A converter output for the original sound, and Figure 2-4 shows the error (distortion) on the time axis of the D/A converter output for the original sound.

As seen from this, even with a variation in time axis, there appears a regenerated waveform different from the original sound.

• D.P.A.C by sample holding (S-H) circuit

The model of this time has the D.P.A.C circuit on the basis of an S-H circuit which has been more improved than the conventional D.P.A.C.

This new S-H circuit has the same composition as the conventional one. The difference between them is that the former uses the clock obtained by dividing the master clock for the sample holding signal which does not have jitters. This clock is converted into an analog signal, than its time axis corrected (its jitters are eliminated). The D/A conversion is carried out at 8 FS, but the sample holding clock is set to 16 FS. Accordingly , the noises generated in the S-H circuit is raised to 16 FS, thus the effects on the audio signal is minimized.

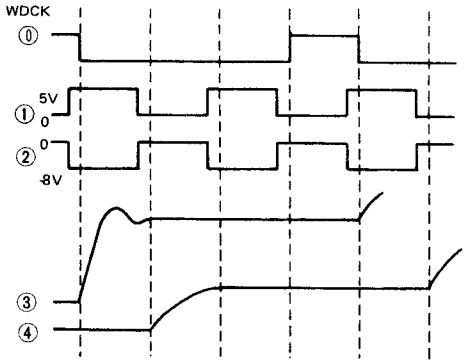
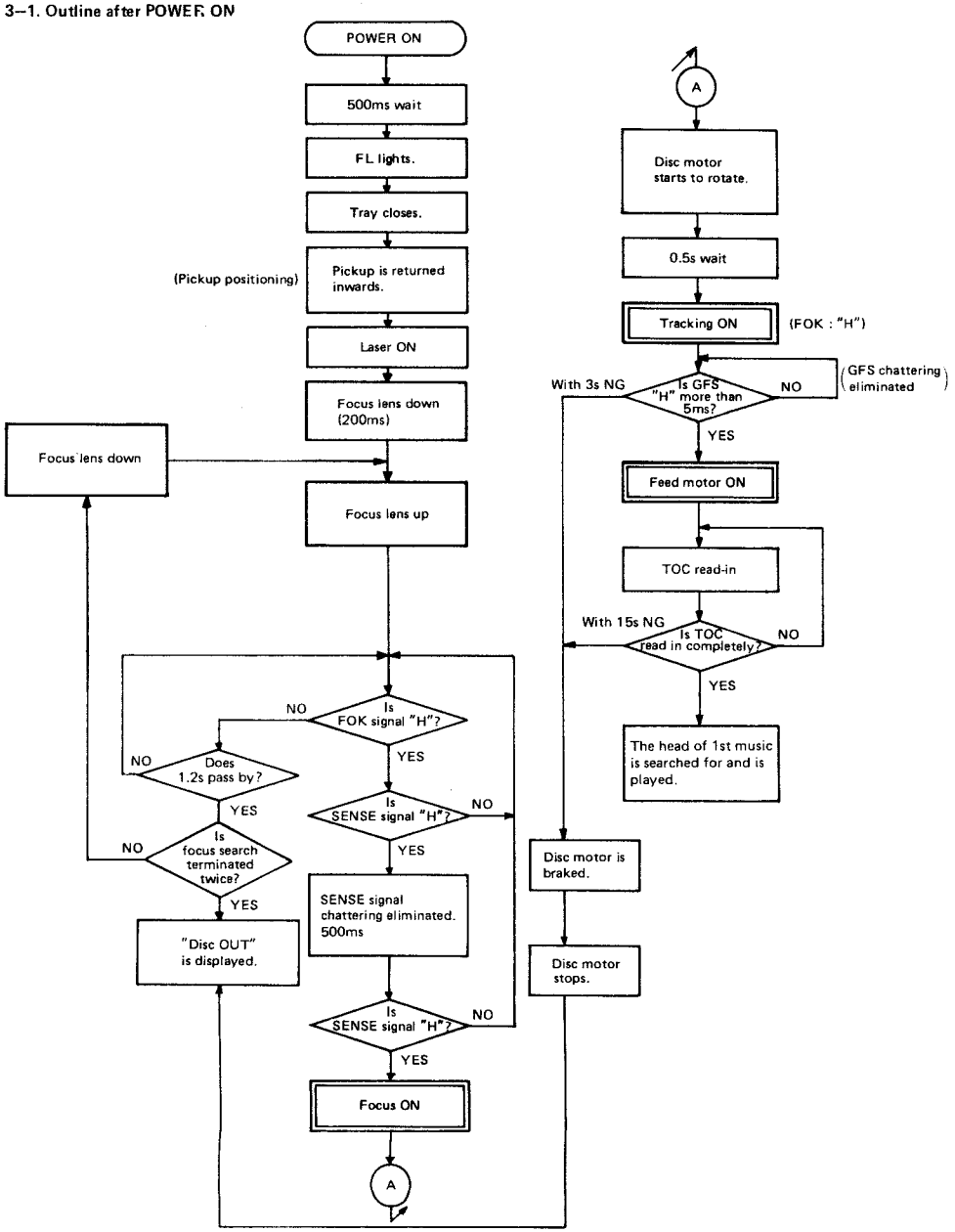


Fig. 5

CIRCUIT DESCRIPTION

3. Set Mode Flowchart

3–1. Outline after POWER ON

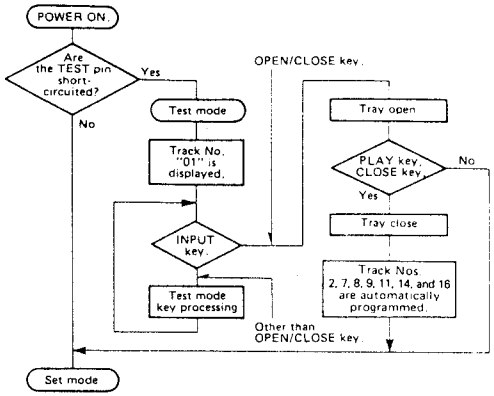


CIRCUIT DESCRIPTION

4. Test mode

With the DP-7020, the microprocessor can be set to test mode by short-circuiting pin 7 and pin 8 of the CD PLAYER UNIT (X32-1500).

Note : "Set mode" shows the normal status.



4-1. Key and functions valid in test mode

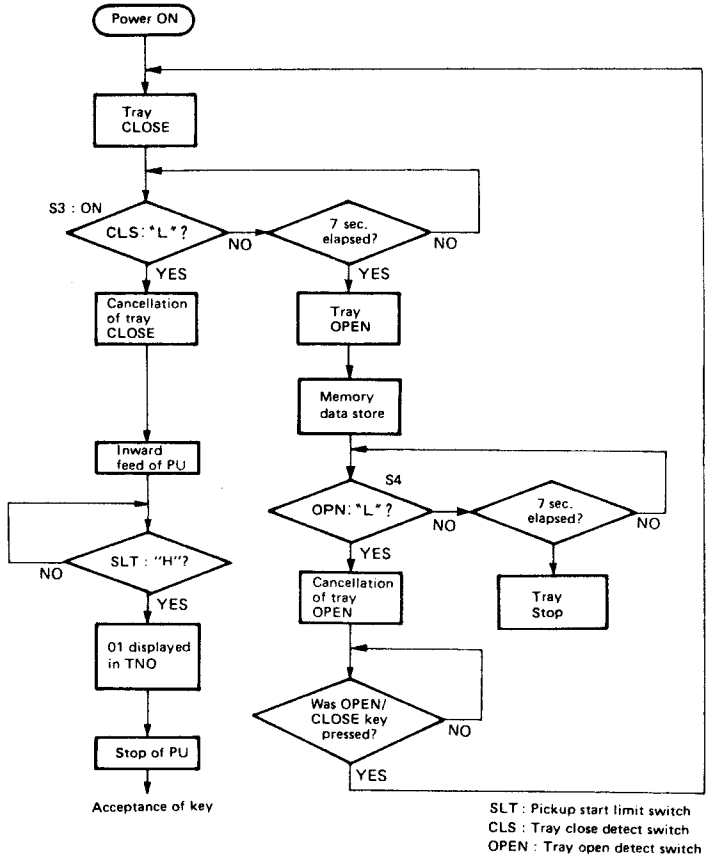
No.	Input key	Function	Track No. display
1	PLAY	(1) Focusing servo ..... ON (2) Tracking servo ..... ON (3) Feed servo ..... ON	TRACK NO. 05 PLAY (▶) Key lights Disk track No.and time are displayed
2	STOP	Jump to the first stop of TEST mode.	TRACK NO 01
3	UP ▶▶|	(1) Focusing servo ..... ON (2) Tracking servo ..... OFF (3) Feed servo ..... OFF	TRACK NO 03 PAUSE (❚❚) blinking P.C lights.
4	DOWN |◀◀	(1) Tray ..... Opened (2) Laser ..... ON The TEST mode goes on when the tray is closed by pressing the tray.	TRACK NO. 02 REPEAT lights
5	FF ▶▶	In the STOP mode, moves the pickup slightly toward the outer position of disc.	
6	FB ◀◀	In the STOP mode, moves the pickup slightly toward the inner position of disc.	
7	OPEN/CLOSE	When the tray is opened and the closed again in test mode, Track Nos 2,7,8, 9,11,14, and 16 are automatically programmed.	
8	DISPLAY OFF	All of FL's segments are light and PLAY and PAUSE indicator light.	

DP-7020

CIRCUIT DESCRIPTION

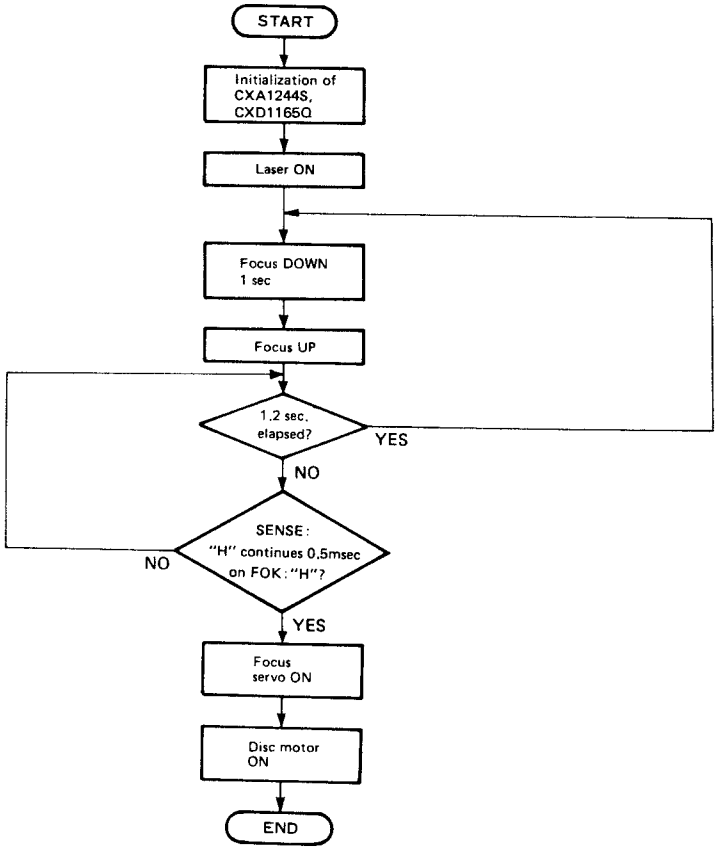
4–2. Flow chart of test mode

- **Flow chart from tray OPEN status after power ON**



CIRCUIT DESCRIPTION

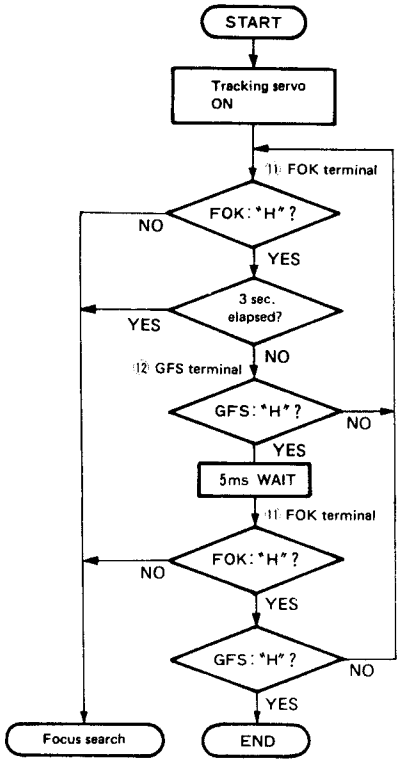
- Focus search & focus servo ON



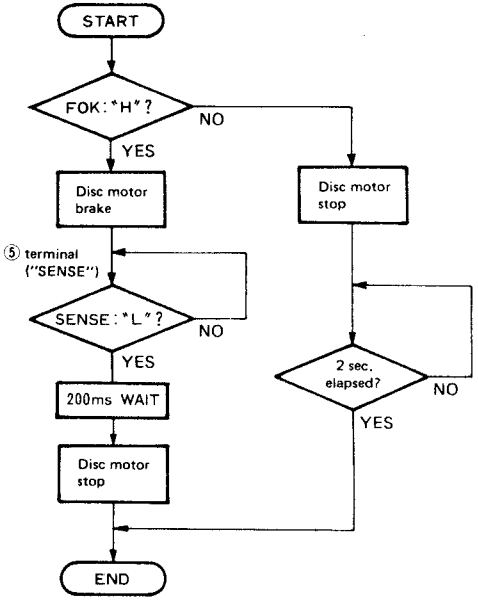
DP-7020

CIRCUIT DESCRIPTION

- Tracking servo ON

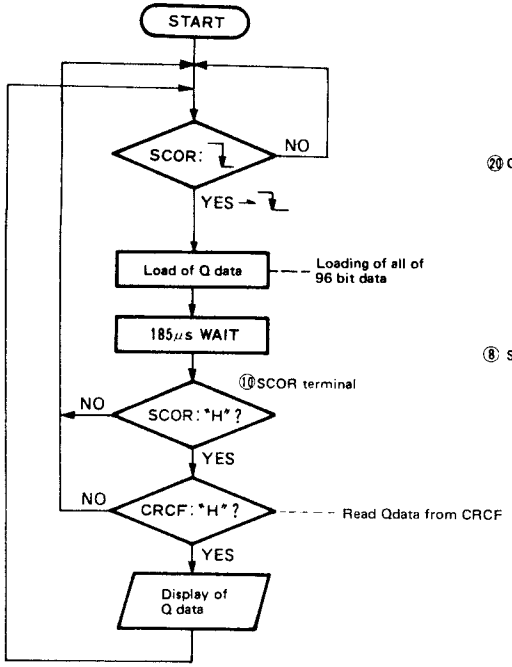


- Disc motor STOP

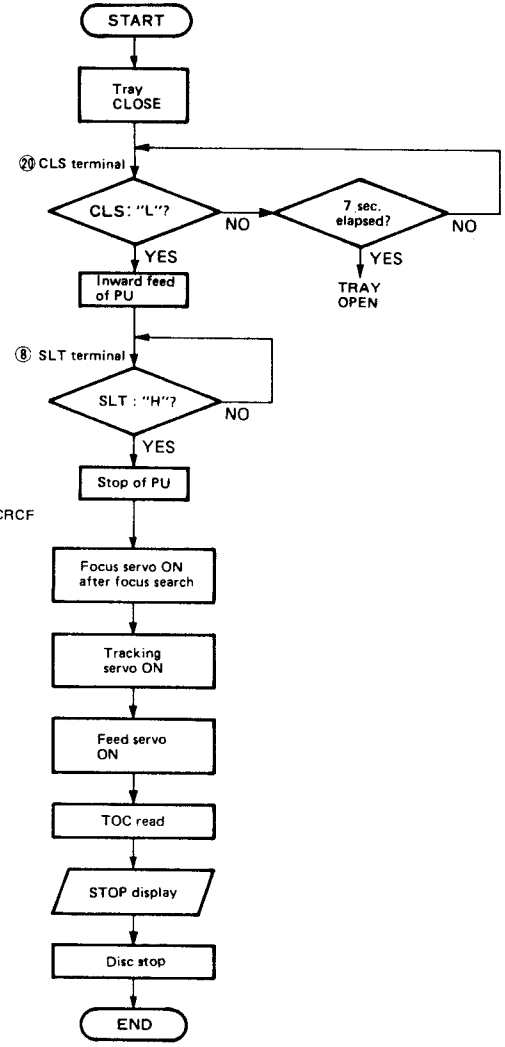


CIRCUIT DESCRIPTION

- From loading of Q data to display



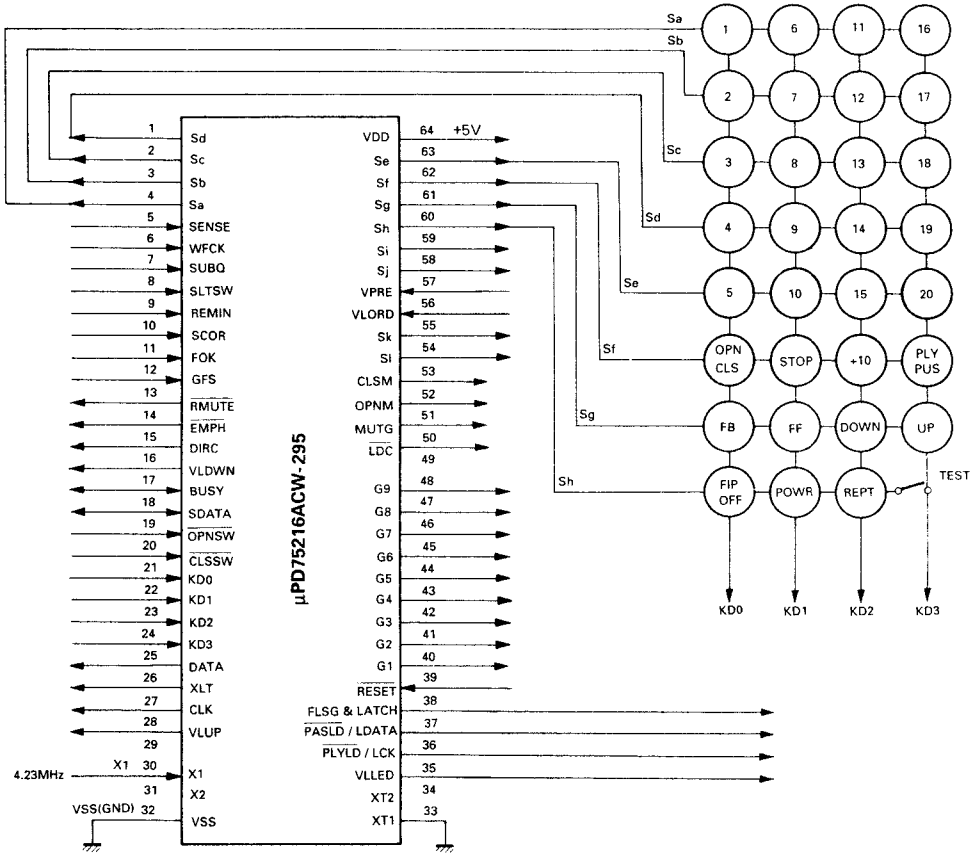
- In a usual case, since the tray was pushed when the tray is OPEN until STOP display is made.



CIRCUIT DESCRIPTION

5.Microprocessor μPD75216ACW-295 (X25-3820-00 : IC1)

5-1. Terminal connection diagram



5–2. Explanation of terminals

Pin No.	Pin Name	I/O	Function
1~4	Pd~Pa	O	FL segment control pins (also for key signal).
5	SENSE	I	Signal processing, pin to detect the SENSE signal from servo IC.
6	WFCK	I	Q data read-out clock pulse input pin.
7	SUBQ	I	Q data input pin.
8	SLTSW	I	Pickup stops (STOP : "H").
9	RCI	I	Remoto control input pin.
10	SCOR	I	Sub-code frame sync detection signal input pin.
11	FOK	I	RF amplifier FOK signal input pin (At focus OK : "H").
12	GFS	I	Frame sync signal input pin (In frame sync : "H").
13	$\overline{\text{REMUTE}}$	O	Relay mutes (ON : "L").
14	EMPH	O	De-emphasis control pin (ON : "L").
15	DIRC	O	Servo IC DIRC pin .
16	VLDWN	O	Volume control level goes down.
17	BUSY	I/O	BUSY signal of serial data. (System control)
18	SDATA	I/O	Data signal of serial data. (System control)
19	$\overline{\text{OPNSW}}$	I	Tray open switch (When open : "L").
20	$\overline{\text{CLSSW}}$	I	Tray close switch (When close : "L").
21~24	KD0~KD3	I	Key matrix key return input pins.
25	DATA	O	Signal processing, servo IC control output pin (Control data signal).
26	XLT	O	Signal processing, servo IC control output pin (Control data latch signal).
27	CLK	O	Signal processing, servo IC control output pin (Control data transmission clock signal).
28	VLUP	O	Volume control level goes up.
29	–	–	Unused.
30	X1	I	System clock pulse input pin.
31	–	–	Unused.
32	Vss	–	GND.
33	XTI	–	GND.
34	–	–	Unused.
35	VLLED	O	LED for positioning output level (Blink : LEVEL varia).
36	PLYLD	O	PLAY LED lights.
37	PASLD	O	PAUSE LED lights.
38	$\overline{\text{FLSG}}$	O	Key scan signal when FL OFF (FL OFF : "H").
39	$\overline{\text{RESET}}$	I	Reset input pin (Active "L").
40~48	G1~G12	O	FL digit control pins.
49	N.C	–	Unused.
50	LCD	O	Signal for laser ON/OFF (Active "L").
51	MUTG	O	Muting signal for signal processor.
52	OPNM	O	Tray OPEN/CLOSE signal (Active "H").
53	CLSM		
54,55	SI,Sk	O	FL segment control pins (also for key scan signal).
56	VLOAD	I	FL driver negative power supply (–30V).
57	VREF	I	FL pre-driver negative power supply (–5V).
58~63	Pj~Pe	O	FL segment control pins (also for key scan signal).
64	VDD	–	Power supply (+5V).

6. RF AMP CXA1081S (X32-1500-11 : IC104)

General

The CXA1081S is an IC developed for use in Compact Disc players. It incorporates a 3-spot optical pickup RF output amplifier, a focusing error amplifier, a tracking error amplifier, and other signal processing circuitry, such as focus OK, mirror, defect, and EFM comparator circuits, as well as a laser diode APC (Automatic Power Control) circuit.

Features

- Operates on a signal +5 V power supply, as well as on a ±5 V dual-voltage power supply.
- Low power consumption (100 mW with ±5 V, 50 mW with +5 V).
- An APC circuit which accepts either a P-sub or N-sub laser diode.
- A minimum of external parts required.
- A disc defect detector circuit for improved playability.

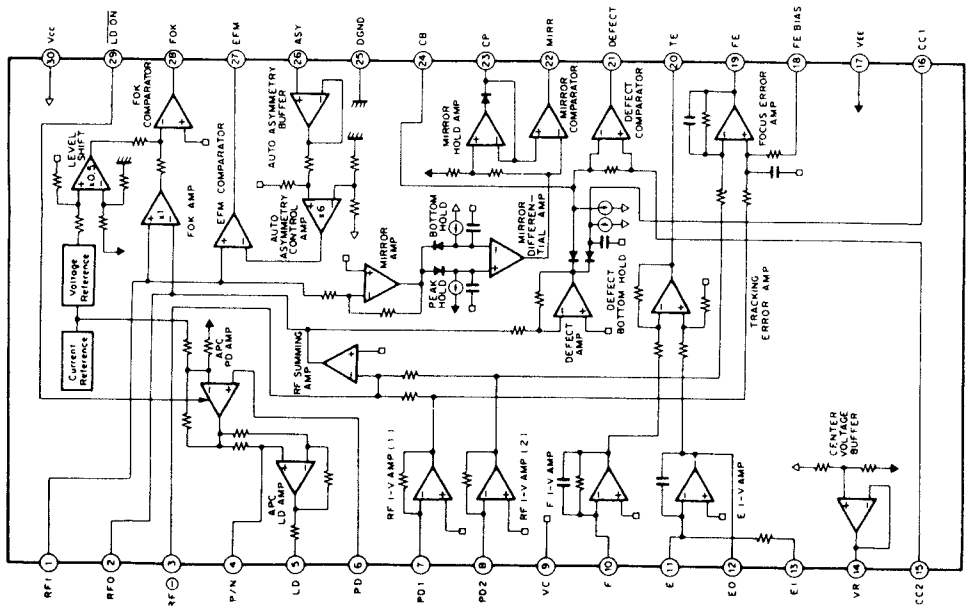
Structure

Bipolar silicon monolithic IC

Functions

- RF amplifier
- Focus OK detector circuit
- Mirror detector circuit
- Tracking error amplifier
- Defect detector circuit
- APC circuit
- EFM comparator
- Auto asymmetry control amplifier

6–1. Block diagram



CIRCUIT DESCRIPTION

6–2. Explanation of terminals (V_{CC}=2.5V, V_{EE}=D_{GND}=–2.5V, VC=GND)

Terminal No.	Terminal name	I/O	DC voltage (V)	Function
1	RFI	I	0	Input pin for the C-coupled signal output from the RF summing amplifier
2	RFO	O	V_{REF}	RF summing amplifier output pin. Used as the check point for the eye pattern
3	RF⊖	I	0	RF summing amplifier feedback input pin
4	P/N	I	0 (VC)	P-sub/N-sub select pin for the LD (Laser Diode). (DC voltage: in N-sub mode)
5	LD	O	–1.8	*APC LD amplifier output pin. (DC voltage: PD open in N-sub mode)
6	PD	I	0	*APC LD amplifier input pin. (DC voltage: open)
7	PD1	I	0	RF I-V amplifier (1) inverted input pin Current input by connecting to the photodiode A + C terminal
8	PD2	I	0	RF I-V amplifier (2) inverted input pin Current input by connecting to the photodiode B + D terminal
9	VC	–	0	Connected to GND when using a positive (+)/negative (–) dual-voltage power supply Connected to VR (pin 14) when using a single-voltage power supply
10	F	I	0	F I-V amplifier inverted input pin Current input by connecting to the photodiode F terminal
11	E	I	0	E I-V amplifier inverted input pin Current input by connecting to the photodiode E terminal
12	EO	O	0	E I-V amplifier output pin
13	EI	I	0	E I-V amplifier feedback input pin. For E I-V amplifier gain adjustment
14	VR	O	V_{CC}	DC voltage output pin of $(V_{CC} + V_{EE})/2$
15	CC2	I	1.0	Input pin for the C-coupled signal output from the defect bottom hold
16	CC1	O	1.2	Defect bottom hold output pin
17	V_{EE}	–	–2.5	Connected to the negative power supply when using a positive (+)/negative (–) dual-voltage power supply. Connected to GND when using a single-voltage power supply
18	FE BIAS	I	0	Bias pin on the focus error amplifier non-inverted side For CMR adjustment of the focus error amplifier
19	FE	O	V_{REF}	Focus error amplifier output pin
20	TE	O	V_{REF}	Tracking error amplifier output pin
21	DEFECT	O	V_{DEFECT}	Defect comparator output pin. (DC voltage: connected to a 10 k-ohm load)
22	MIRR	O	V_{MIRR}	Mirror comparator output pin. (DC voltage: connected to a 10 k-ohm load)
23	CP	I	–1.3	Mirror hold capacitor output pin Mirror comparator non-inverted input
24	CB	I	0	Defect bottom hold capacitor connect pin
25	DGND		–2.5	Connected to GND when using a positive (+)/negative (–) dual-voltage power supply Connected to GND (V_{EE}) when using a single-voltage power supply
26	ASY	I	–	Auto asymmetry control input pin
27	EFM	O	V_{EFM}	EFM comparator output pin. (DC voltage: connected to a 10 k-ohm load)
28	FOK	O	V_{FOK}	FOK comparator output pin. (DC voltage: connected to a 10 k-ohm load)
29	LD ON	I	–2.5 (DGND)	LD ON/OFF select pin. (DC voltage: when LD ON)
30	V_{CC}	–	2.5	Positive power supply

*APC: Automatic Power Control

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CIRCUIT DESCRIPTION

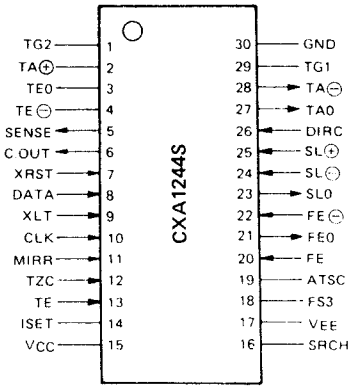
7. Servo control CXA1244S (X32-1500-11 : IC103)

CXA1244S is a bipolar IC developed for servo of compact disc (CD) players, and it provides the following functions.

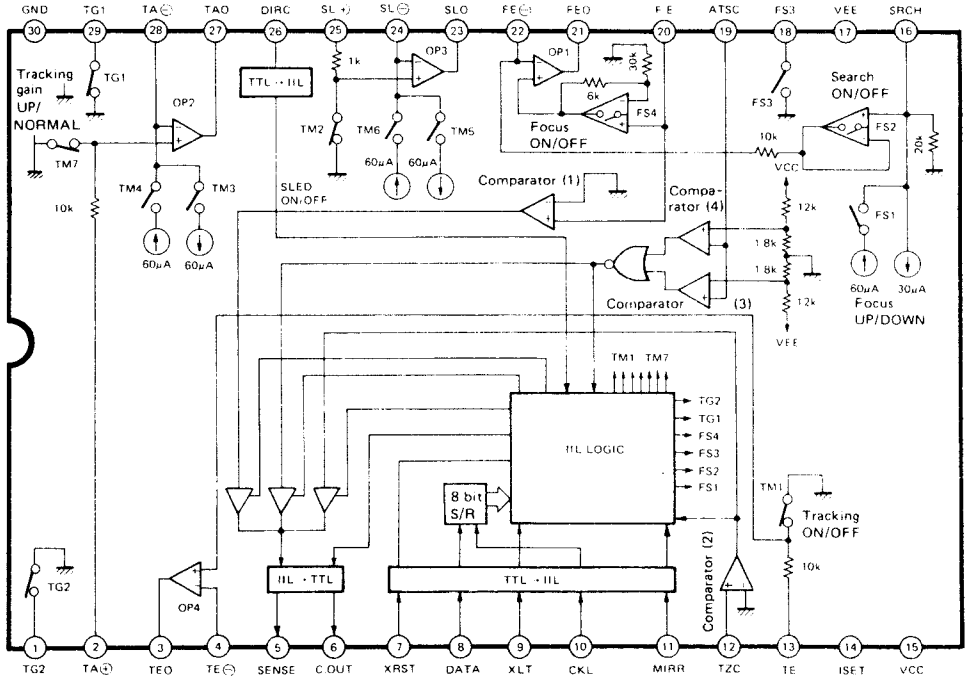
- Focus control (search ON/OFF, gain control)
- Tracking control (servo ON/OFF, single track jump, multiple track jump, gain control, phase compensation control, brake circuit)
- Sled control (servo ON/OFF, fast forward, fast reverse)

Servo function of each of focus, tracking and sled as well as random access operation are realized through control by microcomputer. Furthermore, the serial data bus can be shared with CXD1125Q.

7–1. Terminal connection diagram



7–2. Block diagram



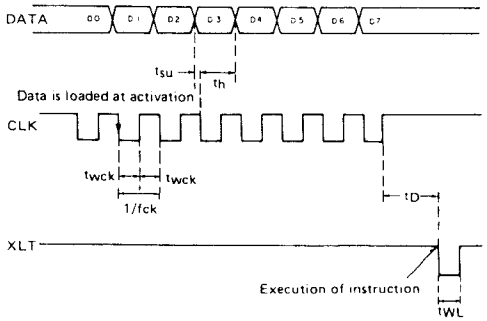
7–3. Explanation of terminals

Terminal No.	Terminal name	I/O	Functions
1	TG2		Tracking amplifier gain switching terminal. GND level.
2	TA ⊕		Non-inverted input of operational amplifier 2.
3	TE0		Output of operational amplifier 4.
4	TE ⊖	O	Inverted input of operational amplifier 4.
5	SENSE	O	Output of SSP internal status that corresponds to ADDRESS of CPU → SSP. (Changes in accordance with ADDRESS content of internal serial register.) See Note 1.
6	C. OUT	O	Signal output for counting number of tracks at the time of high speed access.
7	XRST	I	All internal registers are cleared when CPU → SSP "L". Connected with CPU RESET. See Note 2.
8	DATA	I	Serial data transmission of CPU → SSP. Input is made from LSB. D0~D7.
9	XLT	I	Latch of serial data of CPU → SSP. (The contents of internal serial register are transmitted to each address decoded latch.) Transmission at "L". Change to "H" occurs immediately after execution because no edge trigger is produced.
10	CLK	I	CPU → SSP serial data transmission clock. Data is read at falling. "H" level before and after transmission.
11	MIRR	I	Mirror signal input from RF amplifier.
12	TZC	I	Tracking error signal is input with C couple. The time constant is determined by one single track jump, but it is usually around 2kHz.
13	TE	I	Tracking error signal input.
14	ISET		Setting of current level for determining focus search voltage, tracking jump voltage and sled feed voltage.
15	Vcc		Power supply terminal. Normally −5V.
16	SRCH		The capacitor for determining the time constant of charge/discharge waveform for focus search is connected.
17	VEE		Power supply terminal. Normally −5V.
18	FS3		Focus amplifier gain switching terminal. GND level.
19	ATSC		Such information that a mechanical shock was applied to the player is input. Simply, a trakcing error is input through B.P.F.
20	FE	I	Input of focus error signal.
21	FE0	O	Output of operational ampiifier 1.
22	FE ⊖	I	Inverted input of operational amplifier 1.
23	SL0	O	Output of operational output 3.
24	SL ⊖	I	Inverted input of operational amplifier 3.
25	SL ⊕	I	Non-inverted input of operational amplifier 3.
26	DIRC	I	Used at the time of one track jump. Normally "H". The direction of the track jump pulse is reversed with "L". Setting is made in the normal tracking mode by changing to "H" "L" for a fixed length of time with detection of activation, deactivation of TZC.
27	TA0	O	Output of operational amplifier 2.
28	TA ⊖	O	Inverted input of operational amplifier 2.
29	TG1		Tracking amplifier gain switching terminal. GND level.
30	GND		GND terminal of IC.

Note 1 : SENSE terminal output

Serial data upper 4 bits	ADDRESS content	SENSE terminal output	Explanation
0 0 0 0	FOCUS CONTROL	FZC	"H" when focus zero cross. If focus error voltage is 0V or higher. Used at the time of FOCUS PULL operation.
0 0 0 1	TRACKING CONTROL	AS	"H" when the ATSC input level exceeds the wind comparator level (VTH = +Vcc × 13%). But this is not used in this equipment.
0 0 1 0	TRACKING MODE	TZC	Judgement output of positive or negative of tracking zero cross. tracking error. When used at the time of single track jump, DIRC is reduced to "L" on detection of TZC = "H" FWD JUMP. Soon detection of TZC = "L" REV JUMP.

Note 2 : Digital unit timing chart



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CIRCUIT DESCRIPTION

7–4. System control

COMMAND	ADDRESS				DATA				SENSE
	D7	D6	D5	D4	D3	D2	D1	D0	
FOCUS CONTROL	0	0	0	0	FS4 FOCUS ON	FS3 GAIN DOWN	FS2 SEARCH ON	FS1 SEARCH UP	FZC
TRACKING CONTROL	0	0	0	1	ANTI SHOCK	BREAK ON	TG2 GAIN	TG1* SET	AS
TRACKING MODE	0	0	1	0	TRACKING* MODE		SLED* MODE		TZC

GAIN SET* TG1, TG2 may be set independently.
In the case of ANTI SHOCK = 1 (00011XXX), both TG1, TG2 are inverted when ANTI SCHOCK = "H".

SLED MODE*

	D1	D0
OFF	0	0
SERVO ON	0	1
FWD MOVE	1	0
REV MOVE	1	1

TRACKING MODE*

	D3	D2
OFF	0	0
SERVO ON	0	1
FWD JUMP	1	0
REV JUMP	1	1

CIRCUIT DESCRIPTION

8. Digital signal processor CDX1165Q (X32-1500-11 : IC11)

General

The CXD1165Q is a digital signal processing LSI for a Compact Disc player, and has the following functions.

1. Bit clock reproduction by an EFM-PLL circuit
2. EFM data demodulation
3. Frame sync signal detection, protection and insertion
4. Powerful error detection and correction
5. Interpolation with an average value, or by holding the previous value
6. Demodulation of a sub code signal, error detection of a sub code Q
7. Spindle motor CLV servo
8. 8-bit tracking counter
9. CPU interface with a serial bus
10. Sub code Q register
11. Digital audio interface output
12. RAM the entrails.

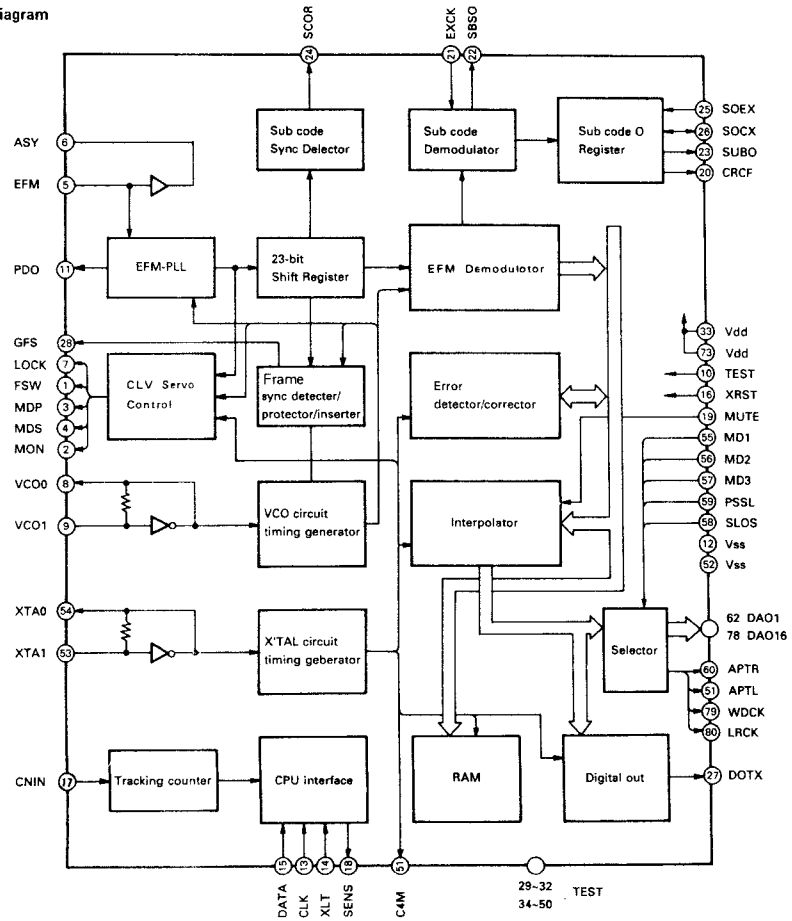
Features

- All digital signals used in playback can be processed using only a single chip.
- An aperture-correction digital filter is built in

Structure

CMOS IC

8–1. Block diagram



DP-7020

CIRCUIT DESCRIPTION

8-2. Explanation of terminals

Terminal No.	Terminal name	I/O	Function
1	FSW	O	Time constant switching output of output filter of spindle motor
2	MON	O	ON/OFF control output of spindle motor
3	MDP	O	Drive output of spindle motor. Rough speed control in CLV-S mode and phase control in CLV-P mode
4	MDS	O	Drive output of spindle motor. Speed control in CLV-P mode
5	EFM	I	EFM signal input from RF amplifier
6	ASY	O	Output for controlling the slice level of EFM signal
7	LOCK	O	Samples the GFS signal with WFCK/16, and outputs "H" when the level is high. When it is "L" for eight times, in arrow, outputs "L"
8	VCOO	O	VCO output. f = 8.6436 MHz when locked to EFM signal
9	VCOI	I	VCO input
10	TEST	I	(0 V)
11	PDO	O	Phase comparison output of EFM signal and VCO/2
12	Vss	–	GND (0 V)
13	CLK	I	Serial data transmission clock input from CPU. Data is latched at rising edge of a clock.
14	XLT	I	Latch input from CPU. Data (serial data from CPU) from the 8 bit shift register is latched in each register.
15	DATA	I	Serial data input from CPU
16	XRST	I	System reset input. Reset at "L"
17	CNIN	I	Input of tracking pulse
18	SENS	O	Output of internal status in correspondence to the address
19	MUTG	I	Muting input. In the case when ATTM of internal register A is "L". Normal status when MUTG is "L" or soundless state when it is "H"
20	CRCF	O	Output of result of CRC check of sub code Q
21	EXCK	I	Clock input for sub code serial output
22	SBSO	O	Sub code serial output
23	SUBQ	O	Sub code Q output
24	SCOR	O	Sub code sync S0 + S1 output
25	SQCK	I/O	Sub code Q read-off clock
26	SQEX	I	SQCK select input.
27	DOTX	O	DIGITAL OUT output. (Outputs the WFCK signal when CXD1130Q or D0 is off)
28	GFS	O	Display output of frame sync lock status
29	DB08	I/O	H or L position. Don't open circuit.
30	DB07	I/O	H or L position. Don't open circuit.
31	DB06	I/O	H or L position. Don't open circuit.
32	DB05	I/O	H or L position. Don't open circuit.
33	VDD	–	Power supply (+5 V)
34	DB04	I/O	H or L position. Don't open circuit.
35	DB03	I/O	H or L position. Don't open circuit.
36	DB02	I/O	H or L position. Don't open circuit.
37	DB01	I/O	H or L position. Don't open circuit.
38	RA01	O	H or L position. Don't open circuit.
39	RA02	O	H or L position . Don't open circuit.
40	RA03	O	H or L position. Don't open circuit.
41	RA04	O	H or L position. Don't open circuit.
42	RA05	O	H or L position. Don't open circuit.
43	RA06	O	H or L position. Don't open circuit.

CIRCUIT DESCRIPTION

Terminal No.	Terminal name	I/O	Function
44	RA07	O	H or L position. Don't open circuit.
45	RA08	O	H or L position. Don't open circuit.
46	RA09	O	H or L position. Don't open circuit.
47	RA10	O	H or L position. Don't open circuit.
48	RA11	O	H or L position. Don't open circuit.
49	RAWE	O	H or L position. Don't open circuit.
50	RACS	O	H or L position. Don't open circuit.
51	C4M	O	Crystal dividing output f = 4.2336 MHz
52	Vss	–	GND (0 V)
53	XTAI	I	Crystal oscillator input. f = 8.4672 MHz or 16.9344 MHz depending on the mode selected
54	XTAO	O	Crystal oscillator output. f = 8.4672 MHz or 16.9344 MHz depending on the mode selected
55	MD1	I	Mode select input 1
56	MD2	I	Mode select input 2
57	MD3	I	Mode select input 3
58	SLOB	I	Audio data output code select input. 2's complement output when "L", offset binary output when "H"
59	PSSL	I	Audio data output mode select input. Serial output when "L", parallel output when "H"
60	APTR	O	Aperture compensation control output. "H" when R-ch
61	APTL	O	Aperture compensation control output. "H" when L-ch
62	DA01	O	DA01 (parallel audio data LSB) output when PSSL = "H", C1F1 output when PSSL = "L"
63	DA02	O	DA02 output when PSSL = "H", C1F2 output when PSSL = "L"
64	DA03	O	DA03 output when PSSL = "H", C2F1 output when PSSL = "L"
65	DA04	O	DA04 output when PSSL = "H", C2F2 output when PSSL = "L"
66	DA05	O	DA05 output when PSSL = "H", C2FL output when PSSL = "L"
67	DA06	O	DA06 output when PSSL = "H", C2PO output when PSSL = "L"
68	DA07	O	DA07 output when PSSL = "H", RFCK output when PSSL = "L"
69	DA08	O	DA08 output when PSSL = "H", WFCK output when PSSL = "L"
70	DA09	O	DA09 output when PSSL = "H", $\overline{\text{PLCK}}$ output when PSSL = "L"
71	DA10	O	DA10 output when PSSL = "H", UGFS output when PSSL = "L"
72	DA11	O	DA11 output when PSSL = "H", GTOP output when PSSL = "L"
73	VDD	–	Power supply (+5 V)
74	DA12	O	DA12 output when PSSL = "H", RAOV output when PSSL = "L"
75	DA13	O	DA13 output when PSSL = "H", C4LR output when PSSL = "L"
76	DA14	O	DA14 output when PSSL = "H", $\overline{\text{C2IO}}$ output when PSSL = "L"
77	DA15	O	DA15 output when PSSL = "H", C2IO output when PSSL = "L"
78	DA16	O	DA16 (parallel audio data MSB) output when PSSL = "H", DATA output when PSSL = "L"
79	WDCK	O	Strobe signal output. 176.4 kHz when DF is ON, 88.2 kHz with CXD1125Q or when DF is OFF
80	LRCK	O	Strobe signal output. 88.2 kHz when DF is ON, 44.1 kHz with CXD1125Q or when DF is OFF

Notes:

C1F1 :
C1F2 : Error correction status monitor output for C1 decode.

C2F1 :
C2F2 : Error correction status monitor output for C2 decode.

C2FL : Correction status output. Goes "H" when the currently corrected C2 series data cannot be corrected.

C2PO : C2 pointer signal. Synchronized to the audio data output.

RFCK : Read frame clock output. 7.35 MHz when locked to the crystal line.

WFCK : Write frame clock output. 7.35 MHz when locked to the crystal line.

$\overline{\text{PLCK}}$: VCO/2 output. f = 4.3218 MHz when locked to the EFM signal.

UGFS : Non-protected frame sync pattern output.

GTOP : Frame sync protect status display output.

RAOV : ±4 frame jitter absorption RAM overflow and underflow display output.

C4LR : Strobe signal. 352.8 kHz when DF is ON, 176.4 kHz with CXD1125Q or when DF is OFF.

BLCK : Output of bit clock. 2.1168MHz

$\overline{\text{BLCK}}$: Inverted output bit clock.

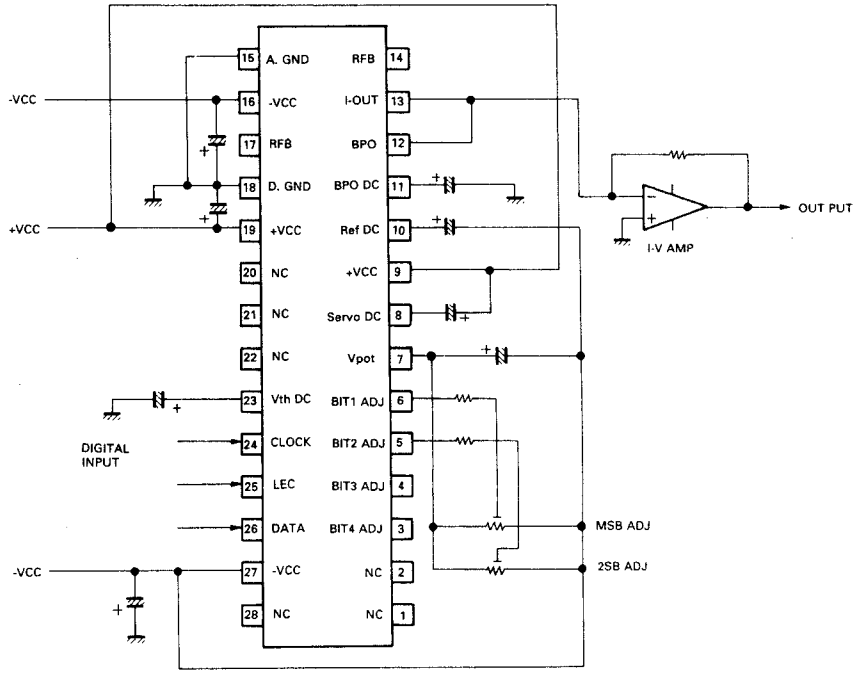
DATA : Audio signal serial data output.

DP-7020

CIRCUIT DESCRIPTION

9. 18bit serial input D/A converter PCM1701 (X32-1500-11 : IC6, 7)

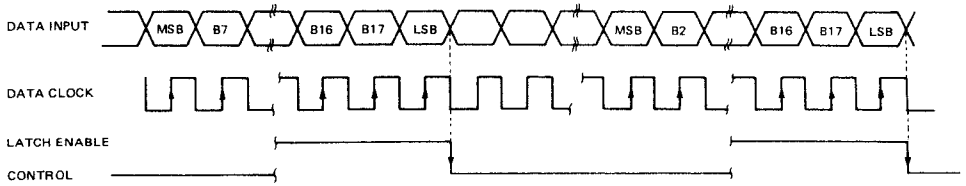
9-1. Terminal connection diagram



9-2. Terminal connections

Pin No.	Name	Pin No.	Name	Pin No.	Name
1	NC	11	BPO Filter	21	NC
2	NC	12	Bipolar offset	22	NC
3	Bit 4 ADJ	13	Power supply output	23	VTH filter
4	Bit 3 ADJ	14	RF	24	Clock input
5	Bit 2 ADJ	15	Analog common	25	LEC input
6	Bit 1 ADJ	16	–Vcc	26	DATA input
7	V POT	17	RF	27	–Vcc
8	Servo filter	18	Digital common	28	NC
9	+Vcc	19	+Vcc		
10	Reference filter	20	NC		

9-3. Timing chart



- The data format is of 2's complement, right-justified or continuous data of MSB first.
- Data is taken in to the shift register at the rise of the data clock pulse.

CIRCUIT DESCRIPTION

10. 8x over-sampling digital filter SM5818AP (X32-1500-11 : IC9)

10-1. Function

- 2-channel processing
- 8x over-sampling (interpolation) filter
  (hereinafter referred to as 8fs for short)
- Serial input data
  2's complement, MSB first
  16-bit
- Serial output data
  MSB first
  2's complement/COB selectable
  Selectable between 16-, 18- and 20-bit
- Jitter-free
  Prevents any faulty operation due to the jitter of the input clock signal, thus eliminating the jitter transmission over to the output.
- System clock pulse
  Selectable from 192fs, 256fs, 384fs and 512fs
- Crystal oscillation circuit incorporated
- I/O TTL compatible
- 5 V single power supply
- 28-pin plastic DIP

10-2. Filter configuration

- Interpolation filter
  Linear phase FIR filter 3-stage configuration
  First stage (fs — 2fs), 153rd
  Second stage (2fs — 4fs), 29th
  Third stage (4fs — 8fs), 17th
- 22-bit filter coefficient, 20x22 bit parallel multiplier/25-bit accumulator high-accuracy operation
- Overflow limiter incorporated

10-3. Applications

- CD playback
- DAT playback
- PCM playback

10-4. Filter characteristics

Characteristic item	Performance
Pass band	0 ~ 0.4535fs
Reject band	0.5465fs ~ 7.4535fs
Pass band ripple	Within ±0.00005dB
Reject band attenuation	More than 110dB
Group delay time	Fixed

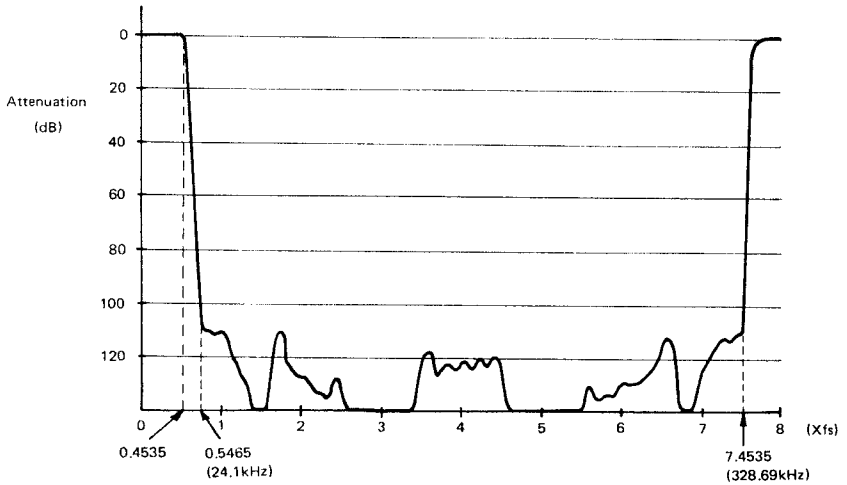
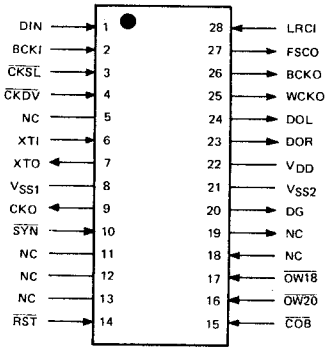


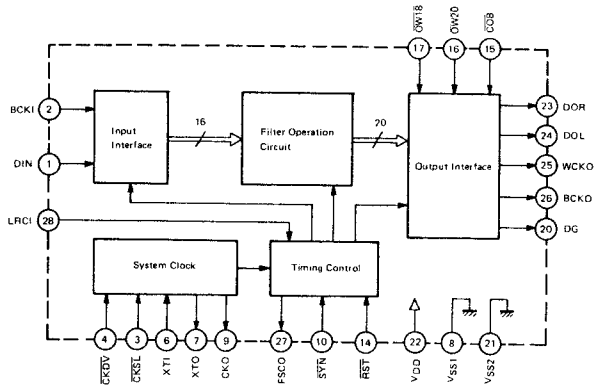
Fig. 8 Frequency response

CIRCUIT DESCRIPTION

10–5 Terminal connection diagram



10–6 Block diagram



10–7. Explanation of terminals

"fs" occurring in the description means the sampling frequency of the input data.

Pin No.	Pin Name	I/O	Function
1	DIN	I	Input data.
2	BCKI	I	Input data beat clock pulse.
3,4	$\overline{CKSL}$, $\overline{CKDV}$	I	XTI pin input frequency selection. (For details, refer to the description of XTi pin.)
5	NC	–	Unused.
6	XTI	I	Oscillator section input pin. 192 fs : CKSL = "H", CKDV = "H" 256 fs : CKSL = "H", CKDV = "L" 384 fs : CKSL = "L", CKDV = "H" 512 fs : CKSL = "L", CKDV = "L"
7	XTO	O	Oscillator section output pin.
8	V_{SS1}	–	GND1.
9	CKO	O	Oscillator section output clock pulse. (Frequency is the same as in XTI pin.)
10	$\overline{SYN}$	I	Jitter-free mode/compulsory sync mode selection. ("H : Jitter-free mode, "L" : Compulsory sync mode)
11~13	NC	–	Unused.
14	$\overline{RST}$	I	System reset. ("H" : normal operation, "L" : system reset)
15	$\overline{COB}$	I	2's complement/COB selection. ("H" : 2's complement, "L" : $\overline{COB}$)
16,17	$\overline{OW20}$, $\overline{OW18}$	I	Number-of-output-bits selection.

No. of output bits	16	18	20
$\overline{OW18}$	H	L	H
$\overline{OW20}$	H	H	L

18,19	NC	–	Unused.
20	DG	O	Deglitch control clock pulse.
21	V_{SS2}	–	GND2.
22	V_{DD}	–	Power supply (+5V).
23	DOR	O	Rch 8x over-sampling output data.
24	DOL	O	Lch 8x over-sampling output data.
25	WCKO	O	Output data word clock pulse.
26	BCKO	O	Output data bit clock pulse.
27	FSCO	O	fs-period internal operation timing clock pulse.
28	LRCI	I	Input data sampling rate (fs) clock pulse. ("H" : Lch, "L" : Rch)

10-8. Function

• 8x over-sampling (interpolation) filter function

This function works to output the over-sampling data of sampling rate 8fs. In this case, sampling noises between 0.5465fs (24.1kHz) and 7.4535fs (328.69kHz) are removed.

The interpolation operation block configuration of this LSI is of a cascade connection of three 2x interpolation filters (FIR).

• System clock (XTI, XTO, CKO, $\overline{\text{CKSL}}$, $\overline{\text{CKDV}}$)

The system clock pulse can be selected from 192fs, 256fs, 384fs and 512fs. More, operation is feasible even by an external clock (input to pin XTI) or a crystal oscillator (inserted between pins XTI and XTO). In this unit, a clock pulse of 8.4672 MHz is input to pin XTI.

From pin CKO, the system clock pulse is output. (See Figure 10-3.)

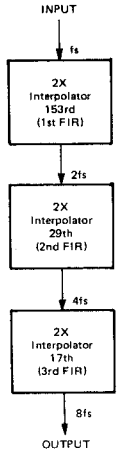


Fig. 9 Configuration of basic operation section

$\overline{\text{CKDV}}$		H		L	
$\overline{\text{CKSL}}$		H	L	H	L
XTI input clock frequency (Fxi)	Fxi = 1/tXI	192fs	256fs	384fs	512fs
Clock pulse input method		External clock (input to pin XTI) or internal clock (a crystal oscillator inserted between pin XTI and XTO).			
Internal system clock pulse period	Tsys	tXI		2*tXI	

tXI stands for the XTI input clock pulse period.

Table 10–1 System clock frequency selection and internal system clock

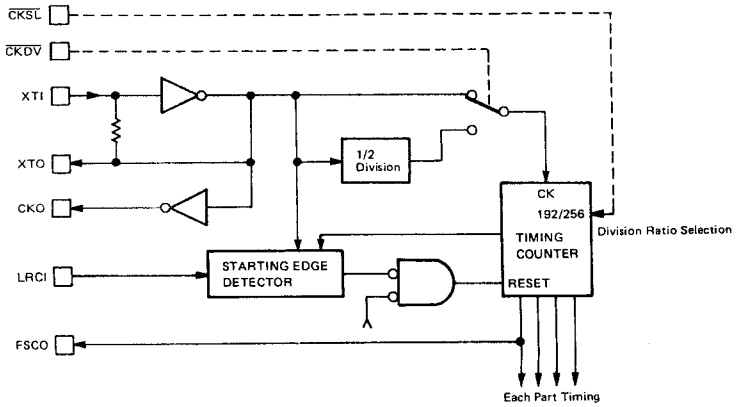


Fig. 10 Clock generation circuit

DP-7020

CIRCUIT DESCRIPTION

• Auto data input (DIN, BCKI, LRCI)

The input data is handled as being of 2's complement, MSB first. Each bit of the serial data input to pin DIN is read in to register SIPO (serial/parallel conversion register) a the leading edge of bit clock pulse BCKI, in which it is in turn converted into a parallel data. The output of SIPO is transferred to each of the Lch and Rch input registers at the trailing/leading edge of clock pulse LRCI.

In addition, the operation section and the output section are independent in signal timing from the input section and are therefore unsusceptible to the jitter of the input section. (Jitter-free mote: For details, refer to the description occurring later.)

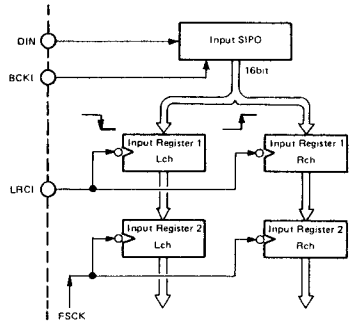
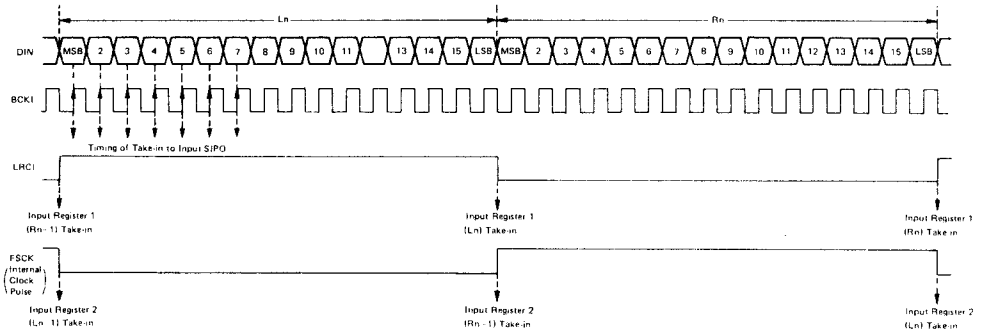


Fig. 11 Configuration of audio data input section



16bits right before LRCI edge is taken in as data.

Fig. 12 Audio data input timing example

• Selection between jitter-free mode and compulsory sync mode ($\overline{\text{SYN}}$, FSCO)

The signal timing (internal timing) applied to internal operation or output, that is produced from the system clock pulse (input to pin XTI), is independent from that of the data input section (BCKI, LRCI).

For this internal timing, the method of countering the jitter of clock pulse input LRCI is available in two types, "jitter-free mode" and "compulsory sync mode". Selection between these both is feasible by setting $\overline{\text{SYN}}$.

1) Jitter-free mode ($\overline{\text{SYN}}$="H")

As long as the phase difference between clock pulse LRCI and the internal timing is within +3/8 to –3/8 of the input sampling period (1/fs), the internal timing is not adjusted. Accordingly, even with a jitter component in clock pulse LRCI, the internal timing is not affected so that it is free from faulty operation or jitter transmission to output.

When the phase difference is without the above range, the internal timing is put in phase synchronously with the start side of clock pulse LRCI. More, this treatment is also performed when the reset input is given.

2) Compulsory sync mode ($\overline{\text{SYN}}$="L")

When this mode is engaged, the internal timing is always reset at a pulse edge of the start side of input LRCI. In this case, when a pulse period shorter than the specified system clock pulse period exists due to the jitter of input LRCI, a faulty operation may result.

Conversely, when a pulse period longer exists, the operation is properly made but no equal output timing is obtained.

3) Clock pulse FSCO (output)

This is a clock pulse with a period of fs obtained from the dividing process of clock pulse XTI.

• Data and DAC control signal output (DOL, DOR, BCKO, WCKO, DG, $\overline{COB}$, $\overline{OW18}$,$\overline{OW20}$)

1) Output data format

1) MSB first
2) 2's complement/COB (Complemented Offset Binary) selection ($\overline{COB}$)
   2's complement format ($\overline{COB}$="H")
   COB format ($\overline{COB}$="L")

2) Output data number-of-bits selection ($\overline{OW18}$, $\overline{OW20}$)

As to the number of bits for the output data, any of 16, 18 and 20-bit can be selected.
   16-bit output ($\overline{OW18}$="H", $\overline{OW20}$="H")
   18-bit output ($\overline{OW18}$="L", $\overline{OW20}$="H")
   20-bit output ($\overline{OW18}$="H", $\overline{OW20}$="L")
However, this unit is set at the 18-bit output mode.

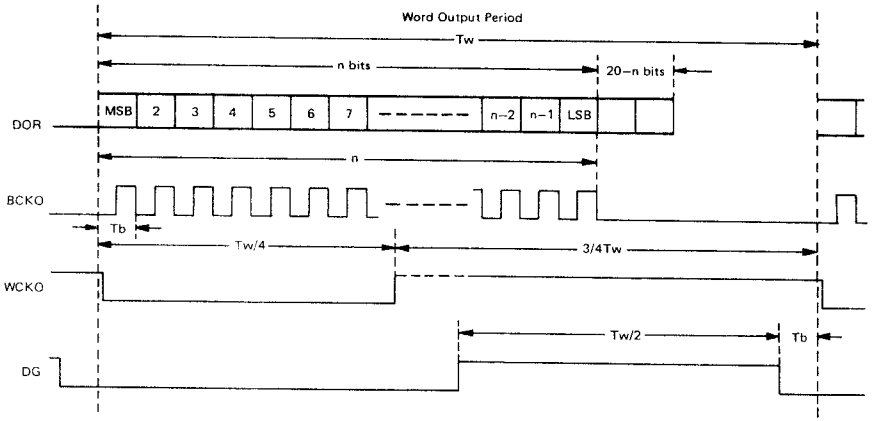
3) Output timing

The output timing of the audio output section is determined according to each internal system clock pulse frequency.

Item	Symbol in diagram	$\overline{CKSL}$	
		H	L
Internal system clock pulse frequency		192fs	256fs
Bit clock pulse period	Tb	Tsys	Tsys
Data word length	Tw	24*Tsys	32*Tsys

Tsys : internal clock pulse period (Refer to Table 10-1.)
Tb, Tw : serial output timing (Refer to Figure 13)

Table 10–2 Output timing



Note : n means the number of output word bits.

Fig. 13 Output timing

• System reset ($\overline{RST}$)

When the reset input is made in the jitter-free mode, the internal operation timing is reset in synchronization with the leading edge of input LRCI. Making use of this, the output timing in the jitter-free mode can be aligned with input LRCI.

In the compulsory sync mode, no system reset is needed. Even in the jitter-free mode, the output timing does not need to be aligned with input LRCI and no system reset is necessary.

For system reset at power ON, externally connect a capacity of around 100pF to pin $\overline{RST}$. (Figure 10-7)

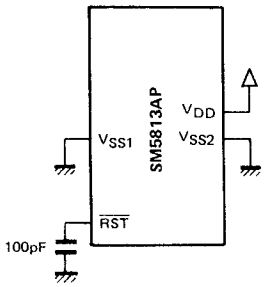
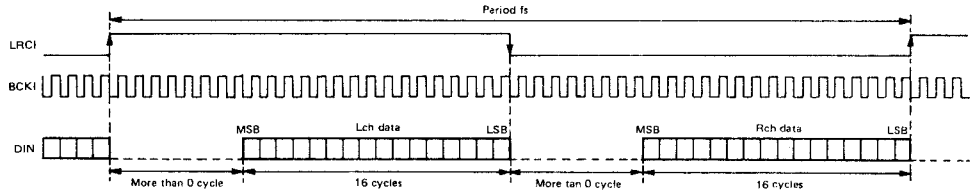


Fig. 14 Circuit example of system reset at power ON

10–9. Timing chart

• Serial input timing (DIN, BCKI, LRCI)



Note : BCKI should have 18 cycles or more for one word.

Fig. 15 Serial input timing

• Serial output timing (DOL, DOR, BCKO, WCKO, DG)

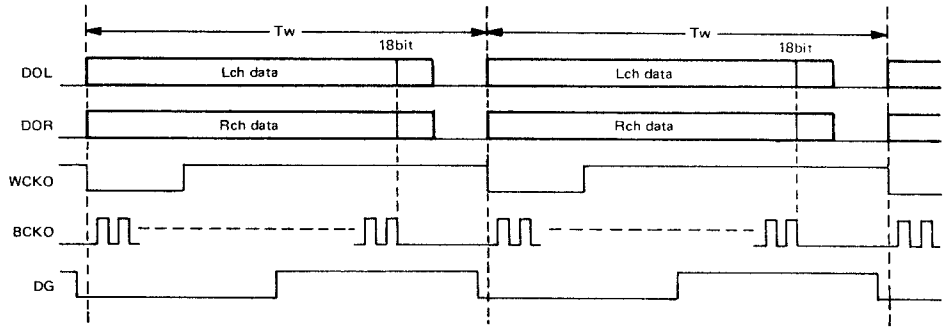
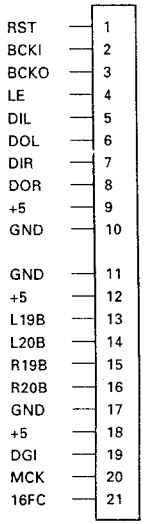


Fig. 16 Serial output timing

CIRCUIT DESCRIPTION

11. D.P.A.C IC KAG01 (X32-1500-11 : IC13)

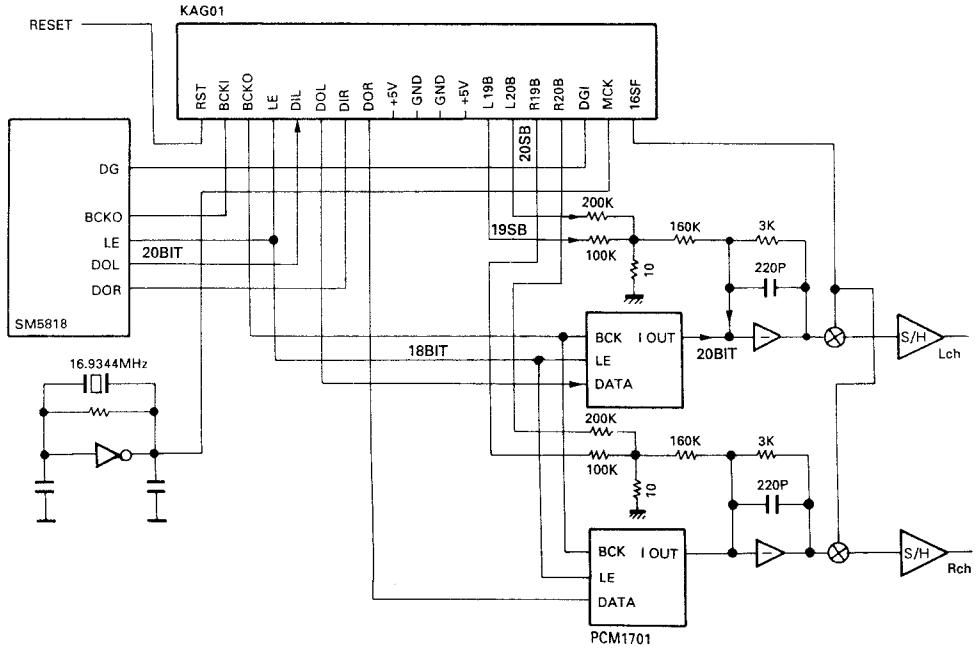
11-1. Terminal connection diagram



11-2. Explanation of terminals

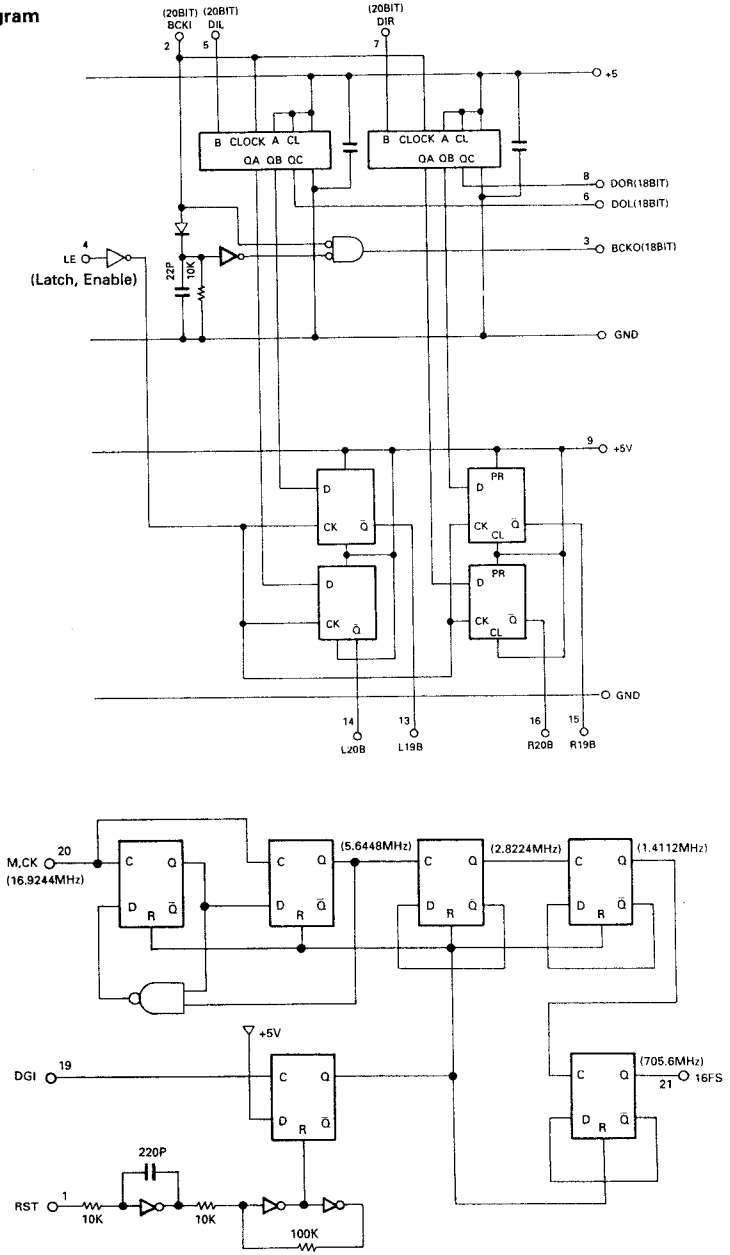
Pin NO.	Pin Name	Function
1	RST	Reset input.
2	BCKI	Bit, Clock input (20bit).
3	BCKO	Bit, Clock output (18bit).
4	LE	Latch, Enable.
5	DIL	L-ch data input (20bit).
6	DOL	L-ch data output (18bit).
7	DIR	R-ch data input.
8	DOR	R-ch data output.
9	+5	
10,11	GND	
12	+5	
13	L19B	L-ch 19bit Data output. (complement output)
14	L20B	L-ch 20bit Data output. (complement output)
15	R19B	R-ch 19bit Data output. (complement output)
16	R20B	R-ch 20bit Data output. (complement output)
17	GND	
18	+5	
19	DGI	Input of D-guritch output of digitaifilter.
20	MCK	16.9344MHz input.
21	16FS	16x D-guritch output.

11-3. Block diagram



CIRCUIT DESCRIPTION

11-4. Block diagram



CIRCUIT DESCRIPTION

• TBC function

The write data clock pulse (WFS) and the read data clock pulse (RFS) are independent in operation from each other. Thus, the jitter margin ranges ±1 clock pulse widths.

For 2MSB detection, the level (2's complement) of the 2MLSB detection value at playback is output for both Lch and Rch.

Figure 17 shows the I/O waveforms in use of each digital filter.

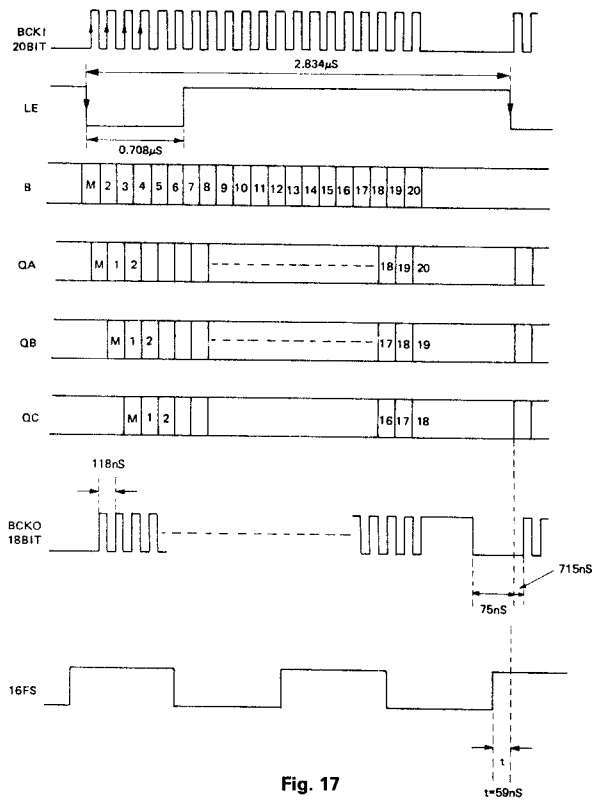


Fig. 17

• PLL function

Since the phase comparator is of a well-known system, its description is not made here.

For the counter setting of the divider, the type of the input clock pulse, LPF and VCXO circuit configuration, etc., refer to "11-3 Block diagram" and "11-2 Pin functions".

• Digital filter mode setting

Only two modes are available, 16-bit and 18-bit modes. This unit is set at the 18-bit mode.

The mode change is performed at the time of muting. The status right before the cancel of muting is held.

MECHANISM OPERATION DESCRIPTION

Mechanism Operation Description

Fig. 1 shows the relationship of mechanisms in the STOP mode. The OPEN/CLOSE operation of the mechanism and the UP/DOWN operation of the pickup chassis when loading the disc are description below.

Note 1 : The black arrow (OPEN) and the white arrow (CLOSE) in the operation description have the following meanings :

Black arrow (OPEN) : Tray opening direction (Tray OPEN)

White arrow (CLOSE) : Tray closing direction (Tray CLOSE)

Note 2 : Figures in the bracket ( ) in the operation description or accompanied with the part name in the diagram show the reference numbers in the Exploded View.

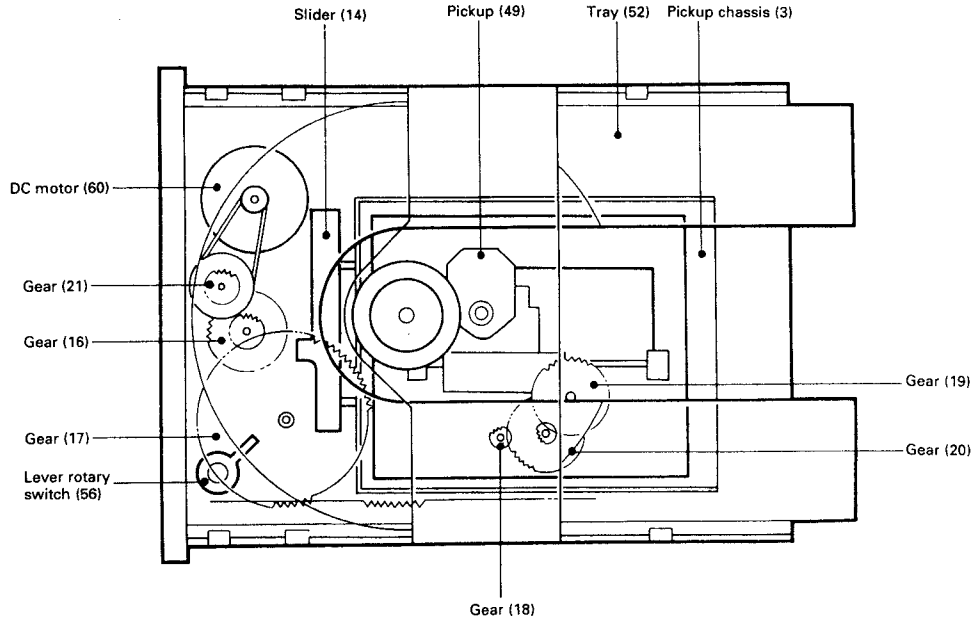


Fig. 1 Tray closed status

MECHANISM OPERATION DESCRIPTION

1. Tray OPEN/CLOSE Operation

By the rotation of the motor (❶), the gear (❷) is rotated and the tray starts OPEN/CLOSE (❸) operation. The OPEN/CLOSE operation stops when the protrusion of the gear comes in contact with the detection switch (❹).

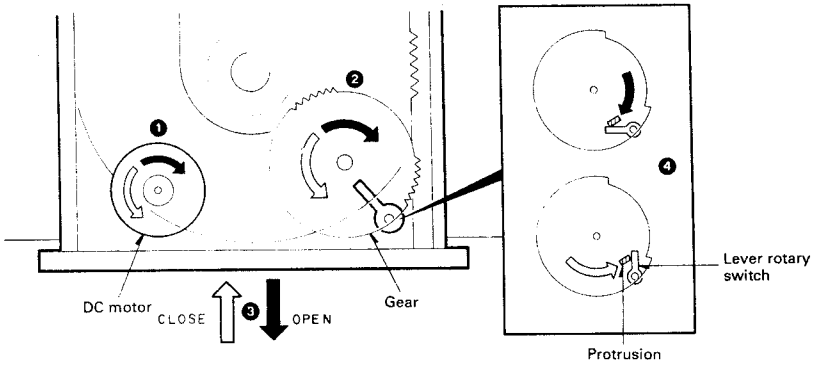


Fig. 2 Tray OPEN/CLOSE operation

2. Pickup Chassis UP/DOWN Movement

Accompanied with the OPEN/CLOSE operation, the lever is shifted (❷) by the rotation of the gear (❶). Along with the grooves in the lever, the pickup chassis moves up and down (❸).

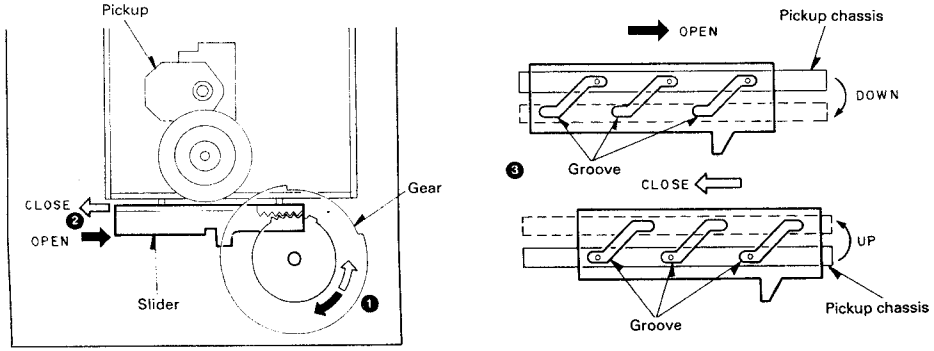


Fig. 3 Pickup chassis UP/DOWN movement

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MECHANISM OPERATION DESCRIPTION

3. Gear Installing Position

When re-installing the gear after removing it, attach the gear at the position (Ⓐ) shown in the condition when the pickup chassis has been lowered.

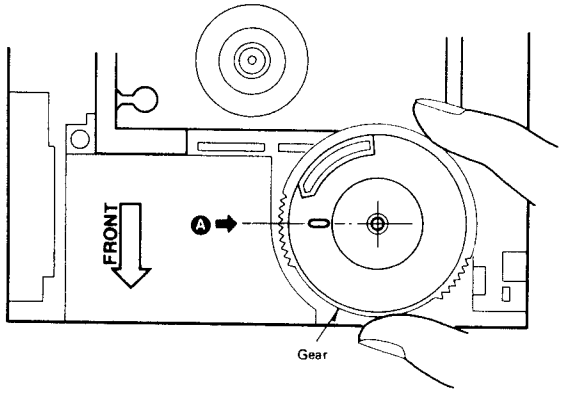

Fig. 4 Gear installing position

ADJUSTMENT

No.	ITEM	INPUT SETTING	OUTPUT SETTING	PLAYER SETTING	ALIGNMENT POINT	ALIGN FOR	FIG
1	LASER POWER	-	Apply the sensor section of the optical power meter on the pickup lens.	Short-circuit pins TEST and turn the power on to enter the test mode. Press the MANUAL S. key(⏭)to move the pickup outwards. Press the CHECK key to check that the LD emits light. Then, confirm that the display is " 03 ".	-	On the power from 0.1 to 0.3mW, when the diffraction grating is correctly aligned with the RF level of 1.0Vp-p or more and the TE (servo open) level of 1.0Vp-p or more, the pickup is acceptable.	(a)
2	VCO	-	Connect a frequency counter to PLCK (X32-1500)	Press the STOP key, and confirm that the display is "01".	L4 (X32-1500)	4.30MHz	(b)
3	TRACKING ERROR BALANCE	Test disc Type 4	Connect an oscilloscope as follows. CH1: RF (X32-1500 RF) CH2: TE (X32-1500 TP3)	Press the REPEAT key to open the tray. Load a disc and close the tray by pushing it by hand. Then, press the CHECK key. Confirm that the display is "03".	TE BALANCE VR104 (X32-1500)	Symmetry between upper and lower patterns, or DC=0±0.03V	(c)
4	FOCUS ERROR BALANCE	Test disc Type 4	Connect an oscilloscope as follows. CH1: RF (X32-1500 RF) CH2: TE (X32-1500 TP3)	Press the PLAY key. Confirm that the display is " 05 ".	FE BALANCE VR103 (X32-1500)	Optimum eyepattern	(d)
5	FOCUS GAIN	Test disc Type 4 Apply signal of 800Hz, 50Vrms to CN10 pin 1-2. (X32-1500)	Connect an LPF to CN10 pin 1-2, to which connect an oscilloscope or an AC voltmeter. (X32-1500)	Press the PLAY key. Confirm that the display is " 05 ".	FOCUS GAIN VR101 (X32-1500)	Two VTVMs should read the same value. 50mVrms	(e)
6	TRACKING GAIN	Test disc Type 4 Apply signal of 1.0kHz, 50Vrms to CN10 pin 4-5. (X32-1500)	Connect an LPF to CN10 pin 4-5, to which connect an oscilloscope or an AC voltmeter. (X32-1500)	Press the PLAY key. Confirm that the display is " 05 ".	TRACKING GAIN VR102 (X32-1500)	Two VTVMs should read the same value. 50mVrms	(e)
7	DAC DISTORTION (MSB)	Test disc Type 4	Connect an distortion meter to the output terminal(FIXED).	Play the 1kHz, -20dB signal in track No.15	VR1:Lch VR2:Rch (X32-1500)	Minimum distortion	(f)
8	DAC DISTORTION (2SB)	Test disc Type 4	Connect an distortion meter to the output terminal(FIXED).	Play the 100Hz, 0dB signal in track No.4.	VR9:Lch VR10:Rch (X32-1500)	Minimum distortion	(f)

(Note) Type 4 disc: SONY YEDS-18 Test Disc or equivalent.
LPF: Around 47kΩ+390pF or so.
Step 1-6 are in TEST mode.
If adjust step 7 or 8, shold readjust steps 7 and 8.

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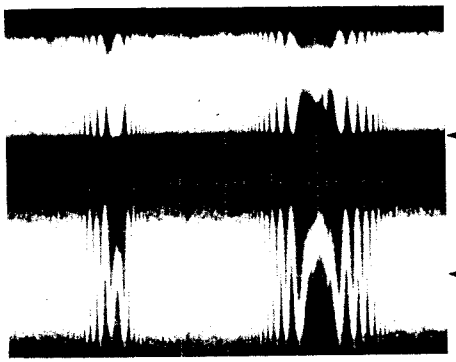
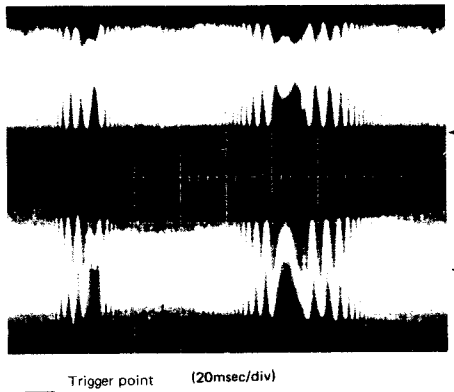
ADJUSTMENT

DIFFRACTION GRID ADJUSTMENT



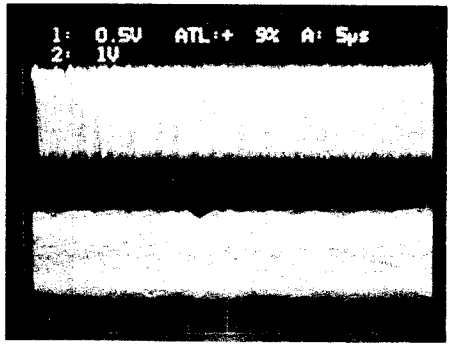
(Photo. 1)

- RF signal and T.Error signal after diffraction grating adjustment.



(Photo. 2)

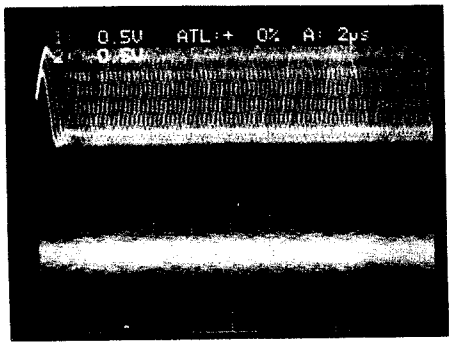
- RF signal and T.Error signal when there is small diffraction grating position error.
- The T.Error signal level is small, and the envelope is as shown in the diagram below.



(Photo. 3)

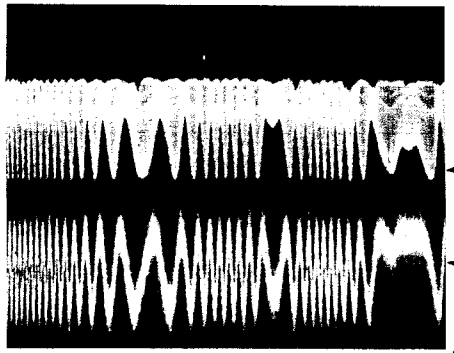
- RF signal and T.Error signal in test mode (with focusing ON).
- When the sub-beam traces the same bit series as the main beam during diffraction grating adjustment, bringing the RF trigger point to the position shown in the Photo causes a "projection" to be observies in the T.Error waveform.

ADJUSTMENT



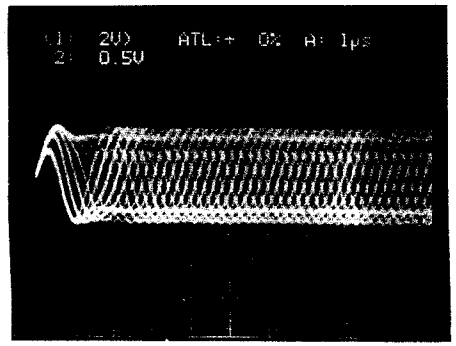
(Photo. 4)

- RF signal and E.Spot signal in test mode (PLAY).
- If the diffraction grating has been adjusted properly, the influence of triggering is observed on the E.Spot waveform of approx. 20μs after RF signal, in the form of a projection.



(Photo. 5)

- RF signal and T.Error signal; in test mode (Focusing ON). (Disc type 4)
- Adjust T.Error so that the waveform is symmetrical above and below 0V. (VR104 of X32-1500)



(Photo. 6)

- RF signal in test mode (PLAY).
- Perform the tangential and focusing offset adjustments so that each of the center cross points are focused into one point on the display. The crossing points above and below the center shall also be displayed clearly.

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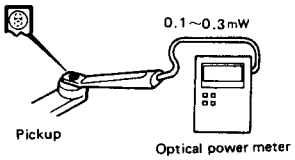
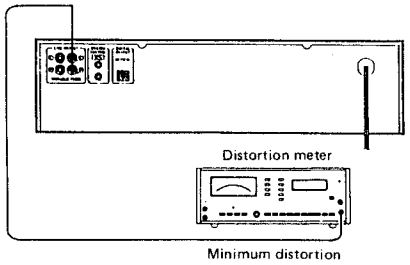
ADJUSTMENT

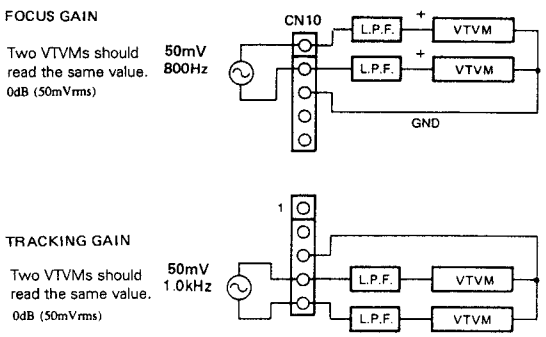
(a) Laser Power

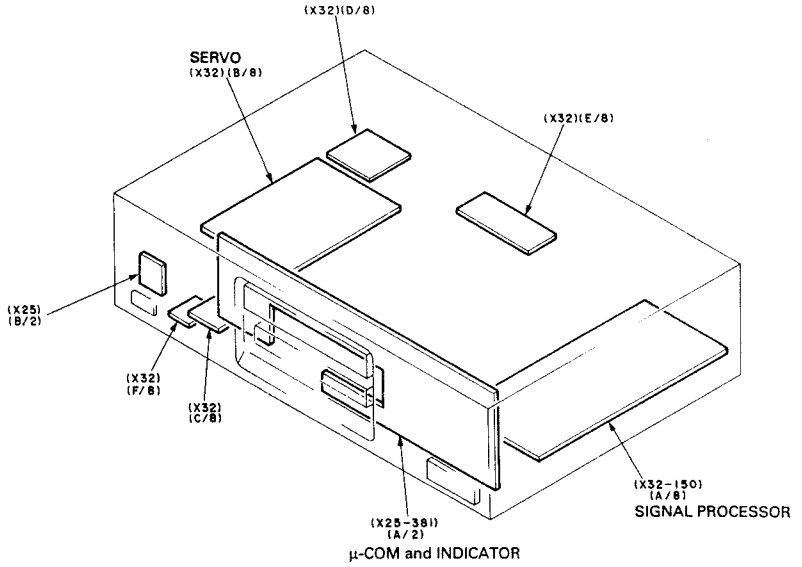


(f) DAC Distortion



(e) Focus Gain and Tracking Gain





DP-7020

VOLTAGE TABLE

(X32-1500-11)

IC1

1	-2.6V
2,3	0V
4	-16.2V
5,6	5.6V
7	2.0V
8	15.6V

IC2,3

1~3	0V
4	-10.4V
5~7	0V
8	10.5V

IC4

2,3	0V
4	-10.4V
5~7	0V
8	10.5V

IC5

1~3	0V
4	-10.4V
5~7	0V
8	10.5V

IC6,7

1,2	0V
3	-9.5V
4	-9.6V
5,6	-9.7V
7(IC6)	-9.0V
7(IC7)	9.0V
8	1.7V
9	5.0V
10	-4.3V
11	3.3V
12~18	0V
19	5.0V
20~22	1.0V
23	3.3V
24	3.0V
25	4.0V
26	0V
27(IC6)	-11.0V
27(IC7)	11.0V
28	0V

IC8

1	5.6V
2,3	5.0V
4	-10.5V
5,6	5.0V
7	5.6V
8	9.0V

IC9

1	0V(2.8V)
2	3.4V
3	5.0V
4,5	0V
6	3.2V
7	2.7V
8	0V
9	3.1V
10~13	0V
14,15	5.0V
16	0V
17	5.0V
18,19	0V
20	2.9V
21	0V
22	5.0V
23,24	0V
25	4.0V
26	2.8V
27,28	2.5V

IC10

1~6	3.3V
7	0V
8	3.3V
9	2.8V
10~13	3.3V
14	5.0V

IC11

1	0V	34~40	0V
2	0V(5.0V)	51	3.3V
3	0V(2.5V)	52	0V
4	0V(2.8V)	53	3.1V
5	0V(3.0V)	54	2.3V
6	0V(2.9V)	55,56	0V
7	0V(5.0V)	57	5.0V
8	2.4V	58,59	0V
9	3.3V	65,66	1.9V(0V)
10	0V	67	5.0V(0V)
11	2.5V	68	1.0V(2.5V)
12	0V	69	2.5V
13~16	5.0V	70	3.3V
17	0V	71	5.0V
18,19	0V(0.5V)	72	5.0V(0V)
20~24	0V	73	5.0V
25	2.5V	74	5.0V(0V)
26	0V	75	2.6V
27	3.1V	76,77	3.2V
28~32	0V	78	0V
33	5.0V	79,80	2.5V

IC12

1	-5.6V
2,3	0V
4	-10.5V
5,6	5.0V
7	5.7V
8	9.0V

IC13

1	5.0V
2	2.8V
3	3.1
4	4.0V
5~8	0V
9	5.0V
10,11	0V
12	5.0V
13	3.8V
14	5.0V(3.8V)
15	3.8V
16	5.0V(3.8V)
17	0V
18	5.0V
19	4.0V
20	3.3V
21	3.2V

IC14

1	0V
2,3	2.5V
4	-5.0V
5,6	0V(2.6V)
7	0V

IC15

1,2	5.0V
3	0V
4	5.0V
5	5.0V(2.8V)
6	0V(2.8V)
7	0V
8	5.0V(2.8V)
9	0V(2.8V)
10	5.0V(0V)
11	5.0V
12,13	0V
14	5.0V

IC101

1	-4.4V
2,3	0V
4	-9.0V
5,6	4.5V
7	4.7V
8	9.0V

IC102

1,2	0V
3,4	5.0V
5	5.0V(0V)
6,8	0V
7	-0.5V

IC103

1~4	0V
5	5.0V(0V)
6	0V
7	4.9V
8~10	5.0V
11~13	0V
14	-4.0V
15	5.0V
16	0V
17	-5.0V
18	2.7V(0V)
19~25	0V
26	5.0V
27~30	0V

IC104

1~3	0V
4	4.6V
5	4.5V(3.6V)
6	-5.0V
7~14	0V
15	-1.0V(-1.7V)
16	-1.2V
17	-5.0V
18~20	0V
21	-4.9V
22	0V
23	-3.5V(-1.8V)
24,25	0V
26	0V
27	4.1V(2.5V)
28	0V(4.8V)
29	4.9V(0V)
30	5.0V

IC105

1~3	0V
4	-0.9
5~7	0V
8	0.9V

IC106

8	0V
9~11	5.0V(2.7V)
12	0V(4.4V)
13	4.1V(2.5V)

IC108

1~3	0V(0.8V)
4	-0.5V
5~7	0V
8	5.0V

IC110

1~3	0V
4	-9.0V
5~7	0V
8	9.0V

IC201

1~3	0V
4	-10.8V
5~7	0V
8	10.1V

	B	C	E
Q1	15.0V	10.7V	15.6V
Q2	-16.1V	-10.8V	-15.5V
Q3(ON)	-10.5V	6.3V	-10.5V
Q3(OFF)	-5.5V	-10.7V	—
Q4	-10.6V (-10.1V)	0V (-10.7V)	-10.8V (-10.8V)
Q5(ON)	0.7V	0V	0V
Q5(OFF)	-10.7V	—	—
Q6	—	0V	—
Q7	0.7V	-3.0V	0V
Q8	—	—	0V
Q13	5.5V	10.5V	4.8V
Q14	3.3V	10.5V	5.0V
Q16,15	5.6V	9.0V	5.0V
Q17	-5.6V	-10.5V	-5.0
Q18	5.7V	9.0V	5.0V
Q20	4.7V	0V	2.3V
Q21	3.1V	0V	2.3V
Q22	0.5V (0V)	0.5V (0V)	5.0V —
Q101	8.5V	5.0V	9.1V
Q102	-8.3V	-5.0V	-9.0V
Q103	5.6V	-14.2V	5.0V
Q104	-30.6V	-39.5V	-30V
Q105	0V	-9.0V	0V
Q106,114	0V	9.0V	0V
Q111	0V	-9.0V	—
Q112	0V	9.0V	—
Q113,115	0V	-9.0V	0V
Q116	0V	9.0V	0V
Q117	0V	5.0V	0V
Q118	4.5V (3.6V)	1.3V (2.1V)	5.0V (4.3V)

(X25-3810-00)

IC1

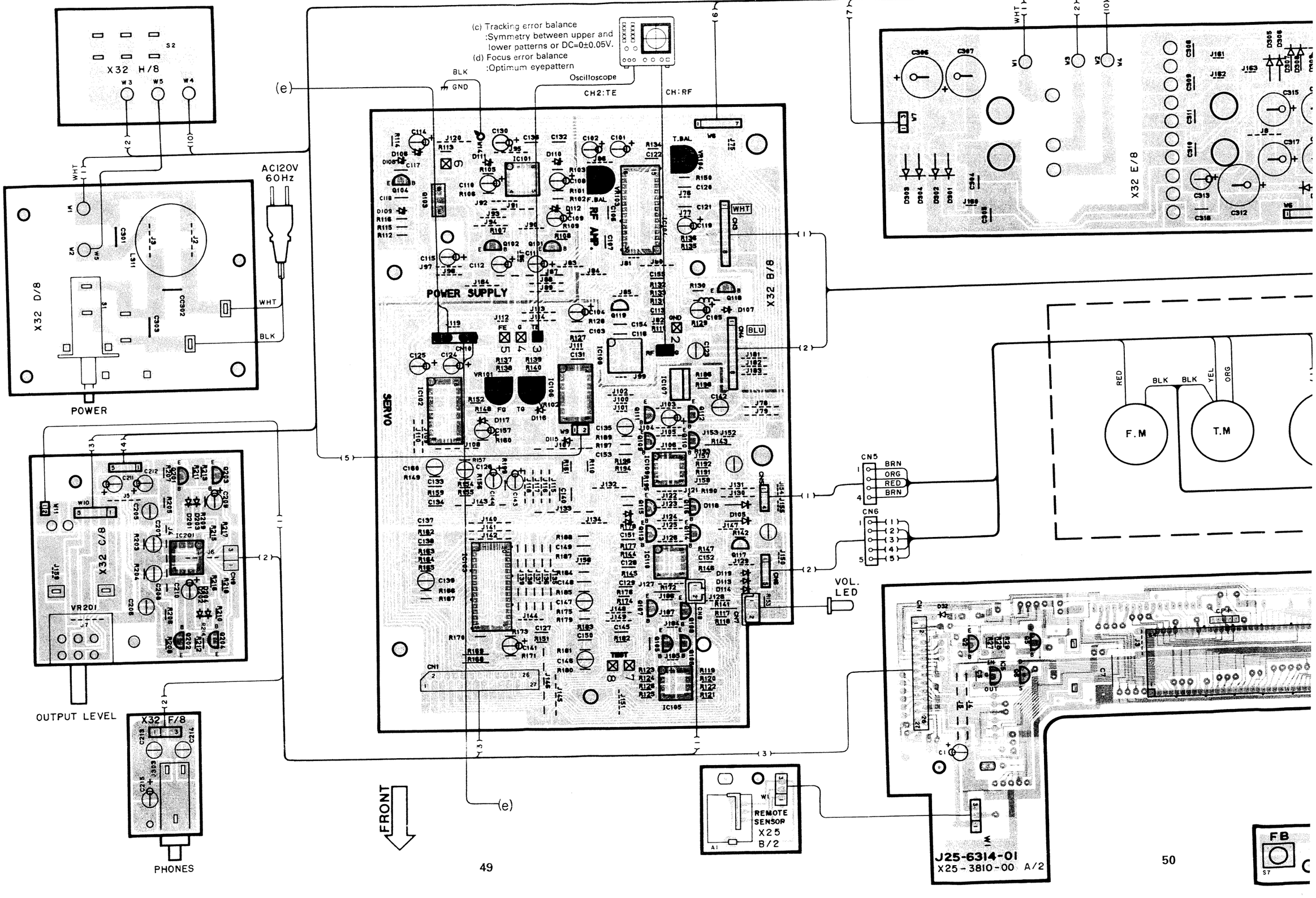
5	5.0V(0V)	25~27	5.0V
6	2.5V	28,32	0V
7,10	0V	36	5.0V(0V)
8,9	5.0V	37,39	5.0V
11~13	0V(5.0V)	38	0V
14	5.0(ON) 0V(OFF)	50,51 52,53	4.9V(0V) 0V
15,19	5.0V	56	-30V
16~18	0V	57	-5.0V
20~24	0V	64	5.0V

IC2

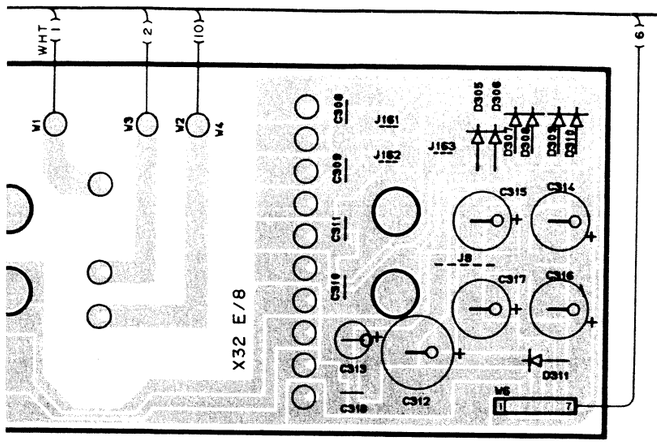
1,3	5.0V
2	0V

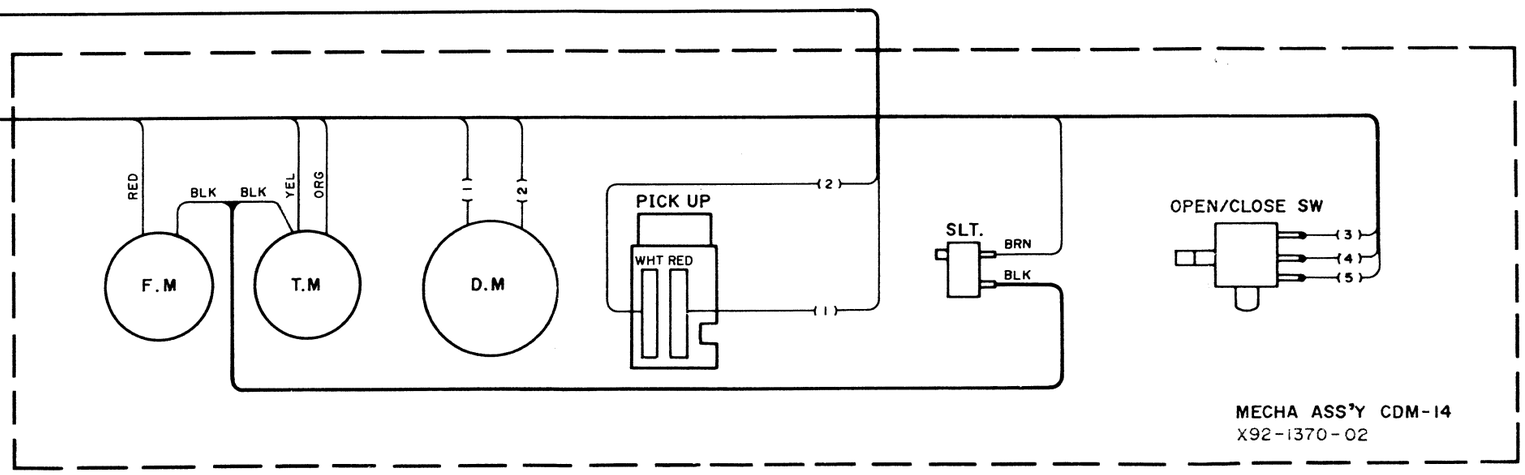
	B	C	E
Q1,2	-26.6V	5.0V	-26.6V
Q3	5.0V(0V)	0V(5.0V)	5.0V
Q4	5.0V	-9.0V(0V)	5.0V

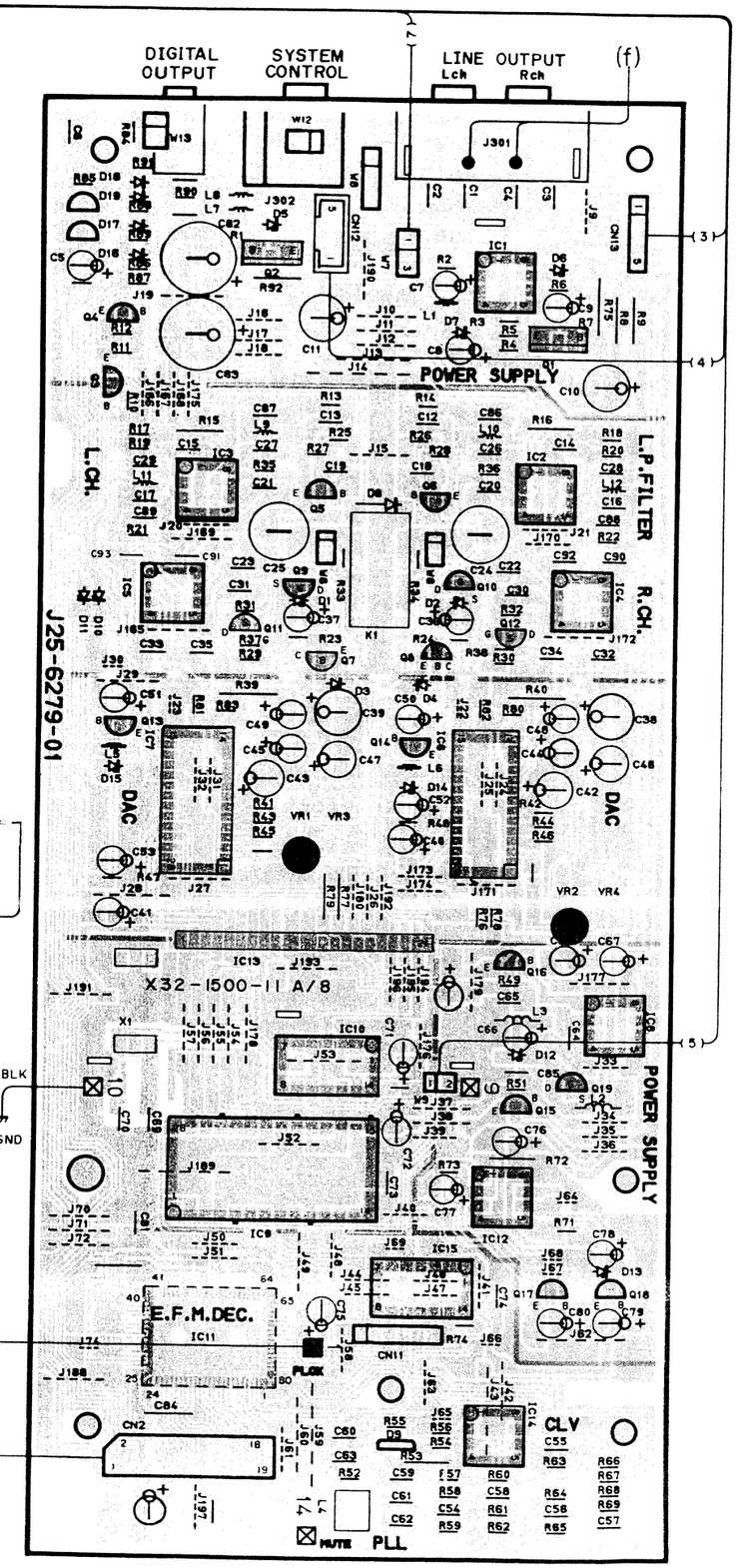
PC BOARD (COMPONENT SIDE VIEW)

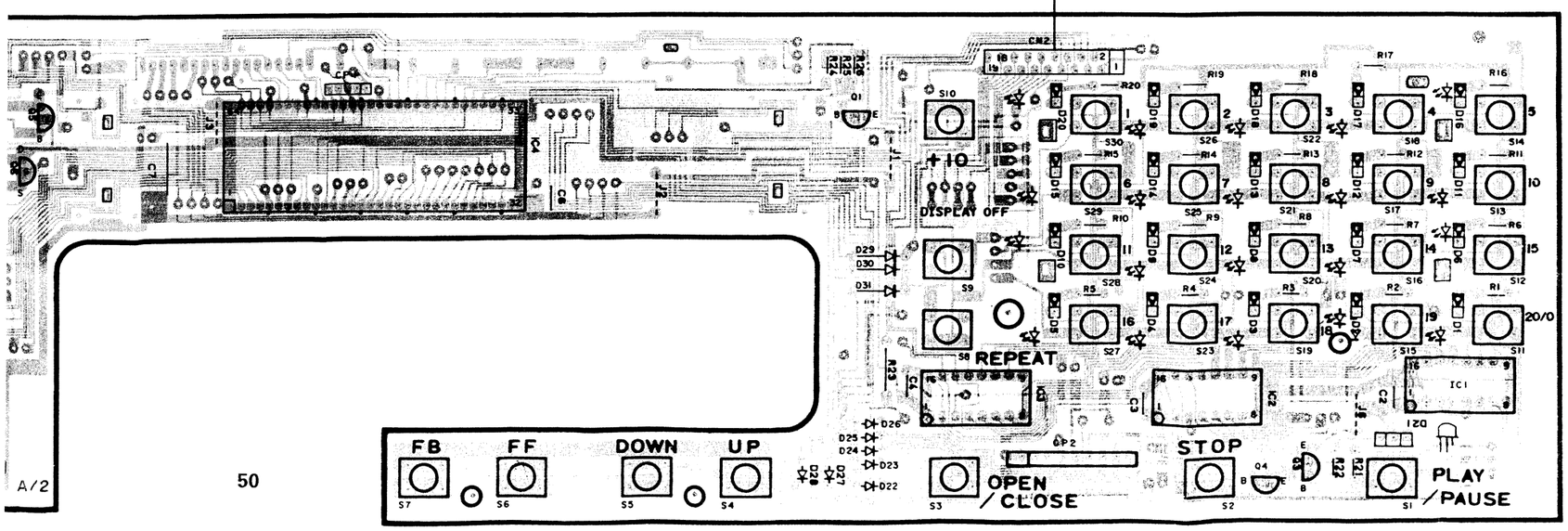


Refer to the schematic diagram for the values of resistors and capacitors.

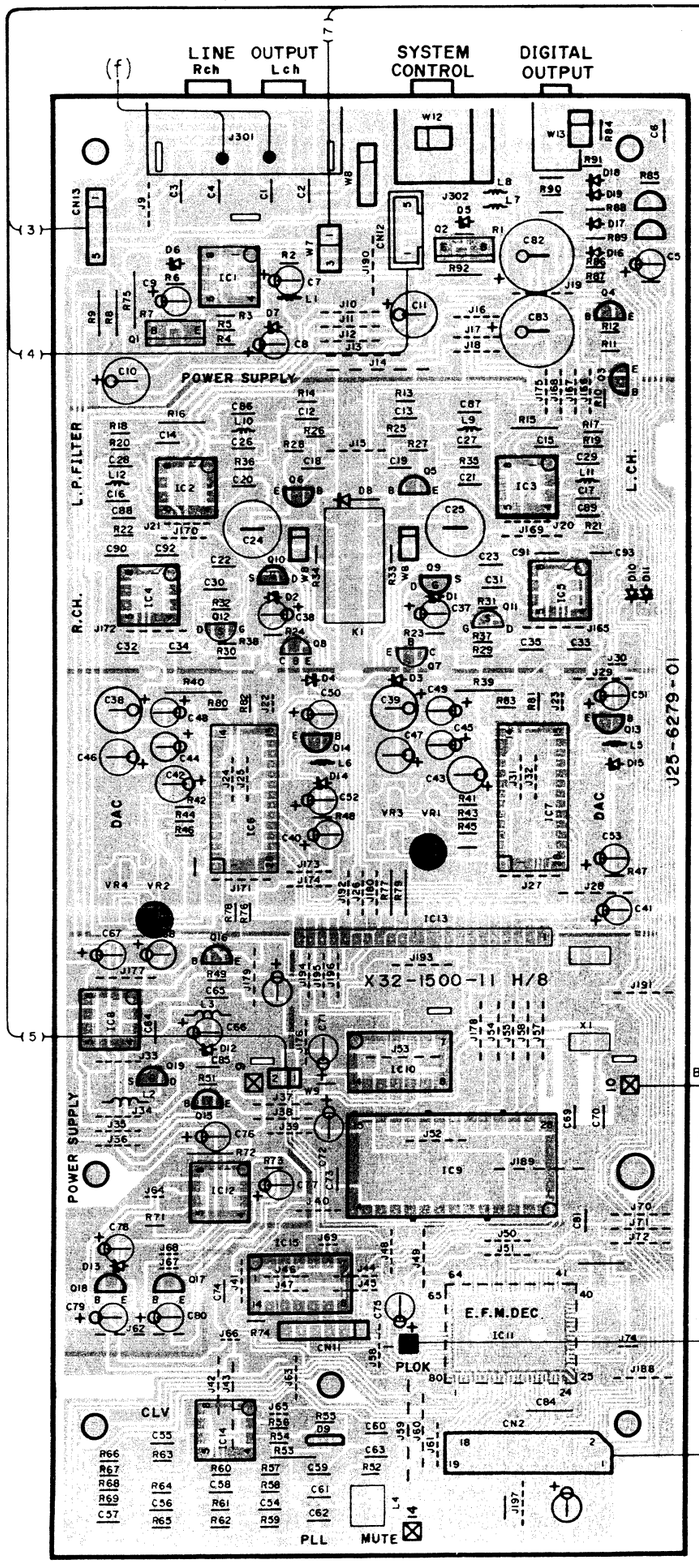


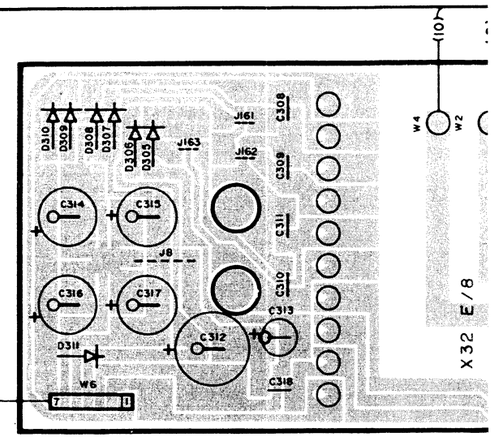


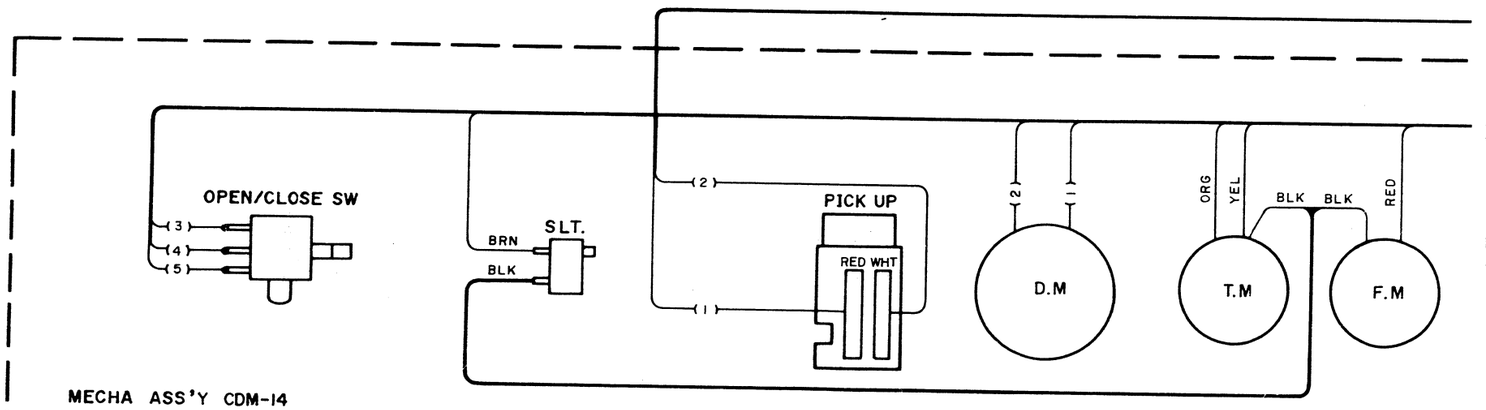




C BOARD (FOIL SIDE VIEW)





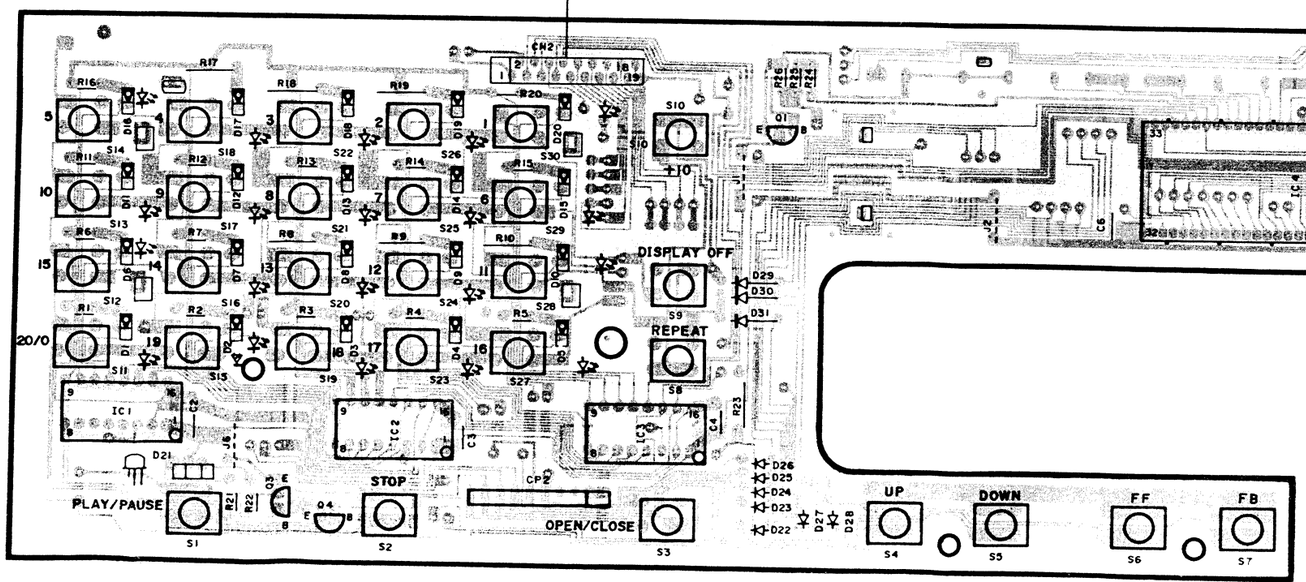


Frequency counter

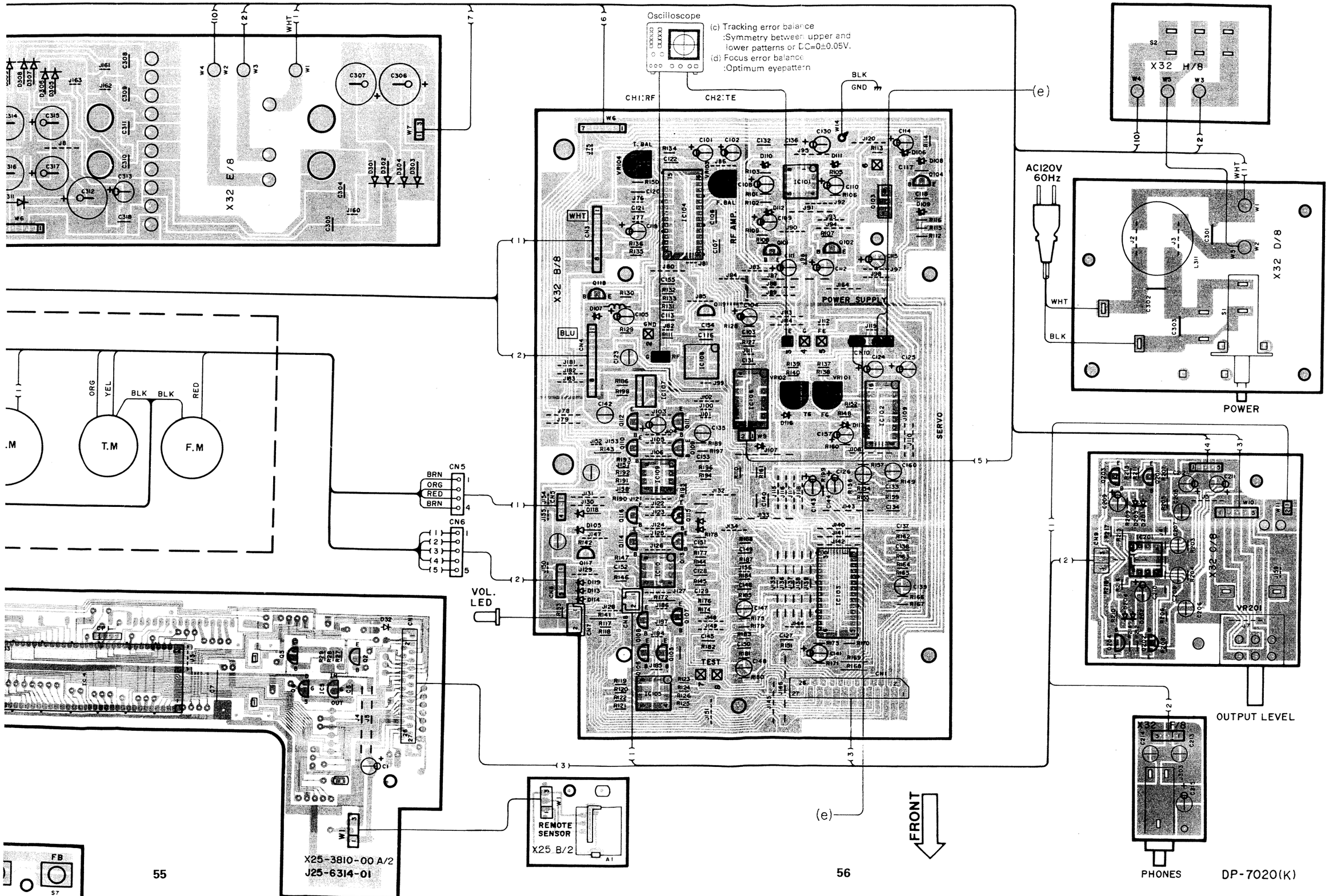
(b)VCO : 4.30MHz

BLK

GND



Refer to the schematic diagram for the values of resistors and capacitors.



X32-1510-11	(K,P)
0-21	(U,M,UE)
2-71	(X)

(X32-1500-11)(A/8)

CN2 (Vss, MUTE, EMPH, SDATA, BUSY, XI, GFS, WFCK, SCOR, SUBQ, MUTG, SENS, C IN, XRST, DATA, XLT, CLK, CLV, MON)

WQ (GND, EFM)

PLCK

PLL

IC14 (1/2)

IC14 (2/2) CLV

Q22

IC11 DIGITAL SIGNAL PROCESSOR / RAM

MASTER CLOCK 16.9344 MHz

IC10

19SB, 20SB DETECTOR

IC13

IC9

DIGITAL FILTER

IC12 (1/2) +5V AVR

IC12 (2/2) -5V AVR

IC15 DATA SELECTOR

CN11 (GND, BCK, D OUT, LRCK, DIN, SEL)

IC8 (1/2) +5V BUFFER

IC8 (2/2) +5V AVR

Q19 Q16 Q15

D9 D12 D15

IC7 D/A CONVERTER

IC6 -9.5V +5V BUFFER

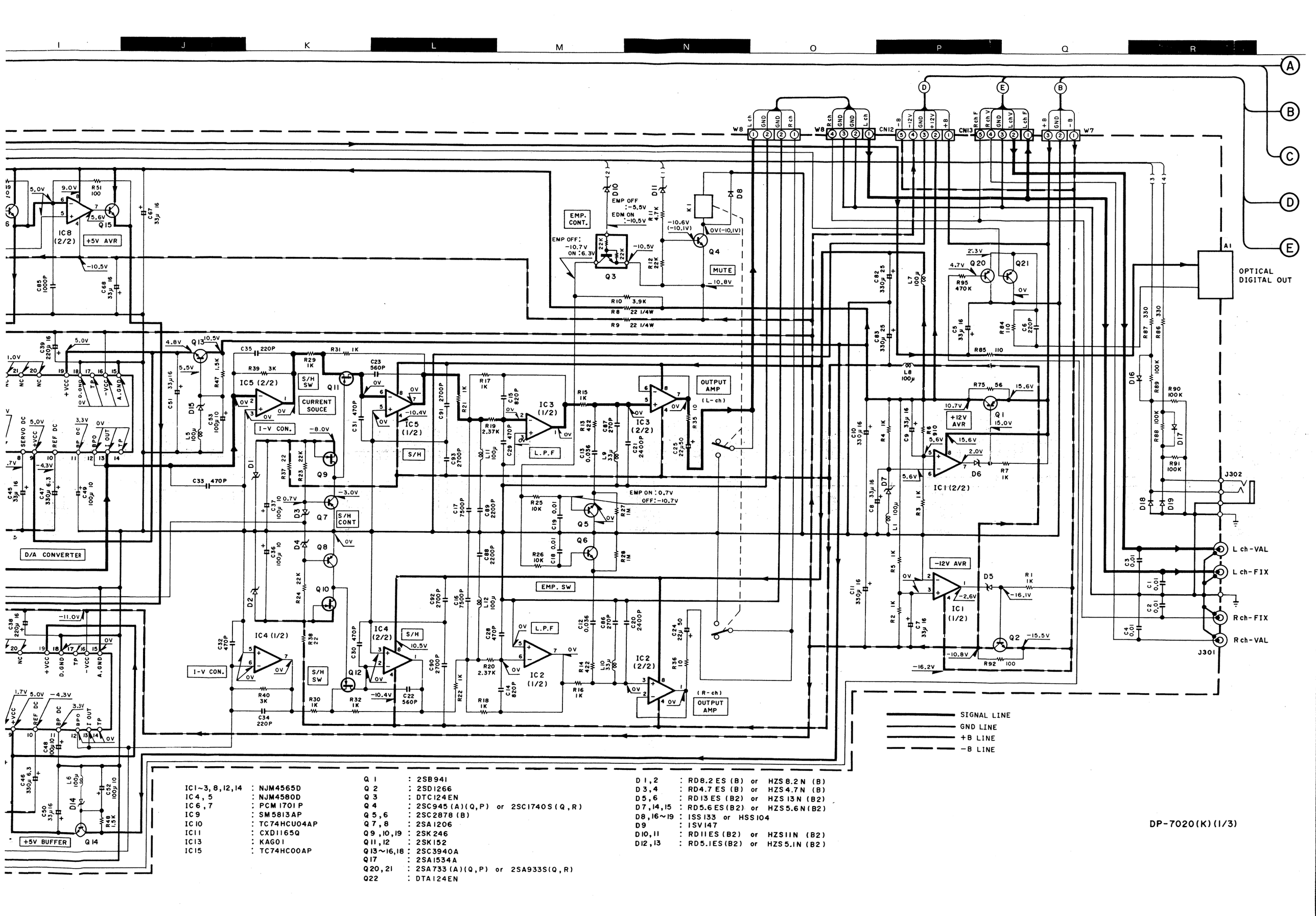
Q13 Q14 Q18 Q17

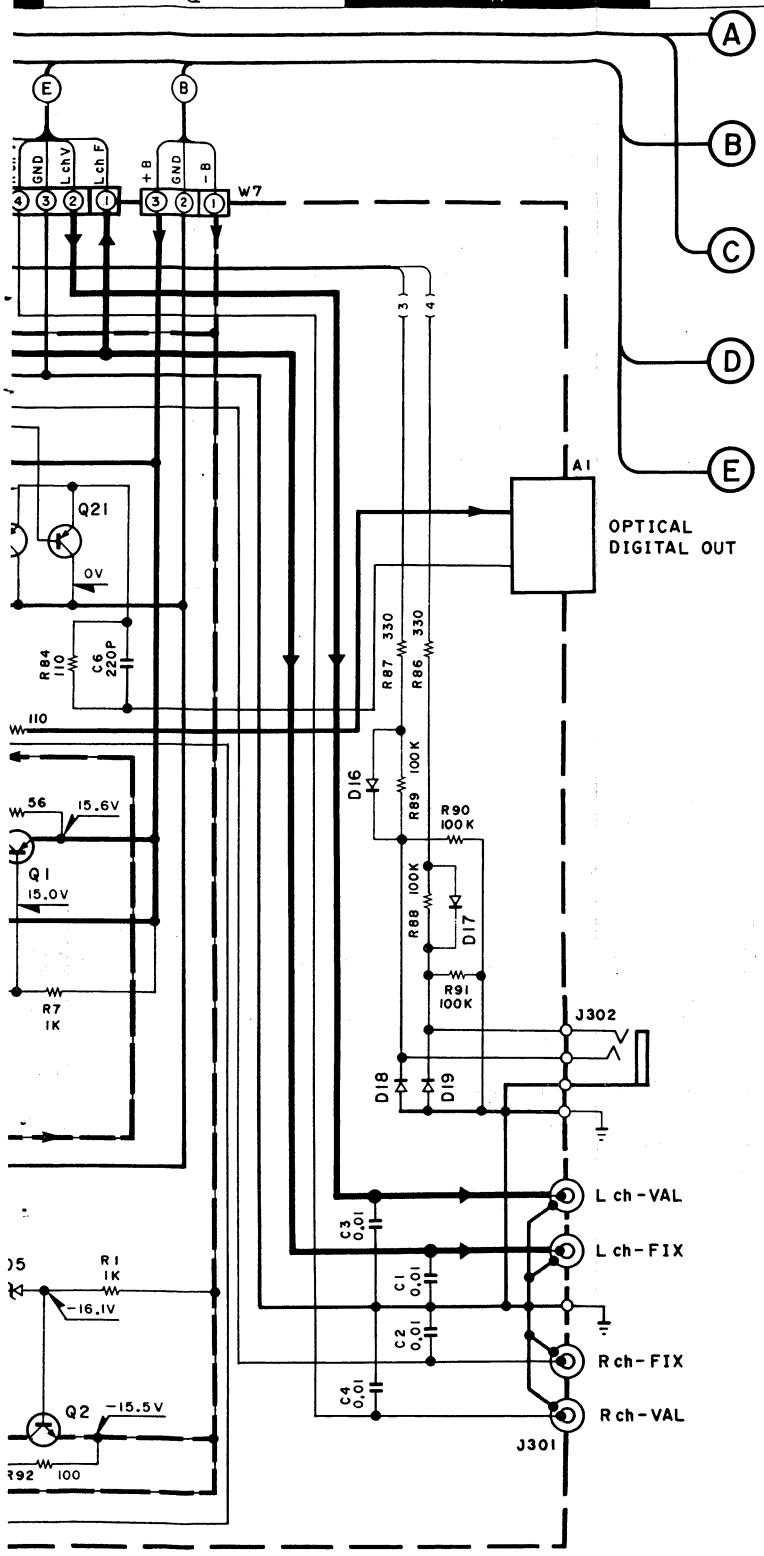
D13 D14

I-V CON.

D1 D2

IC 1~3, 8, 12, 14
IC 4, 5
IC 6, 7
IC 9
IC 10
IC 11
IC 13
IC 15

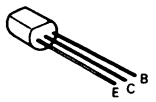

W8
W8
CN12
CN13
W7
L ch
GND
R ch
-8
-12V
+12V
+B
R ch F
R ch V
L ch V
L ch F
EMP. CONT.
EMP OFF :-5.5V
EDM ON :-10.5V
EMP OFF: -10.7V ON :6.3V
-10.5V
-10.6V (-10.1V)
0V(-10.1V)
MUTE
-10.8V
Q3
Q4
K1
D8
D10
D11
R10 3.9K
R8 22 1/4W
R9 22 1/4W
OPTICAL DIGITAL OUT
A1
IC8 (2/2)
+5V AVR
Q15
5.0V
9.0V
5.6V
R51 100
C67 33μ 16
C85 1000P
C68 33μ 16
Q20
Q21
2.3V
4.7V
R95 470K
0V
C5 33μ 16
R64 110
C6 220P
R85 110
C82 330μ 25
C83 330μ 25
L7 100μ
L8 100μ
R87 330
R86 330
D16
R89 100K
R90 100K
R88 100K
D17
R91 100K
J302
D18
D19
L ch-VAL
L ch-FIX
R ch-FIX
R ch-VAL
J301
C3 0.01
C1 0.01
C2 0.01
C4 0.01
R75 56
15.6V
Q1
15.0V
10.7V
+12V AVR
R6 910
15.6V
2.0V
D6
R7 1K
IC1(2/2)
C9 33μ 16
C10 330μ 16
R4 1K
5.6V
D7
C8 33μ 16
L1 100μ
R3 1K
R5 1K
-12V AVR
D5
R1 1K
-16.1V
IC1 (1/2)
-2.6V
R2 1K
C7 33μ 16
C11 330μ 16
Q2
-15.5V
-10.8V
R92 100
-16.2V
IC1~3,8,12,14 : NJM4565D
IC4,5 : NJM4580D
IC6,7 : PCM1701P
IC9 : SM5813AP
IC10 : TC74HCU04AP
IC11 : CXD1165Q
IC13 : KAG01
IC15 : TC74HC00AP
Q1 : 2SB941
Q2 : 2SD1266
Q3 : DTC124EN
Q4 : 2SC945(A)(Q,P) or 2SC1740S(Q,R)
Q5,6 : 2SC2878(B)
Q7,8 : 2SA1206
Q9,10,19 : 2SK246
Q11,12 : 2SK152
Q13~16,18 : 2SC3940A
Q17 : 2SA1534A
Q20,21 : 2SA733(A)(Q,P) or 2SA933S(Q,R)
Q22 : DTA124EN
D1,2 : RD8.2ES(B) or HZS8.2N(B)
D3,4 : RD4.7ES(B) or HZS4.7N(B)
D5,6 : RD13ES(B2) or HZS13N(B2)
D7,14,15 : RD5.6ES(B2) or HZS5.6N(B2)
D8,16~19 : 1SS133 or HSS104
D9 : 1SV147
D10,11 : RD11ES(B2) or HZS11N(B2)
D12,13 : RD5.1ES(B2) or HZS5.1N(B2)
SIGNAL LINE
GND LINE
+B LINE
-B LINE
DP-7020(K)(1/3)



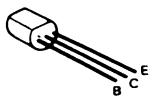
L LINE
INE
NE
NE

DP-7020(K)(1/3)

2SC2878 DTC124EN
2SC3940A 2SA1534A
2SC945(A) 2SA733(A)

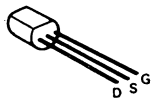


DTA124EN

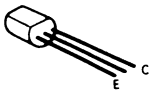


2SB941

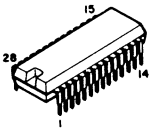
2SK152



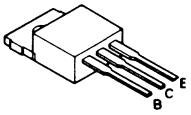
2SA1206



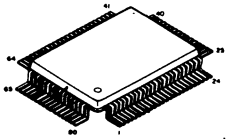
SM5813AP



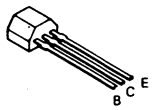
2SD1266



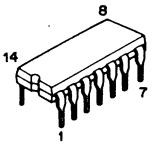
CXD1165Q



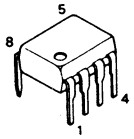
2SA933S
2SC1740S



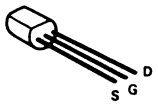
TC74HCU04AP
TC74HC00AP



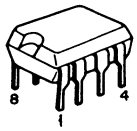
NJM4558D



2SK246



NJM4565D



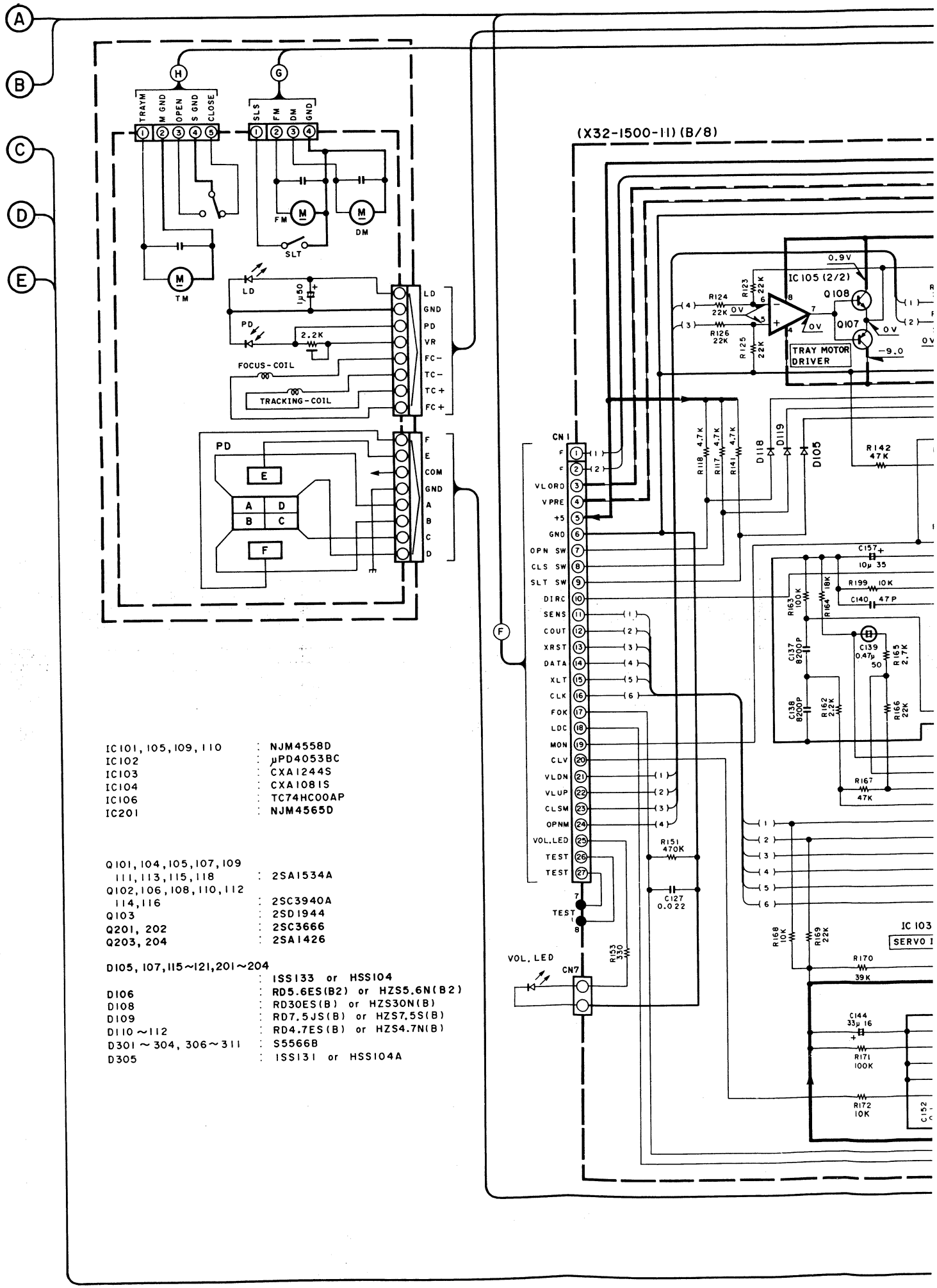
- Voltage : (PLAY) STOP when power ON.
- DC voltages are as measured with a high impedance voltmeter. Values may vary slightly due to variations between individual instruments or/and units.

CAUTION : For continued safety, replace safety critical components only with manufacturer's recommended parts (refer to parts list). ⚠ Indicates safety critical components. To reduce the risk of electric shock, leakage-current or resistance measurements shall be carried out (exposed parts are acceptably insulated from the supply circuit) before the appliance is returned to the customer.

Y22-1890-11

DP-7020

KENWOOD



IC101, 105, 109, 110	:	NJM4558D
IC102	:	μPD4053BC
IC103	:	CXA1244S
IC104	:	CXA1081S
IC106	:	TC74HC00AP
IC201	:	NJM4565D

Q101, 104, 105, 107, 109 111, 113, 115, 118	:	2SA1534A
Q102, 106, 108, 110, 112 114, 116	:	2SC3940A
Q103	:	2SD1944
Q201, 202	:	2SC3666
Q203, 204	:	2SA1426

D105, 107, 115~121, 201~204	:	1SS133 or HSS104
D106	:	RD5.6ES(B2) or HZS5.6N(B2)
D108	:	RD30ES(B) or HZS30N(B)
D109	:	RD7.5JS(B) or HZS7.5S(B)
D110~112	:	RD4.7ES(B) or HZS4.7N(B)
D301~304, 306~311	:	S5566B
D305	:	1SS131 or HSS104A

AQ AR AS AT AU AV AW AX AY AZ

(X25-3810-00)(A/2)

IC1 ~ 3 : TD62801P
IC4 : μPD75216ACW-29
IC5 : M51951ASL

Q1,5 : 2SC945(A)(Q,P)
Q2~4 : DTA124EN
Q6 : 2SK105(F,H)

D1~20 : B30-1012-05
D21 : B30-1263-05
D22~32 : HSS104A or 1SS133
D33 : DAP803

FL1

DISC OUT A B REPEAT CCRS
TRACK PROGRAM TIME
TRACK NO. INDEX PNO. P.C. SINGLE TOTAL TIME TIME
EMPHASIS RANDOM SPACE EDIT

9G 8G 7G 6G 5G 4G 3G 2G 1G

CN1: TEST TEST VLLED OPNM CLSM VLUP VLDN CLV MON LD ON FOK CLK XLT DATA XRST COUT SENS DIRC SLTSW CLSSW OPNSW GND +5V VPRE VLORD F F

CN2: GND MUTE EMPH SDATA BUSY XI GFS WFCK SCOR SUBQ MUTG SENS CIN XRST DATA XLT CLK CLV MON

D32 Q5 BUFFER R29 100K R28 100K R27 1K -26.6V 5.0V
Q1 BUFFER R26 100K R25 100K R24 1K
VOL. LED BUFFER Q2 22K 22K
R50 2.2K x4
C5 0.01 RESET IC5 GND OUT IN
CURRENT SOURCE RESET Q6
C1 33μ16
-5.0V -30V 0V 4.9V(0V) 5.0V(0V)
EMP ON : 5.0V
EMPH OFF : 0V

IC4 μ-COM
SENSE WFCK SUBQ SLTSW SCI SCOR FOK GFS RMUTE EMPH DIRC VLDWN BUSY SDATA OPNSW CLSSW VDD XDI XD2 XD3 DATAI XLT CLK VLUP XI VSS
VDD Se Sf Sg Sh Si Sj VPRE VLORD Sk Sl CLSM OPNM MUTE LDC G9 G8 G7 G6 G5 G4 G3 G2 G1 RST FL & LATCH LDATA LCK VLLED

W1 A1 REMOCON RECEIVER
(X25-3810-00)(B/2)

IC3 IC2 IC1 S/P CONVERTOR
2.2K 0.01 C2 C3 C4

D26 D20 D15 S30 S20 S28
D25 D19 D14 S26 S25 S24
D24 D18 D13 S22 S21 S20
D23 D17 D12 S18 S17 S16
D22 D16 D11 S14 S13 S12
D29 S3 S2 OPEN/CLOSE STOP +10
D28 S7 S6 FB FF DOW
D30 S9 DISPLAY OFF REP

PLAY LED BUFFER Q4 PAUSE LED BUFFER Q3 -9.0V (0V) 0V (5.0V) 5.0V(0V)
D21 R21 300 R22 150 PLAY PAUSE

(X32-1500-11) (E/8)

(X32-1500-11) (D/8)

(X32-1500-11) (H/8)

(X32-1500-11) (C/8)

(X32-1500-11) (F/8)

(K,P) TYPE
AC120V 60Hz
(U) TYPE
AC110-120V 50/60Hz
(M,UE) TYPE
AC220-240V 50/60Hz
(X) TYPE
AC240V 50Hz

AC220-240V ⟷ AC110-120V

DISPLAY −30V

DISPLAY +5V

+5V AVR (SERVO)

−5V AVR (SERVO)

FE. BIAS

IC 104 RF AMP

EFM BUFFER (FOK)

RF BUFFER

TE. BAL

ALPC

HEADPHONE AMP

PHONES

J303

SIGNAL LINE
GND LINE
+B LINE
−B LINE

2SA1534A

2SC3666
2SA1426

2SD1944

NJM4558D

NJM4565D

TC74HC00AP

µPD4053BC

CXA1244S
CXA1081S

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- Voltage : (PLAY) STOP when power ON.

DP-7020(K)(2/3)

DP-7020
KENWOOD

(X32-1500-11) (B/8)

CN8 GND SP SLD LIMT
CN5
CN6 CLOSE COM OPEN TRAY+ TRAY-
CN10 FE GND TE FE2 FE1 GND TE1 TE2
CN4 LD GND PD LR F- T+ T- F+

TRAY MOTOR DRIVER
IC 105 (2/2)
IC 105 (1/2)
MOTOR VOL. CONT.

IC102 DEFECT SW

DISPLAY -30V
DISPLAY +5V

LINEAR MOTOR AMP
IC 109 (2/2)

F.GAIN
T.GAIN

TRACKING ACT. DRIVE
FOCUS ACT. DRIVE

IC 103 SERVO IC

DISC MOTOR DRIVE
IC110 (2/2)

IC110 (1/2)

EFM BUFFER (FOK)
IC 106

RF BUFFER
IC108

CN1 CN7 TEST

W9 EFM GND RF GND

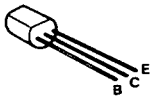
: TD62801P
: μPD75216ACW-295
: M51951ASL

: 2SC945(A)(Q,P) or 2SC1740S(Q,R)
: DTA124EN
: 2SK105(F,H)

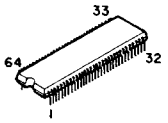
: B30-1012-05
: B30-1263-05
: HSS104A or ISS131
: DAP803

GND LINE
+B LINE
−B LINE

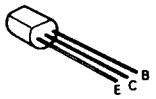
DTA124EN



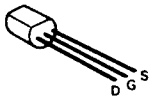
μPD75216ACW-295



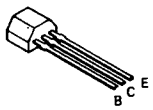
2SC945



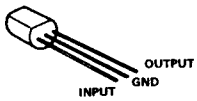
2SK105

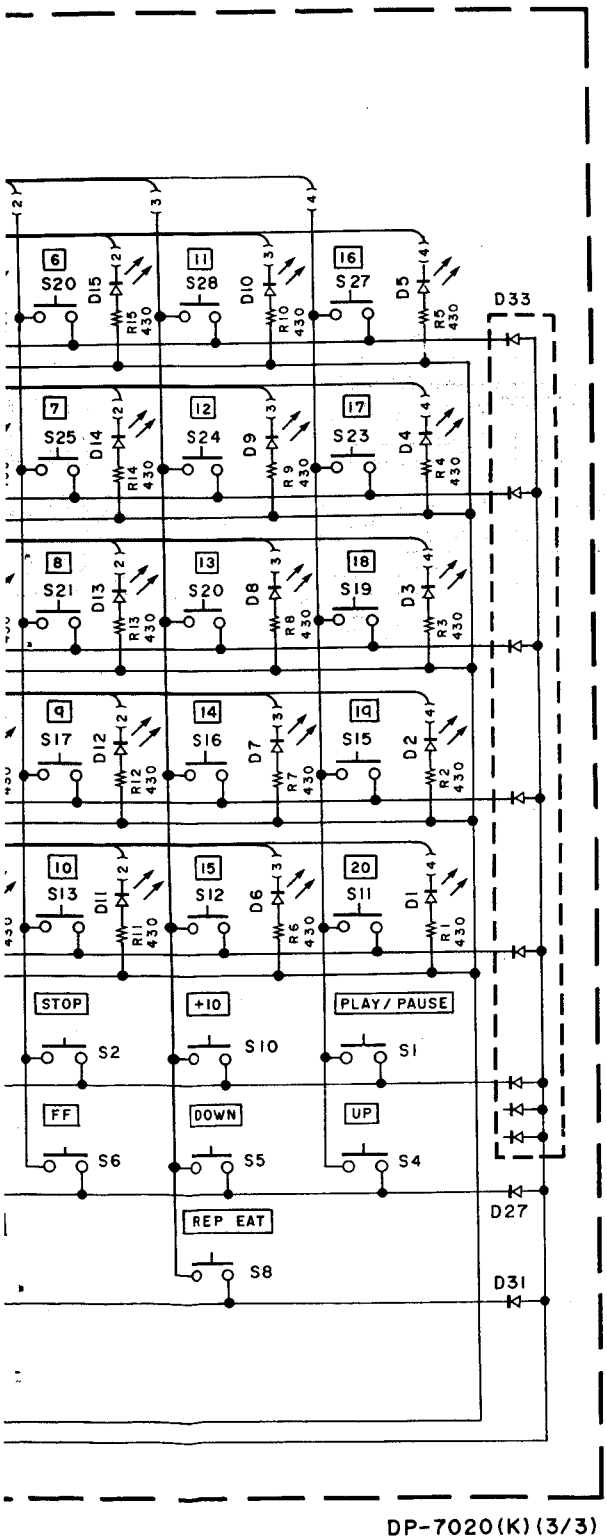


2SC1740S



M51951ASL





DP-7020(K)(3/3)

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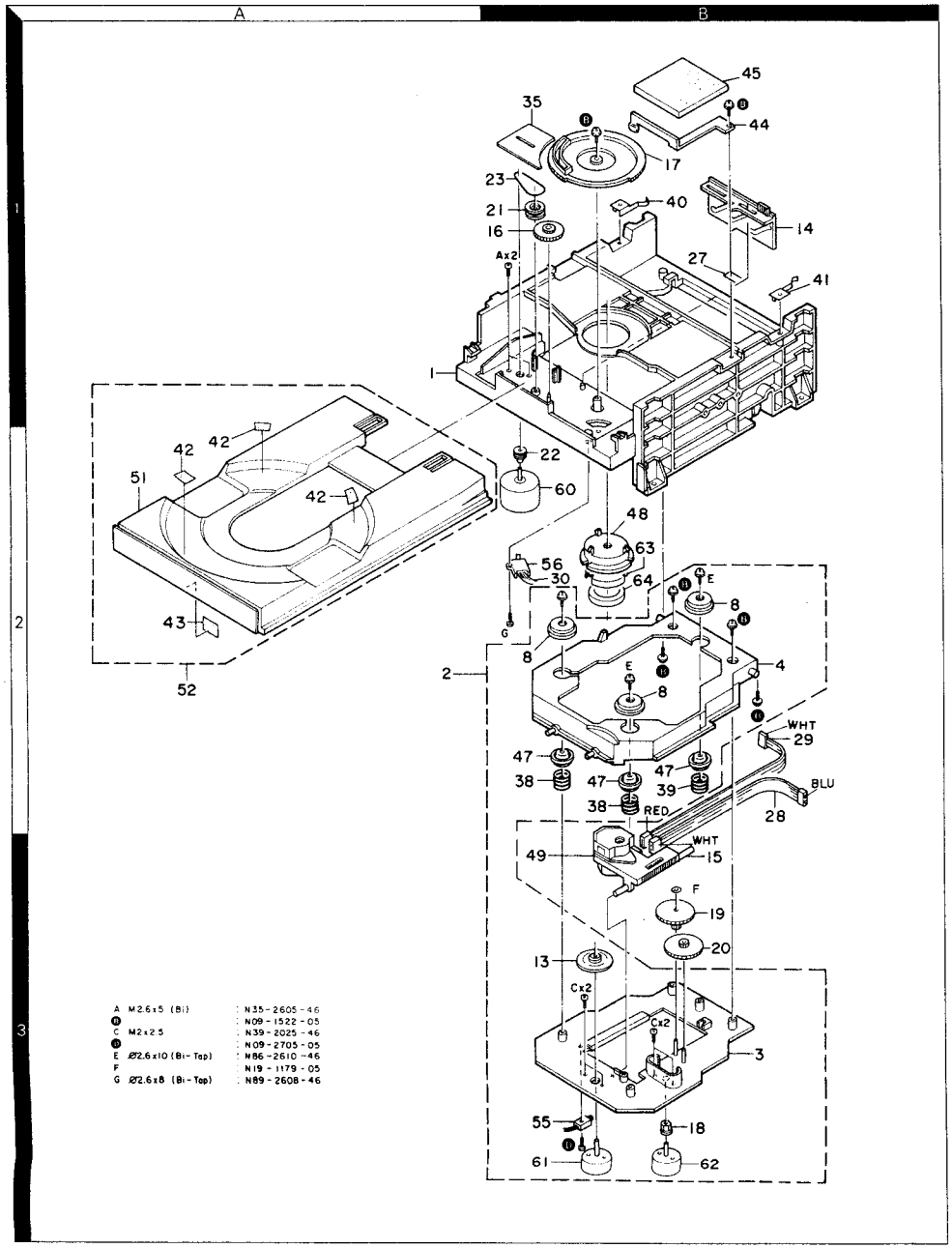
- Voltage : (PLAY) STOP when power ON.

Y22-1890-11

DP-7020
KENWOOD

EXPLODED VIEW (MECHANISM) : JAPAN MADE

JAPAN MADE

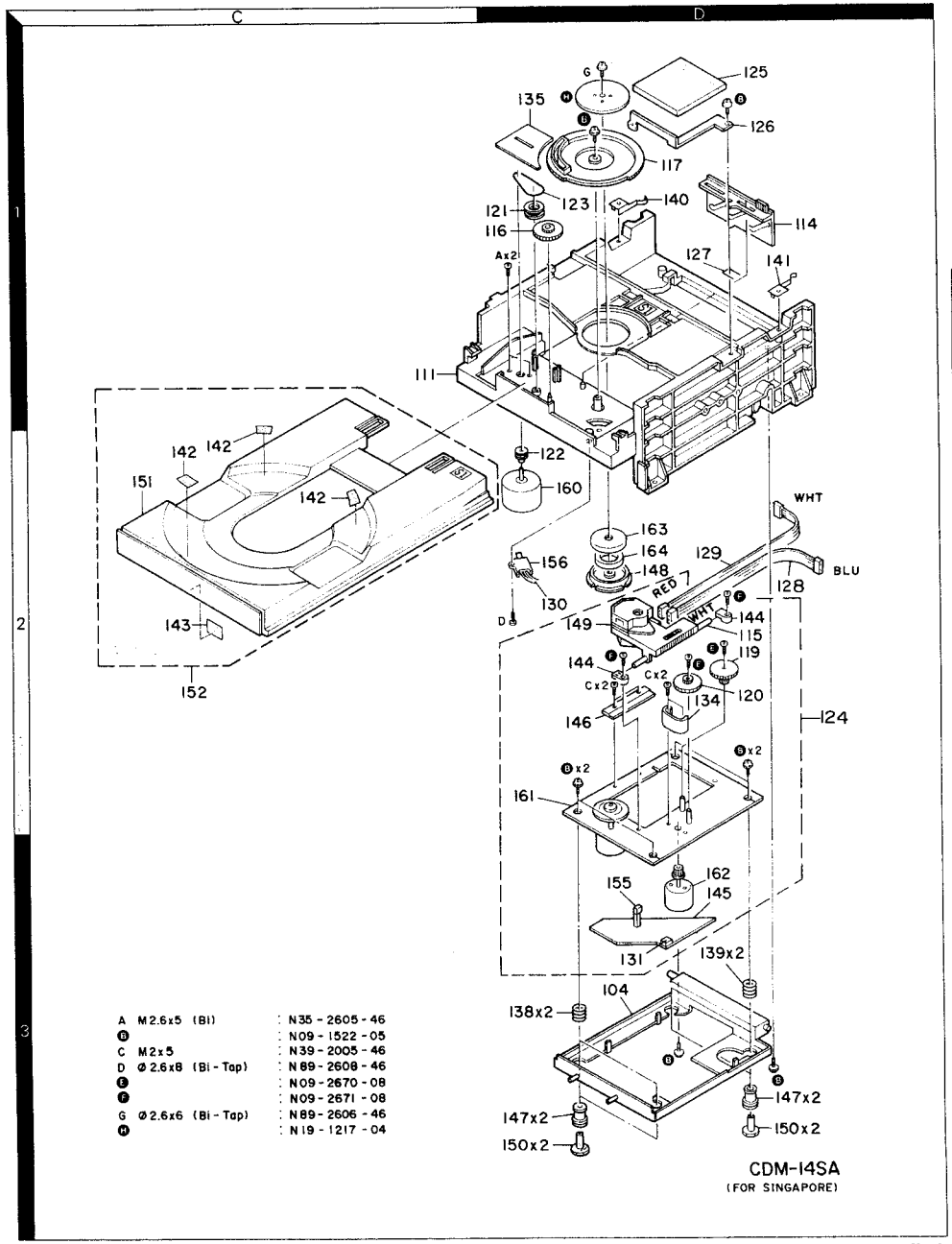


A	M2.6x5 (BI)	: N35 - 2605 - 46
B		: N09 - 1522 - 05
C	M2x2.5	: N39 - 2025 - 46
D		: N09 - 2705 - 05
E	Ø2.6x10 (Bi-Tap)	: N86 - 2610 - 46
F		: N19 - 1179 - 05
G	Ø2.6x8 (Bi-Tap)	: N89 - 2608 - 46

Parts with the exploded numbers larger than 700 are not supplied.

EXPLODED VIEW (MECHANISM) : SINGAPORE MADE

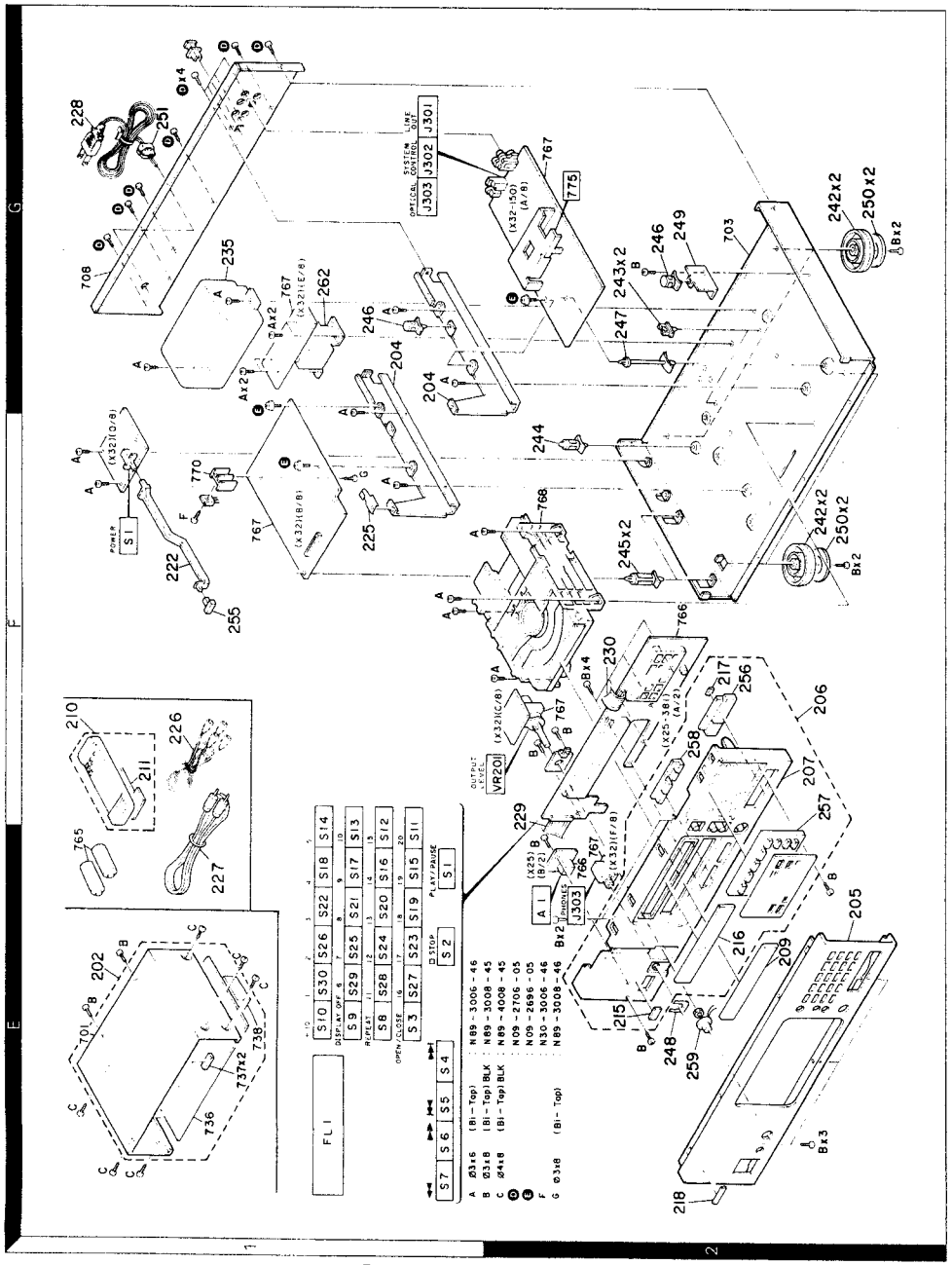
SINGAPORE MADE



A	M2.6x5 (BI)	: N35 - 2605 - 46
B		: N09 - 1522 - 05
C	M2x5	: N39 - 2005 - 46
D	Ø2.6x8 (Bi-Tap)	: N89 - 2608 - 46
E		: N09 - 2670 - 08
F		: N09 - 2671 - 08
G	Ø2.6x6 (Bi-Tap)	: N89 - 2606 - 46
H		: N19 - 1217 - 04

Parts with the exploded numbers larger than 700 are not supplied.

EXPLODED VIEW (UNIT)



Parts with the exploded numbers larger than 700 are not supplied.

PARTS LIST

JAPAN MADE

* New Parts
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Ref. No. 参照番号	Address 位置	New Parts 新	Parts No. 部品番号	Description 部品名／規格	Destination 仕向	Remarks 備考
			DP-7020 / JAPAN			
202	1E	*	A01-1804-12	METALLIC CABINET ASSY		
204	1G	*	A13-1222-03	FRAME		
205	2E	*	A20-5899-02	PANEL		
206	2F	*	A22-1130-12	SUB PANEL ASSY		
207	2F	*	A22-1131-01	SUB PANEL		
209	2E	*	A29-0153-03	PANEL(TRAY)		
210	1F		A70-0308-05	REMOCON ASSY(RC-P8020)		
211	1F		A09-0078-08	BATTERY COVER		
215	2E		B10-1047-04	FRONT GLASS(REMOCON)		
216	2E	*	B10-1048-03	FRONT GLASS(DISPLAY)		
217	2E		B12-0066-04	INDICATOR		
218	2E		B43-0287-04	KENWOOD BADGE		
-			B46-0092-03	WARRANTY CARD	K	
-			B46-0094-03	WARRANTY CARD	UUE	
-			B46-0095-03	WARRANTY CARD	UUE	
-			B46-0096-13	WARRANTY CARD	X	
-			B46-0121-03	WARRANTY CARD	P	
-		*	B50-9861-00	INSTRUCTION MANUAL(ENGLISH)		
-		*	B50-9862-00	INSTRUCTION MANUAL(FRENCH)	PM	
-		*	B50-9863-00	INSTRUCTION MANUAL(SPANISH)	M	
-			B58-0223-04	CAUTION CARD (PRE-SET 120V)	U	
-			B58-0513-04	CAUTION CARD (PRESET220-240)	UE	
222	1F		D21-1540-03	EXTENSION SHAFT		
226	1E		E30-0505-05	AUDIO CORD		
⚠ 227	1F		E30-0977-05	CORD WITH PLUG		
⚠ 228	1G		E30-0459-05	AC POWER CORD	M	
⚠ 228	1G		E30-0780-05	AC POWER CORD	KP	
⚠ 228	1G		E30-0812-05	AC POWER CORD	UUE	
⚠ 228	1G		E30-1341-05	AC POWER CORD	X	
229	2F		E31-4289-05	WIRING HARNESS		
230	2F		E31-4790-05	WIRING HARNESS		
235	1G		F11-0440-03	SHIELDING CASE		
-		*	H01-8634-04	ITEM CARTON CASE		
-		*	H10-3894-02	POLYSTYRENE FOAMED FIXTURE(L)		
-		*	H10-3895-02	POLYSTYRENE FOAMED FIXTURE(R)		
-		*	H21-0273-04	PROTECTION SHEET	KPUUEX	
-			H25-0232-04	PROTECTION BAG (235X350X0.03)		
-			H25-0361-04	PROTECTION BAG	KPUUEX	
242	2F,2G	*	J02-1052-05	FOOT ASSY		
243	2G		J11-0129-05	WIRE CLAMPER		
244	2F		J19-0506-05	UNIT HOLDER		
245	2F		J19-0581-05	UNIT HOLDER		
246	1G,2G		J19-2598-05	HOLDER		
247	2G	*	J19-3208-05	UNIT HOLDER		
248	2E		J21-3326-05	JACK MOUNTING HARDWARE		
249	2G	*	J21-5560-04	MOUNTING HARDWARE		
⚠ 251	1G		J42-0083-05	POWER CORD BUSHING		
-			J61-0307-05	WIRE BAND		
255	1F		K27-2004-04	KNOB (BUTTON)(POWER)		
256	2F	*	K29-3780-04	KNOB (PLAY/PAUSE)		

E: Scandinavia & Europe K: USA P: Canada
U: PX(Far East, Hawaii) T: England M: Other Areas
UE: AAFES(Europe) X: Australia

⚠ indicates safety critical components.

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SINGAPORE MADE

Ref. No. 参照番号	Address 位置	New Parts 新	Parts No. 部品番号	Description 部品名／規格	Destination 仕向	Remarks 備考
257	2F	*	K29-3782-03	KNOB (20KEY)		
258	2F	*	K29-3783-03	KNOB (SKIP)		
259	2E		K29-3796-05	KNOB ASSY(OUTPUT LEVEL)		
⚠ 262	1G		L01-5601-05	POWER TRANSFORMER	KP	
⚠ 262	1G		L01-5602-05	POWER TRANSFORMER	X	
⚠ 262	1G		L01-5604-05	POWER TRANSFORMER	UMUE	
A			N89-3006-46	BINDING HEAD TAPTITE SCREW		
B			N89-3008-45	BINDING HEAD TAPTITE SCREW		
C			N89-4008-45	BINDING HEAD TAPTITE SCREW		
D			N09-2706-05	TAPTITE SCREW		
E		*	N09-2696-05	STEPPED SCREW		
DP-7020 / SINGAPORE						
202	1E	*	A01-1822-02	METALLIC CABINET ASSY		
204	1G	*	A13-1240-03	FRAME		
205	2E	*	A20-5899-02	PANEL		
206	2F	*	A22-1130-02	SUB PANEL ASSY		
207	2F	*	A22-1131-01	SUB PANEL		
209	2E	*	A29-0153-03	PANEL(TRAY)		
210	1F		A70-0308-05	REMOCON ASSY(RC-P8020)		
211	1F		A09-0078-08	BATTERY COVER		
215	2E		B10-1047-04	FRONT GLASS(REMOCON)		
216	2E	*	B10-1048-03	FRONT GLASS(DISPLAY)		
217	2E		B12-0066-04	INDICATOR		
218	2E		B43-0287-04	KENWOOD BADGE		
-			B46-0092-03	WARRANTY CARD	K	
-			B46-0122-13	WARRANTY CARD	E	S
-			B46-0143-03	WARRANTY CARD	T	S
-		*	B50-9861-00	INSTRUCTION MANUAL(ENGLISH)		
-		*	B50-9862-00	INSTRUCTION MANUAL(FRENCH)	E	S
-		*	B50-9864-00	INSTRUCTION MANUAL(G,D,I)	E	S
222	1F	*	D21-1540-03	EXTENSION SHAFT		
225	1F		E29-0333-04	LEAD PLATE		
226	1E		E30-0505-05	AUDIO CORD		
227	1F		E30-0977-05	CORD WITH PLUG	K	S
228	1G		E30-0459-05	AC POWER CORD	E	S
228	1G		E30-0780-05	AC POWER CORD	K	S
228	1G		E30-1416-05	AC POWER CORD	T	S
229	2F		E31-4289-05	WIRING HARNESS		
230	2F		E31-4790-05	WIRING HARNESS		
235	1G		F11-0440-03	SHIELDING CASE		
-		*	H01-8690-04	ITEM CARTON CASE		
-		*	H10-3934-02	POLYSTYRENE FOAMED FIXTURE(L)		
-		*	H10-3935-02	POLYSTYRENE FOAMED FIXTURE(R)		
-			H25-0232-04	PROTECTION BAG (235X350X0.03)		
-			H25-0361-04	PROTECTION BAG		
242	2F,2G		J02-1052-05	FOOT ASSY		
243	2G		J11-0129-05	WIRE CLAMPER		
244	2F		J19-2598-15	UNIT HOLDER		
245	2F		J19-0581-05	UNIT HOLDER(H=27.3)		
246	1G,2G		J19-0506-05	UNIT HOLDER(H= 8.3)		
247	2G	*	J19-3208-05	UNIT HOLDER		
248	2E		J21-3326-05	JACK MOUNTING HARDWARE		

E: Scandinavia & Europe K: USA P: Canada
U: PX(Far East, Hawaii) T: England M: Other Areas
UE: AAFES(Europe) X: Australia

⚠ indicates safety critical components.

DP-7020

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SINGAPORE MADE JAPAN MADE

Ref. No. 参照番号	Address 位置	New Parts 新	Parts No. 部品番号	Description 部品名／規格	Destination 仕向	Remarks 備考
⚠ 251	1G		J42-0083-05	POWER CORD BUSHING		
-		*	J21-5560-04	MOUNTING HARDEARE		
-			J61-0307-05	WIRE BAND	KE	S
255	1F		K27-2004-04	KNOB (BUTTON)(POWER)		
256	2F	*	K29-3780-04	KNOB (PLAY/PAUSE)		
257	2F	*	K29-3782-03	KNOB (20KEY)		
258	2F	*	K29-3783-03	KNOB (SKIP)		
259	2E		K29-3796-05	KNOB ASSY(OUTPUT LEVEL)		
262	1G	*	L07-5601-05	POWER TRANSFORMER	K	S
262	1G	*	L07-5602-05	POWER TRANSFORMER	TE	S
A			N89-3006-46	BINDING HEAD TAPTITE SCREW		
B			N89-3008-45	BINDING HEAD TAPTITE SCREW		
C			N89-4008-45	BINDING HEAD TAPTITE SCREW		
D			N09-2706-05	TAPTITE SCREW		
E		*	N09-2696-05	STEPPED SCREW		
DISPLAY UNIT (X25-3810-00)						
D1 -20			B30-1012-05	LED(SLP-981C-50)		
D21			B30-1263-05	LED		
C1			CE04KW1C330M	ELECTRO 33UF 16WV		
⚠ C2 -5			CK45FF1H103Z	CERAMIC 0.010UF Z		
CN1			E10-2703-05	FLAT CABLE CONNECTOR		
CN2			E10-1908-05	FLAT CABLE CONNECTOR		
CP1		*	R90-0852-05	MULTIPLE RESISTOR		
S1 -30			S40-1064-05	PUSH SWITCH		
D22 -32			HSS104A	DIODE		
D22 -32			1SS131	DIODE		
D33			DAP803	DIODE		
FL1			FIP9BFM8	FLUORESCENT INDICATOR TUBE		
IC1 -3		*	TD62801P	IC		
IC4		*	UPD75216ACW-295	IC(MICROPROCESSOR)		
IC5			M51951ASL	IC(SYSTEM RESET)		
Q1			2SC1740S(Q,R)	TRANSISTOR		
Q1			2SC945(A)(Q,P)	TRANSISTOR		
Q2 -4			DTA124EN	DIGITAL TRANSISTOR		
Q5			2SC1740S(Q,R)	TRANSISTOR		
Q5			2SC945(A)(Q,P)	TRANSISTOR		
Q6			2SK105(F,H)	FET		
A1			W02-0973-05	ELECTRIC CIRCUIT MODULE		
CONTROL UNIT (X32-1510-XX) 11 : K, P 21 : U, M, UE / JAPAN (X25-1572-71) X, / SINGAPORE						
C1 -4			CF92FV1H103J	MF 0.010UF J		
C5			CE04KW1C330M	ELECTRO 33UF 16WV		
C6		*	CF92FV1H221J	MF 220PF J		
C7 -9			CE04KW1C330M	ELECTRO 33UF 16WV		
C10 ,11			CE04KW1C331M	ELECTRO 330UF 16WV		
C12 ,13			CF92FV1H363J	MF 0.036UF J		
C14 ,15		*	CF92FV1H821J	MF 820PF J		
C16 ,17			CF92FV1H752J	MF 7500PF J		
C18 ,19			CF92FV1H103J	MF 0.010UF J		
C20 ,21			CF92FV1H242J	MF 2400PF J		
C22 ,23			CF92FV1H561J	MF 560PF J		

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C24 ,25		*	C90-1813-05	ELECTRO	22UF	50WV		
C28 -33			CF92FV1H471J	MF	470PF	J		
C34 ,35		*	CF92FV1H221J	MF	220PF	J		
C36 ,37			CE04KW1A101M	ELECTRO	100UF	10WV		
C38 ,39			CE04KW1C221M	ELECTRO	220UF	16WV		
C40 ,41			CE04KW1H010M	ELECTRO	1.0UF	50WV		
C42 ,43			CE04KW0J331M	ELECTRO	330UF	6.3WV		
C44 ,45			CE04KW1C330M	ELECTRO	33UF	16WV		
C46 ,47			CE04KW0J331M	ELECTRO	330UF	6.3WV		
C48 ,49			CE04KW1A101M	ELECTRO	100UF	10WV		
C50 ,51			CE04KW1C330M	ELECTRO	33UF	16WV		
C52 ,53			CE04KW1A101M	ELECTRO	100UF	10WV		
C54			CC45FSL1H101J	CERAMIC	100PF	J		
C55			CK45FB1H332K	CERAMIC	3300PF	K		
⚠ C56 ,57			CK45FF1H103Z	CERAMIC	0.010UF	Z		
C58			CF92FV1H124J	MF	0.12UF	J		
C59 ,60			CK45FB1H222K	CERAMIC	2200PF	K		
C61			CC45FUJ1H330J	CERAMIC	33PF	J		
C62			CC45FUJ1H101J	CERAMIC	100PF	J		
C63			CC45FUJ1H050C	CERAMIC	5.0PF	C		
C64 ,65			CF92FV1H102J	MF	1000PF	J		
C66 -68			CE04KW1C330M	ELECTRO	33UF	16WV		
C69 ,70			CC45FSL1H040C	CERAMIC	4.0PF	C		
C71 ,72			CE04KW1H010M	ELECTRO	1.0UF	50WV		
⚠ C73			CK45FF1H103Z	CERAMIC	0.010UF	Z		
C74			CF92FV1H104J	MF	0.10UF	J		
C75			CE04KW1C330M	ELECTRO	33UF	16WV		
C76			CE04KW1E330M	ELECTRO	33UF	25WV		
C77			CE04KW1H010M	ELECTRO	1.0UF	50WV		
C78 -80			CE04KW1C330M	ELECTRO	33UF	16WV		
⚠ C81			CK45FF1H103Z	CERAMIC	0.010UF	Z		
C82 ,83		*	C90-1805-05	ELECTRO	330UF	25WV		
C84			C91-0745-05	CERAMIC	100PF	K		
C85			CF92FV1H102J	MF	1000PF	J		
C86 ,87			CF92FV1H271J	MF	270PF	J		
C88 ,89			CF92FV1H222J	MF	2200PF	J		
C90 -93			CF92FV1H272J	MF	2700PF	J		
⚠ C94			CK45FF1H103Z	CERAMIC	0.010UF	Z		
C95 ,96			CE04KW1H010M	ELECTRO	1.0UF	50WV		
C101,102			CE04KW1C330M	ELECTRO	33UF	16WV		
⚠ C103			CK45FF1H103Z	CERAMIC	0.010UF	Z		
C104			CE04KW1HR47M	ELECTRO	0.47UF	50WV		
C105			CE04KW1A101M	ELECTRO	100UF	10WV		
C106			CF92FV1H103J	MF	0.010UF	J		
C107			CF92FV1H102J	MF	1000PF	J		
C108-112			CE04KW1C330M	ELECTRO	33UF	16WV		
C113			CC45FSL1H180J	CERAMIC	18PF	J		
C114			CK45FF1H103Z	CERAMIC	0.010UF	Z		
C115			CE04KW1C330M	ELECTRO	33UF	16WV		
⚠ C117,118			CK45FF1H103Z	CERAMIC	0.010UF	Z		
C119			CE04KW1C330M	ELECTRO	33UF	16WV		
C120,121			CC45FSL1H150J	CERAMIC	15PF	J		
C122			CF92FV1H333J	MF	0.033UF	J		
C123			C90-1349-05	NP-ELEC	1UF	50WV		
C124,125			CE04KW1C330M	ELECTRO	33UF	16WV		

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C126			C90-1350-05	NP-ELEC	2.2UF	50WV		
C127			CF92FV1H223J	MF	0.022UF	J		
C128			CF92FV1H152J	MF	1500PF	J		
C129			CF92FV1H222J	MF	2200PF	J		
C131			C91-0668-05	CERAMIC	0.0047UF	K		
⚠ C132			CK45FF1H103Z	CERAMIC	0.010UF	Z		
C133,134			CC45FSL1H101J	CERAMIC	100PF	J		
⚠ C136			CK45FF1H103Z	CERAMIC	0.010UF	Z		
C137,138			CF92FV1H822J	MF	8200PF	J		
C139			C90-1331-05	NP-ELEC	0.47UF	50WV		
C140			CC45FSL1H470J	CERAMIC	47PF	J		
C141			CE04KW1A101M	ELECTRO	100UF	10WV		
C142			C90-1349-05	NP-ELEC	1UF	50WV		
C143,144			CE04KW1C330M	ELECTRO	33UF	16WV		
C145			CF92FV1H124J	MF	0.12UF	J		
C146			C90-1349-05	NP-ELEC	1UF	50WV		
C147			C90-1351-05	NP-ELEC	3.3UF	50WV		
C148			CF92FV1H104J	MF	0.10UF	J		
C149			CK45FB1H821K	CERAMIC	820PF	K		
C150			CF92FV1H102J	MF	1000PF	J		
C151			CC45FSL1H121J	CERAMIC	120PF	J		
C152			CF92FV1H104J	MF	0.10UF	J		
⚠ C153			CK45FF1H103Z	CERAMIC	0.010UF	Z		
C155			C91-0668-05	CERAMIC	0.0047UF	K		
C157			CE04KW1V100M	ELECTRO	10UF	35WV		
C160			C90-1350-05	NP-ELEC	2.2UF	50WV		
C161,162			C90-1349-05	NP-ELEC	1UF	50WV		
C163			C91-0652-05	CERAMIC	0.001UF	K		
C164			CE04KW1E330M	ELECTRO	33UF	25WV		
C205,206			C90-1455-05	NP-ELEC	0.1UF	50WV		
C207,208			C90-1349-05	NP-ELEC	1UF	50WV		
C209-212			CE04KW1C330M	ELECTRO	33UF	16WV		
C213,214			C90-1456-05	NP-ELEC	0.22UF	50WV		
C215			CE04KW1H010M	ELECTRO	1.0UF	50WV		
C301-303			C91-0971-05	FILM	0.01UF	250WV		
C304,305			CF92FV1H103J	MF	0.010UF	J		
C306,307			CE04KW1E102M	ELECTRO	1000UF	25WV		
C308-311			CF92FV1H103J	MF	0.010UF	J		
C312			CE04KW1C222M	ELECTRO	2200UF	16WV		
C313			CE04KW1H470M	ELECTRO	47UF	50WV		
C314,315			CE04KW1A222M	ELECTRO	2200UF	10WV		
C318			CF92FV1H105J	MF	1.0UF	J		
CN1			E10-2703-05	FLAT CABLE CONNECTOR				
CN2			E10-1907-05	FLAT CABLE CONNECTOR				
J301		*	E13-1404-05	PHONO JACK(4P) LINE OUT				
J302			E11-0188-05	MINIATURE PHONE JACK(SYSTEM)				
J303			E11-0190-05	PHONE JACK(HEADPHONES)				
-			F01-0468-04	HEAT SINK				
-		*	J21-5516-04	MOUNTING HARDWARE				
L1 -3			L40-1011-17	SMALL FIXED INDUCTOR(100UH,K)				
L4			L32-0328-15	OSCILATING COIL				
L5 -8			L40-1011-17	SMALL FIXED INDUCTOR(100UH,K)				
L9 ,10			L40-3301-16	SMALL FIXED INDUCTOR(33UH,K)				

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L11 ,12			L40-1011-17	SMALL FIXED INDUCTOR(100UH,K)		
L101			L40-1001-17	SMALL FIXED INDUCTOR(10UH,K)		
⚠ L311			L79-0733-05	LINE FILTER		
X1			L77-1164-05	CRYSTAL RESONATOR		
F			N30-3006-46	PAN HEAD MACHINE SCREW		
G			N89-3008-46	BINDING HEAD TAPTITE SCREW		
R8 ,9			RD14AB2E220J.	FL-PROOF RD 22 J 1/4W		
R13 ,14			RN14BK2C4220F	RN 422.0 F 1/6W		
R15 -18			RN14BK2C1001F	RN 1.00K F 1/6W		
R19 ,20			RN14BK2C2371F	RN 2.37K F 1/6W		
R21 ,22			RN14BK2C1001F	RN 1.00K F 1/6W		
R29 -32			RN14BK2C1001F	RN 1.00K F 1/6W		
R33 ,34			RN14BK2C1003F	RN 100K F 1/6W		
R35 ,36			RN14BK2C10R0F	RN 10.0 F 1/6W		
R39 ,40			R92-0393-05	RD 3.0K J 1/2W		
R41 -44			RN14BK2C1963F	RN 196K F 1/6W		
R70			RN14BK2C1004F	RN 1.00M F 1/6W		
R75			RS14KB3A560J	FL-PROOF RS 56 J 1W		
R92			RS14KB3A101J	FL-PROOF RS 100 J 1W		
VR1 -4		*	R12-5070-05	TRIMMING POT.(2SB,MSB)		
VR101-103			R12-3126-05	TRIMMING POT.(T/F GAIN&BIAS)		
VR104			R12-3128-05	TRIMMING POT.(TE BALANCE)		
VR201		*	R29-9023-05	POTENTIOMETER(3KX2)OUTPUT		
K1			S51-2089-05	MAGNETIC RELAY		
⚠ S1			S40-1103-05	PUSH SWITCH (POWER TYPE)		
⚠ S2			S31-2131-05	SLIDE SWITCH (POWER TYPE)	UMUE	
D1 ,2			HZS8.2N(B)	ZENER DIODE		
D1 ,2			RD8.2ES(B)	ZENER DIODE		
D3 ,4			HZS4.7N(B)	ZENER DIODE		
D3 ,4			RD4.7ES(B)	ZENER DIODE		
D5 ,6			HZS13N(B2)	ZENER DIODE		
D5 ,6			RD13ES(B2)	ZENER DIODE		
D7			HZS5.6N(B2)	ZENER DIODE		
D7			RD5.6ES(B2)	ZENER DIODE		
D8			HSS104	DIODE		
D8			1SS133	DIODE		
D9			1SV147	VARISTOR		
D10 ,11			HZS11N(B2)	ZENER DIODE		
D10 ,11			RD11ES(B2)	ZENER DIODE		
D12 ,13			HZS5.1N(B2)	ZENER DIODE		
D12 ,13			RD5.1ES(B2)	ZENER DIODE		
D14 ,15			HZS5.6N(B2)	ZENER DIODE		
D14 ,15			RD5.6ES(B2)	ZENER DIODE		
D16 -19			HSS104	DIODE		
D16 -19			1SS133	DIODE		
D105			HSS104	DIODE		
D105			1SS133	DIODE		
D106			HZS5.6N(B2)	ZENER DIODE		
D106			RD5.6ES(B2)	ZENER DIODE		
D107			HSS104	DIODE		
D107			1SS133	DIODE		
D108			HZS30N(B)	ZENER DIODE		
D108			RD30ES(B)	ZENER DIODE		

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D109			HZS7.5S(B)	ZENER DIODE		
D109			RD7.5JS(B)	ZENER DIODE		
D110-112			HZS4.7N(B)	ZENER DIODE		
D110-112			RD4.7ES(B)	ZENER DIODE		
D115-117			HSS104	DIODE		
D115-117			1SS133	DIODE		
D120,121			HSS104	DIODE		
D120,121			1SS133	DIODE		
D201-204			HSS104	DIODE		
D201-204			1SS133	DIODE		
D301-304			S5566B	DIODE		
D305			HSS104A	DIODE		
D305			1SS131	DIODE		
D306-311			S5566B	DIODE		
IC1 -3			NJM4565D	IC(OP AMP X2)		
IC4 ,5		*	NJM4580D	IC		
IC6 ,7		*	PCM1701P	IC		
IC8			NJM4565D	IC(OP AMP X2)		
IC9			SM5813AP	IC(8FS DIGITAL FILTER)		
IC10			TC74HCU04AP	IC(CMOS INVERTER)		
IC11			CXD1165Q	IC(DIGITAL SIGNAL PROCESSOR)		
IC12			NJM4565D	IC(OP AMP X2)		
IC13			KAG01	CUSTOM IC		
IC14			NJM4565D	IC(OP AMP X2)		
IC15			TC74HC00AP	IC(QUAD 2-INPUT NAND GATE)		
IC101			NJM4558D	IC(OP AMP X2)		
IC102			UPD4053BC	IC(3-INPUT 2CH MPX/DE-MPX)		
IC103			CXA1244S	IC(SERVO SIGNAL PROCESSOR)		
IC104			CXA1081S	IC(RF AMP)		
IC105			NJM4558D	IC(OP AMP X2)		
IC106			TC74HC00AP	IC(QUAD 2-INPUT NAND GATE)		
IC109,110			NJM4558D	IC(OP AMP X2)		
IC201			NJM4565D	IC(OP AMP X2)		
Q1			2SB941	TRANSISTOR		
Q2			2SD1266	TRANSISTOR		
Q3			DTC124EN	DIGITAL TRANSISTOR		
Q4			2SC1740S(Q,R)	TRANSISTOR		
Q4			2SC945(A)(Q,P)	TRANSISTOR		
Q5 ,6			2SC2878(B)	TRANSISTOR		
Q7 ,8			2SA1206	TRANSISTOR		
Q9 ,10			2SK246	FET		
Q11 ,12			2SK152	FET		
Q13 -16			2SC3940A	TRANSISTOR		
Q17			2SA1534A	TRANSISTOR		
Q18			2SC3940A	TRANSISTOR		
Q19			2SK246	FET		
Q20 ,21			2SA733(A)(Q,P)	TRANSISTOR		
Q20 ,21			2SA933S(Q,R)	TRANSISTOR		
Q22			DTA124EN	DIGITAL TRANSISTOR		
Q101			2SA1534A	TRANSISTOR		
Q102			2SC3940A	TRANSISTOR		
Q103			2SD1944	TRANSISTOR		
Q104,105			2SA1534A	TRANSISTOR		
Q106			2SC3940A	TRANSISTOR		
Q107			2SA1534A	TRANSISTOR		

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Q108			2SC3940A	TRANSISTOR		
Q109			2SA1534A	TRANSISTOR		
Q110			2SC3940A	TRANSISTOR		
Q111			2SA1534A	TRANSISTOR		
Q112			2SC3940A	TRANSISTOR		
Q113			2SA1534A	TRANSISTOR		
Q114			2SC3940A	TRANSISTOR		
Q115			2SA1534A	TRANSISTOR		
Q116			2SC3940A	TRANSISTOR		
Q118			2SA1534A	TRANSISTOR		
Q201,202			2SC3666	TRANSISTOR		
Q203,204			2SA1426	TRANSISTOR		
A1			W02-1036-05	TRANSMITTING ASSY(OPT OUT)		
MECHANISM ASS'Y (X92-1370-02) / JAPAN						
1	1A		A10-1964-01	CHASSIS		
2	2A	*	A11-0626-15	SUB CHASSIS ASSY		
3	3B		A11-0621-08	SUB CHASSIS INJECTION MOLD		
4	2B		A11-0623-08	SUB CHASSIS		
8	2B		B09-0098-08	CAP		
13	3B		D02-0091-08	TURNTABLE PLATTER		
13	3B		D02-0092-08	TURNTABLE PLATTER		
14	1B		D10-2324-03	SLIDER		
15	3B		D10-2325-04	ROD		
16	1B		D13-0807-04	GEAR		
17	1B		D13-0808-02	GEAR		
18	3B		D13-0809-08	GEAR		
19	3B		D13-0810-04	GEAR		
20	3B		D13-0811-04	GEAR		
21	1B		D13-0813-04	GEAR		
22	2B		D15-0296-04	MOTOR PULLEY		
23	1B		D16-0282-04	BELT		
27	1B		E23-0343-04	TERMINAL		
28	2B	*	E31-7270-05	WIRING HARNESS (WHITE/BLUE)		
29	2B	*	E31-7271-05	WIRING HARNESS (WHITE/RED)		
30	2B		E31-7075-05	WIRING HARNESS		
35	1B		F19-1005-04	BLIND PLATE		
38	2B		G01-2385-08	COMPRESSION SPRING		
39	2B		G01-2390-08	COMPRESSION SPRING		
40	1B		G02-0926-04	FLAT SPRING		
41	1B		G02-0927-04	FLAT SPRING		
42	2A		G16-0739-04	SHEET		
43	2A		G16-0744-04	SHEET		
44	1B		G02-0945-04	FLAT SPRING ASSY		
45	1B	*	G11-2008-04	CUSHION		
47	2B		J02-1033-08	INSULATOR		
48	2B		J11-0151-03	CLAMPER		
49	2B		J91-0385-08	PICKUP		
51	2A		J99-0065-11	TRAY		
52	2A		J99-0067-13	TRAY ASSY		
A			N35-2605-46	BINDING HEAD MACHINE SCREW		
B			N09-1522-05	SET SCREW (3X8)		

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C			N39-2025-46	PAN HEAD MACHINE SCREW		
D			N09-2705-05	MACHINE SCREW		
E			N89-2610-46	BINDING HEAD TAPTITE SCREW		
F			N19-1179-05	FLAT WASHER		
G			N89-2608-46	BINDING HEAD TAPTITE SCREW		
H			N88-3008-45	FLAT HEAD TAPTITE SCREW		
55	3B		S33-1022-05	LEVER SWITCH		
56	2B		S33-2061-05	LEVER SWITCH		
60	2B		T42-0530-05	DC MOTOR		
61	3B		T42-0531-05	DC MOTOR		
62	3B		T42-0532-05	DC MOTOR		
63	2B		T50-1044-04	YOKE		
64	2B		T99-0233-05	MAGNET		
MECHANISM ASS'Y (X92-1400-02) / SINGAPORE						
101	1C		A10-2513-01	CHASSIS		S
104	3D		A11-0625-02	SUB CHASSIS		S
114	1D		D10-2324-03	SLIDER		
115	2D		D10-2315-04	ROD		S
116	1D		D13-0807-04	GEAR(INTERMEDIATE)		
117	1D		D13-0808-02	GEAR(MAIN)		
119	2D		D13-0802-08	GEAR(A)		S
120	2D		D13-0803-08	GEAR(B)		S
121	1D		D13-0813-04	GEAR(PULLEY)		
122	2D		D15-0296-04	MOTOR PULLEY		
123	1D		D16-0284-03	BELT		S
124	2D		D40-0876-05	MECHANISH ASSY		S
125	1D		G11-2008-04	CUSHION		
126	1D	*	G02-0945-04	FLAT SPRING ASSY		
127	1D		E23-0343-04	TERMINAL(SHORT)		
128	2D	*	E31-7236-15	WIRING HARNESS(WHITE/BLUE)		S
129	2D	*	E31-7237-05	WIRING HARNESS(WHITE/RED)		S
130	2D		E31-7137-05	WIRING HARNESS(5P)		S
131	3D		E40-4117-08	CONNECTOR PIN(4P)		S
134	2D		F07-0554-08	GEAR COVER		
135	1D		F19-1015-14	BLIND PLATE		S
138	3D		G01-2394-04	COMPRESSION SPRING(FRONT)		S
139	3D		G01-2395-04	COMPRESSION SPRING(REAR)		S
140	1D		G02-0926-04	FLAT SPRING(L)		
141	1D		G02-0927-04	FLAT SPRING(R)		
142	2C		G16-0743-04	SHEET		S
143	2C		G16-0745-04	SHEET		S
144	2D		J19-3148-08	SHAFT CLAMP		S
145	3D		J25-6135-08	MOTOR PCB		
146	2D		J90-0640-08	SLIDER HOLDER(J)		S
147	3D		J02-1027-08	INSULATOR		S
148	2D		J11-0130-03	CLAMPER		S
149	2D		J91-0385-08	PICKUP(KSS-150A(H))		
150	3D		J42-0175-04	BUSHIHG		S
151	1C		J99-0069-11	TRAY		S
152	2C	*	J99-0070-13	TRAY ASSY		S
A			N35-2605-46	BINDING HEAD MACHINE SCREW		

E: Scandinavia & Europe K: USA P: Canada
U: PX(Far East, Hawaii) T: England M: Other Areas
UE: AAFES(Europe) X: Australia

⚠ indicates safety critical components.

DP-7020

PARTS LIST

× New Parts
Parts without **Parts No.** are not supplied.
Les articles non mentionnes dans le **Parts No.** ne sont pas fournis.
Teile ohne **Parts No.** werden nicht geliefert.

Ref. No. 参照番号	Address 位置	New Parts 新	Parts No. 部品番号	Description 部品名／規格	Destination 仕向	Remarks 備考
B			N09-1522-05	SET SCREW (3X8)		
C			N39-2005-46	PAN HEAD MACHINE SCREW		
D			N89-2608-46	BINDING HEAD TAPTITE SCREW		S
E			N09-2670-08	SCREW		
F			N09-2671-08	SCREW		S
G			N89-2606-46	BIND HEAD TAPTITE SCREW		
H			N19-1217-04	FLAT WASHER		S
155	3D		S46-1128-08	LEAF SWITCH(S1/LIMIT)		S
156	2D		S33-2061-05	LEVER SWITCH(S2/OPEN,CLOSE)		
160	2D		T42-0530-05	DC MOTOR(M3/TRAY)		
161	2D		T42-0528-08	DC MOTOR(M2/SPINDLE)		S
162	3D		T42-0527-08	DC MOTOR(M1/FEE)		
163	2D		T50-1046-04	YOKE		S
164	2D		T99-0233-05	MAGNET		

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SINGAPORE MADE

DP-7020 DP-7020

SPECIFICATIONS

[Format]

Type ..... Compact disc player
Read system ..... Non-contact optical pick-up
Rotational speed ..... About 200 rpm to 500 rpm

[Audio]

Frequency response ..... 2 Hz ~ 20 kHz ±0.5 dB
Signal-to-noise ratio ..... more than 110 dB
Total harmonic distortion ..... 0.0025% at 1 kHz
Channel separation ..... more than 105 dB at 1 kHz
Wow & flutter ..... Below measurable limit

Output

LINE (FIXED) ..... 2.0 V
(VARIABLE) ..... 0 ~ 2.0 V
DIGITAL (OPTICAL) ..... −15 dBm ~ −21 dBm
Headphone jack ..... 20 mW (8 Ω)

[General]

Power consumption ..... 25 W
Dimensions ..... W: 440 mm (17-5/16")
H: 128 mm (5-1/16")
D: 314 mm (12-3/8")
Weight ..... 5.9 kg (13.0 lb)

Note:
KENWOOD follows a policy of continuous advancements in development. For this reason specifications may be changed without notice.

Note :
Component and circuitry are subject to modification to insure best operation under differing local conditions. This manual is based on, the U.S.A. (K) standard, and provides information on regional circuit modification through use of alternate schematic diagrams, and information on regional component variations through use of parts list.

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